

# AFE4490 Integrated Analog Front-End for Pulse Oximeters

## 1 Features

- Fully-Integrated Analog Front-End for Pulse Oximeter Applications:
  - Flexible Pulse Sequencing and Timing Control
- Transmit:
  - Integrated LED Driver (H-Bridge, Push, or Pull)
  - 110-dB Dynamic Range Across Full Range (Enables Low Noise at Low LED Current)
  - LED Current:
    - Programmable Ranges of 50 mA, 75 mA, 100 mA, 150 mA, and 200 mA, Each with 8-Bit Current Resolution
  - Low Power:
    - 100  $\mu$ A + Average LED Current
  - LED On-Time Programmability from (50  $\mu$ s + Settle Time) to 4 ms
  - Independent LED2, LED1 Current Reference
- Receive Channel with High Dynamic Range:
  - Input-Referred Noise:
    - 50 pA<sub>RMS</sub> (at 5- $\mu$ A PD Current)
  - 13.5 Noise-Free Bits (at 5- $\mu$ A PD Current)
  - Analog Ambient Cancellation Scheme with Selectable 1- $\mu$ A to 10- $\mu$ A Ambient Current
  - Low Power: < 2.3 mW at 3.0-V Supply
  - Rx Sample Time: 50  $\mu$ s to 4 ms
  - I-V Amplifier with Seven Separate LED2 and LED1 Programmable Feedback R and C Settings
  - Integrated Digital Ambient Estimation and Subtraction
- Integrated Fault Diagnostics:
  - Photodiode and LED Open and Short Detection
  - Cable On or Off Detection
- Supplies:
  - Rx = 2.0 V to 3.6 V
  - Tx = 3.0 V or 5.25 V
- Package: Compact VQFN-40 (6 mm  $\times$  6 mm)
- Specified Temperature Range: -40°C to 85°C

## 2 Applications

- Medical Pulse Oximeter Applications
- Industrial Photometry Applications

## 3 Description

The AFE4490 is a fully-integrated analog front-end (AFE) that is ideally suited for pulse-oximeter applications. The device consists of a low-noise receiver channel with a 22-bit analog-to-digital converter (ADC), an LED transmit section, and diagnostics for sensor and LED fault detection. The device is a very configurable timing controller. This flexibility enables the user to have complete control of the device timing characteristics. To ease clocking requirements and provide a low-jitter clock to the device, an oscillator is also integrated that functions from an external crystal. The device communicates to an external microcontroller or host processor using an SPI™ interface.

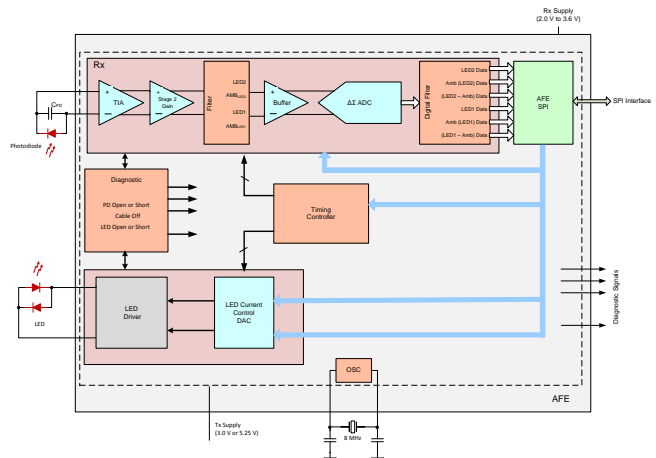
The device is a complete AFE solution packaged in a single, compact VQFN-40 package (6 mm  $\times$  6 mm) and is specified over the operating temperature range of -40°C to 85°C.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)          |
|-------------|-----------|--------------------------|
| AFE4490     | VQFN (40) | 6.00 mm $\times$ 6.00 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### Simplified Schematic



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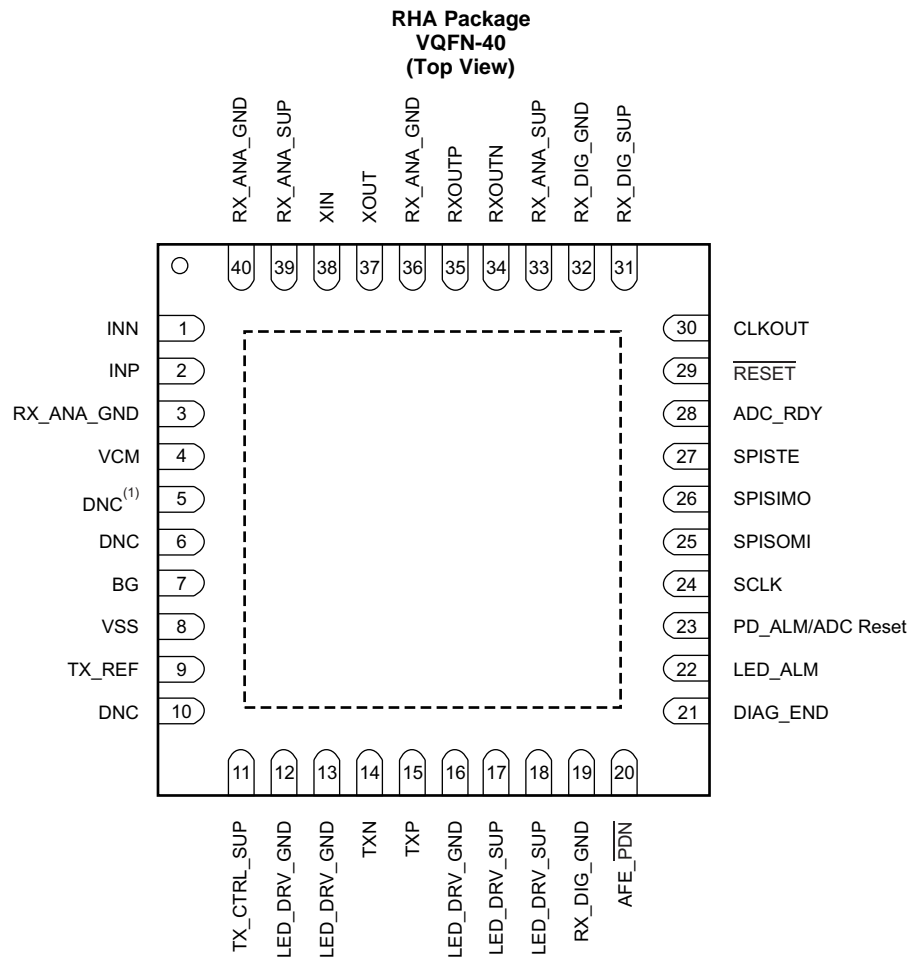
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## 5 Device Comparison Table

| PRODUCT | PACKAGE-LEAD | LED DRIVE CONFIGURATION | LED DRIVE CURRENT (mA, max) | Tx POWER SUPPLY (V) | OPERATING TEMPERATURE RANGE |
|---------|--------------|-------------------------|-----------------------------|---------------------|-----------------------------|
| AFE4490 | VQFN-40      | Bridge, push-pull       | 50, 75, 100, 150, and 200   | 3 to 5.25           | –40°C to 85°C               |
| AFE4400 | VQFN-40      | Bridge, push-pull       | 50                          | 3 to 5.25           | 0°C to 70°C                 |
| AFE4403 | WCSP-36      | Bridge, push-pull       | 100                         | 3 to 5.25           | –20°C to 70°C               |

## 6 Pin Configuration and Functions



(1) DNC = Do not connect.

## Pin Functions

| PIN                |            | FUNCTION  | DESCRIPTION  |
|--------------------|------------|-----------|--|
| NAME               | NO.        |           |  |
| ADC_RDY            | 28         | Digital   | Output signal that indicates ADC conversion completion. Can be connected to the interrupt input pin of an external microcontroller.  |
| AFE_PDN            | 20         | Digital   | AFE-only power-down input; active low. Can be connected to the port pin of an external microcontroller.  |
| BG                 | 7          | Reference | Decoupling capacitor for internal band-gap voltage to ground (2.2-μF decoupling capacitor to ground, expected voltage = 1.0 V).  |
| CLKOUT             | 30         | Digital   | Buffered 4-MHz output clock output. Can be connected to the clock input pin of an external microcontroller.  |
| DIAG_END           | 21         | Digital   | Output signal that indicates completion of diagnostics. Can be connected to the port pin of an external microcontroller.   |
| DNC <sup>(1)</sup> | 5, 6, 10   | —         | Do not connect these pins. Leave as open-circuit.  |
| INN                | 1          | Analog    | Receiver input pin. Connect to photodiode anode.   |
| INP                | 2          | Analog    | Receiver input pin. Connect to photodiode cathode.   |
| LED_DRV_GND        | 12, 13, 16 | Supply    | LED driver ground pin, H-bridge. Connect to common board ground.   |
| LED_DRV_SUP        | 17, 18     | Supply    | LED driver supply pin, H-bridge. Connect to an external power supply capable of supplying the large LED current, which is drawn by this supply pin.  |
| LED_ALM            | 22         | Digital   | Output signal that indicates an LED cable fault. Can be connected to the port pin of an external microcontroller.  |
| PD_ALM/ADC Reset   | 23         | Digital   | Output signal that indicates a PD sensor or cable fault. Can be connected to the port pin of an external microcontroller. In ADC bypass mode, the PD_ALM pin can be used to bring out the ADC reset signal.                    |
| RESET              | 29         | Digital   | AFE-only reset input, active low. Can be connected to the port pin of an external microcontroller.   |
| RX_ANA_GND         | 3, 36, 40  | Supply    | Rx analog ground pin. Connect to common board ground.  |
| RX_ANA_SUP         | 33, 39     | Supply    | Rx analog supply pin; 0.1-μF decoupling capacitor to ground  |
| RX_DIG_GND         | 19, 32     | Supply    | Rx digital ground pin. Connect to common board ground.   |
| RX_DIG_SUP         | 31         | Supply    | Rx digital supply pin; 0.1-μF decoupling capacitor to ground   |
| RXOUTN             | 34         | Analog    | External ADC negative input when in ADC bypass mode  |
| RXOUTP             | 35         | Analog    | External ADC positive input when in ADC bypass mode  |
| SCLK               | 24         | SPI       | SPI clock pin  |
| SPISIMO            | 26         | SPI       | SPI serial in master out   |
| SPISOMI            | 25         | SPI       | SPI serial out master in   |
| SPISTE             | 27         | SPI       | SPI serial interface enable  |
| TX_CTRL_SUP        | 11         | Supply    | Transmit control supply pin (0.1-μF decoupling capacitor to ground)  |
| TX_REF             | 9          | Reference | Transmitter reference voltage, 0.75 V default after reset. Connect a 2.2-μF decoupling capacitor to ground.  |
| TXN                | 14         | Analog    | LED driver out B, H-bridge output. Connect to LED.   |
| TXP                | 15         | Analog    | LED driver out B, H-bridge output. Connect to LED.   |
| VCM                | 4          | Reference | Input common-mode voltage output. Connect a series resistor (1 kΩ) and a decoupling capacitor (10 nF) to ground. The voltage across the capacitor can be used to shield (guard) the INP, INN traces. Expected voltage = 0.9 V. |
| VSS                | 8          | Supply    | Substrate ground. Connect to common board ground.  |
| XOUT               | 37         | Digital   | Crystal oscillator pins. Connect an external 8-MHz crystal between these pins with the correct load capacitor (as specified by vendor) to ground.  |
| XIN                | 38         | Digital   | Crystal oscillator pins. Connect an external 8-MHz crystal between these pins with the correct load capacitor (as specified by vendor) to ground.  |

(1) Leave pins as open circuit. Do not connect.



## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|  |            | MIN              | MAX                                 | UNIT |
|--|------------|------------------|-------------------------------------|------|
| RX_ANA_SUP, RX_DIG_SUP to RX_ANA_GND, RX_DIG_GND           |            | −0.3             | 4                                   | V    |
| TX_CTRL_SUP, LED_DRV_SUP to LED_DRV_GND                    |            | −0.3             | 6                                   | V    |
| RX_ANA_GND, RX_DIG_GND to LED_DRV_GND                      |            | −0.3             | 0.3                                 | V    |
| Analog inputs  |            | RX_ANA_GND − 0.3 | RX_ANA_SUP + 0.3                    | V    |
| Digital inputs   |            | RX_DIG_GND − 0.3 | RX_DIG_SUP + 0.3                    | V    |
| TXP, TXN pins  |            | −0.3             | Minimum [6,<br>(LED_DRV_SUP + 0.3)] | V    |
| Input current to any pin except supply pins <sup>(2)</sup> |            |                  | ±7                                  | mA   |
| Input current  | Momentary  |                  | ±50                                 | mA   |
|  | Continuous |                  | ±7                                  | mA   |
| Operating temperature range                                |            | −40              | 85                                  | °C   |
| Maximum junction temperature, T <sub>J</sub>               |            |                  | 125                                 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Input pins are diode-clamped to the power-supply rails. Input signals that can swing beyond the supply rails must be current-limited to 10 mA or less.

### 7.2 Handling Ratings

|                    |                           |  | MIN   | MAX  | UNIT |
|--------------------|---------------------------|--|-------|------|------|
| T <sub>stg</sub>   | Storage temperature range |  | −60   | 150  | °C   |
| V <sub>(ESD)</sub> | Electrostatic discharge   | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | −1000 | 1000 | V    |
|                    |                           | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | −250  | 250  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|             |  | MIN  | MAX  | UNIT |
|-------------|--|--|------|------|
| SUPPLIES    |  |  |      |      |
| RX_ANA_SUP  | AFE analog supply  | 2.0  | 3.6  | V    |
| RX_DIG_SUP  | AFE digital supply   | 2.0  | 3.6  | V    |
| TX_CTRL_SUP | Transmit controller supply   | 3.0  | 5.25 | V    |
| LED_DRV_SUP | Transmit LED driver supply, H-bridge or common anode configuration | [3.0 or (V <sub>HR</sub> + V <sub>LED</sub> + V <sub>CABLE</sub> ) <sup>(1)(2)(3)</sup> ,<br>whichever is greater] | 5.25 | V    |
|             | Difference between LED_DRV_SUP and TX_CTRL_SUP                     | −0.3   | 0.3  | V    |
| TEMPERATURE |  |  |      |      |
|             | Specified temperature range  | −40  | 85   | °C   |

- (1)  $V_{HR}$  refers to the required voltage headroom necessary to drive the LEDs. See [Table 6](#) for the appropriate  $V_{HR}$  value.  
(2)  $V_{LED}$  refers to the maximum voltage drop across the external LED (at maximum LED current) connected between the TXP and TXN pins (in H-bridge mode) and from the TXP and TXN pins to LED\_DRV\_SUP (in the common anode configuration).  
(3)  $V_{CABLE}$  refers to voltage drop across any cable, connector, or any other component in series with the LED.

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | AFE4490    | UNIT |
|-------------------------------|--|------------|------|
|                               |  | RHA (VQFN) |      |
|                               |  | 40 PINS    |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 35         | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 31         |      |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 26         |      |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.1        |      |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | N/A        |      |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | N/A        |      |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.5 Electrical Characteristics

Minimum and maximum specifications are at  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Typical specifications are at  $25^{\circ}\text{C}$ .

All specifications are at  $\text{RX\_ANA\_SUP} = \text{RX\_DIG\_SUP} = 3\text{ V}$ ,  $\text{TX\_CTRL\_SUP} = \text{LED\_DRV\_SUP} = 5\text{ V}$ , stage 2 amplifier disabled, and  $f_{\text{CLK}} = 8\text{ MHz}$ , unless otherwise noted.

| PARAMETER                                     |   | TEST CONDITIONS   | MIN  | TYP  | MAX  | UNIT              |
|---|---|---|------|------|------|-------------------|
| PERFORMANCE (Full-Signal Chain)               |   |   |      |      |      |                   |
| I <sub>IN_FS</sub>                            | Full-scale input current  | R <sub>F</sub> = 10 kΩ  |      | 50   |      | μA                |
|   |   | R <sub>F</sub> = 25 kΩ  |      | 20   |      | μA                |
|   |   | R <sub>F</sub> = 50 kΩ  |      | 10   |      | μA                |
|   |   | R <sub>F</sub> = 100 kΩ   |      | 5    |      | μA                |
|   |   | R <sub>F</sub> = 250 kΩ   |      | 2    |      | μA                |
|   |   | R <sub>F</sub> = 500 kΩ   |      | 1    |      | μA                |
|   |   | R <sub>F</sub> = 1 MΩ   |      | 0.5  |      | μA                |
| PRF   | Pulse repetition frequency  |   | 62.5 |      | 5000 | SPS               |
| DC <sub>PRF</sub>                             | PRF duty cycle  |   |      |      | 25%  |                   |
| CMRR  | Common-mode rejection ratio   | f <sub>CM</sub> = 50 Hz and 60 Hz, LED1 and LED2 with R <sub>SERIES</sub> = 500 kΩ, R <sub>F</sub> = 500 kΩ         |      | 75   |      | dB                |
|   |   | f <sub>CM</sub> = 50 Hz and 60 Hz, LED1-AMB and LED2-AMB with R <sub>SERIES</sub> = 500 kΩ, R <sub>F</sub> = 500 kΩ |      | 95   |      | dB                |
| PSRR  | Power-supply rejection ratio  | f <sub>PS</sub> = 50 Hz, 60 Hz at PRF = 200 Hz  |      | 100  |      | dB                |
|   |   | f <sub>CM</sub> = 50 Hz, 60 Hz at PRF = 600 Hz  |      | 106  |      | dB                |
| PSRR <sub>LED</sub>                           | PSRR, transmit LED driver   | With respect to ripple on LED_DRV_SUP   |      | 75   |      | dB                |
| PSRR <sub>Tx</sub>                            | PSRR, transmit control  | With respect to ripple on TX_CTRL_SUP   |      | 60   |      | dB                |
| PSRR <sub>Rx</sub>                            | PSRR, receiver  | With respect to ripple on RX_ANA_SUP and RX_DIG_SUP   |      | 60   |      | dB                |
|   | Total integrated noise current, input-referred (receiver with transmitter loop back, 0.1-Hz to 20-Hz bandwidth) | R <sub>F</sub> = 100 kΩ with stage 2 gain disabled, PRF = 1200 Hz, duty cycle = 5%                                  |      | 36   |      | pA <sub>RMS</sub> |
|   |   | R <sub>F</sub> = 500 kΩ with ambient cancellation enabled and stage 2 gain = 4, PRF = 1200 Hz, duty cycle = 25%     |      | 13   |      | pA <sub>RMS</sub> |
| N <sub>FB</sub>                               | Noise-free bits (receiver with transmitter loop back, 0.1-Hz to 20-Hz bandwidth) <sup>(1)</sup>                 | R <sub>F</sub> = 100 kΩ, PRF = 1200 Hz, duty cycle = 5%   |      | 14.3 |      | Bits              |
|   |   | R <sub>F</sub> = 500 kΩ, PRF = 1200 Hz, duty cycle = 25%  |      | 13.5 |      | Bits              |
| RECEIVER FUNCTIONAL BLOCK LEVEL SPECIFICATION |   |   |      |      |      |                   |
|   | Total integrated noise current, input-referred (receiver alone) over 0.1-Hz to 5-Hz bandwidth                   | R <sub>F</sub> = 500 kΩ, ambient cancellation enabled, stage 2 gain = 4, PRF = 1300 Hz, LED duty cycle = 25%        |      | 1.4  |      | pA <sub>RMS</sub> |
|   |   | R <sub>F</sub> = 500 kΩ, ambient cancellation enabled, stage 2 gain = 4, PRF = 1300 Hz, LED duty cycle = 5%         |      | 5    |      | pA <sub>RMS</sub> |

(1) Noise-free bits ( $N_{\text{FB}}$ ) are defined as:

$$N_{\text{FB}} = \log_2 \left( \frac{I_{\text{PD}}}{6.6 \times I_{\text{NOISE}}} \right)$$

where:  $I_{\text{PD}}$  is the photodiode current, and  $I_{\text{NOISE}}$  is the input-referred RMS noise current.

## Electrical Characteristics (continued)

Minimum and maximum specifications are at  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Typical specifications are at  $25^{\circ}\text{C}$ .

All specifications are at  $\text{RX\_ANA\_SUP} = \text{RX\_DIG\_SUP} = 3\text{ V}$ ,  $\text{TX\_CTRL\_SUP} = \text{LED\_DRV\_SUP} = 5\text{ V}$ , stage 2 amplifier disabled, and  $f_{\text{CLK}} = 8\text{ MHz}$ , unless otherwise noted.

| PARAMETER                    |  | TEST CONDITIONS   | MIN   | TYP              | MAX  | UNIT |
|------------------------------|--|---|---|------------------|------|------|
| I-V TRANSIMPEDANCE AMPLIFIER |  |   |   |                  |      |      |
| G                            | Gain   | R <sub>F</sub> = 10 kΩ to R <sub>F</sub> = 1 MΩ   | See the <a href="#">Receiver Channel</a> section for details                                      |                  |      | V/μA |
|                              | Gain accuracy                                      |   | ±7%   |                  |      |      |
|                              | Feedback resistance                                | R <sub>F</sub>  | 10k, 25k, 50k, 100k, 250k, 500k, and 1M   |                  |      | Ω    |
|                              | Feedback resistor tolerance                        | R <sub>F</sub>  | ±7%   |                  |      |      |
|                              | Feedback capacitance                               | C <sub>F</sub>  | 5, 10, 25, 50, 100, and 250   |                  |      | pF   |
|                              | Feedback capacitor tolerance                       | C <sub>F</sub>  | ±20%  |                  |      |      |
| V <sub>OD(is)</sub>          | Full-scale differential output voltage             |   | 1   |                  |      | V    |
|                              | Common-mode voltage on input pins                  | Set internally  | 0.9   |                  |      | V    |
|                              | External differential input capacitance            | Includes equivalent capacitance of photodiode, cables, EMI filter, and so forth   | 10  |                  | 1000 | pF   |
| V <sub>O(shield)</sub>       | Shield output voltage, V <sub>CM</sub>             | With a 1-kΩ series resistor and a 10-nF decoupling capacitor to ground, when loaded with a small current (for example, of a few μA or less) | 0.8   | 0.9              | 1.0  | V    |
| AMBIENT CANCELLATION STAGE   |  |   |   |                  |      |      |
| G                            | Gain   |   | 0, 3.5, 6, 9.5, and 12  |                  |      | dB   |
|                              | Current DAC range                                  |   | 010   |                  |      | μA   |
|                              | Current DAC step size                              |   | 1   |                  |      | μA   |
| LOW-PASS FILTER              |  |   |   |                  |      |      |
|                              | Low-pass corner frequency                          | 3-dB attenuation  | 0.5 and 1   |                  |      | kHz  |
|                              | Pass-band attenuation, 2 Hz to 10 Hz               | Duty cycle = 25%  | 0.004   |                  |      | dB   |
|                              |  | Duty cycle = 10%  | 0.041   |                  |      | dB   |
|                              | Filter settling time                               | After diagnostics mode with filter corner = 500 Hz  | 28  |                  |      | ms   |
|                              |  | After diagnostics mode with filter corner = 1000 Hz   | 16  |                  |      | ms   |
|                              | ADC bypass outputs output impedance                | RXOUTP and RXOUTN   | 1   |                  |      | kΩ   |
| ANALOG-TO-DIGITAL CONVERTER  |  |   |   |                  |      |      |
|                              | Resolution   |   | 22  |                  |      | Bits |
|                              | Sample rate  | See the <a href="#">ADC Operation and Averaging Module</a> section  | 4 × PRF   |                  |      | SPS  |
|                              | ADC full-scale voltage                             |   | ±1.2  |                  |      | V    |
|                              | ADC conversion time                                | See the <a href="#">ADC Operation and Averaging Module</a> section  | 50  | PRF / 4          |      | μs   |
|                              | ADC reset time                                     |   | 2   | t <sub>CLK</sub> |      |      |
| TRANSMITTER                  |  |   |   |                  |      |      |
|                              | Output current range                               |   | 0, 50, 75, 100, 150, and 200 (see the <a href="#">LEDCNTRL: LED Control Register</a> for details) |                  |      | mA   |
|                              | LED current DAC error                              |   | ±5%   |                  |      |      |
|                              | Output current resolution                          |   | 8   |                  |      | Bits |
|                              | Transmitter noise dynamic range                    | 0.1-Hz to 20-Hz bandwidth, at 25-mA output current  | 110   |                  |      | dB   |
|                              |  | 0.1-Hz to 20-Hz bandwidth, at 100-mA output current   | 110   |                  |      | dB   |
|                              | Minimum sample time of LED1 and LED2 pulses        |   | 50  |                  |      | μs   |
|                              | LED current DAC leakage current                    | LED_ON = 0  | 1   |                  |      | μA   |
|                              |  | LED_ON = 1  | 50  |                  |      | μA   |
|                              | LED current DAC linearity                          | Percent of full-scale current   | 0.5%  |                  |      |      |
|                              | Output current settling time (with resistive load) | From zero current to 150 mA   | 7   |                  |      | μs   |
|                              |  | From 150 mA to zero current   | 7   |                  |      | μs   |

## Electrical Characteristics (continued)

Minimum and maximum specifications are at  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Typical specifications are at  $25^{\circ}\text{C}$ .

All specifications are at  $\text{RX\_ANA\_SUP} = \text{RX\_DIG\_SUP} = 3\text{ V}$ ,  $\text{TX\_CTRL\_SUP} = \text{LED\_DRV\_SUP} = 5\text{ V}$ , stage 2 amplifier disabled, and  $f_{\text{CLK}} = 8\text{ MHz}$ , unless otherwise noted.

| PARAMETER                               |  | TEST CONDITIONS  | MIN | TYP               | MAX | UNIT          |
|---|--|--|-----|-------------------|-----|---------------|
| DIAGNOSTICS                             |  |  |     |                   |     |               |
| Duration of diagnostics state machine   | EN_SLOW_DIAG = 0<br>Start of diagnostics after the DIAG_EN register bit is set.<br>End of diagnostic indicated by DIAG_END going high. |  |     | 8                 |     | ms            |
|   | EN_SLOW_DIAG = 1<br>Start of diagnostics after the DIAG_EN register bit is set.<br>End of diagnostic indicated by DIAG_END going high. |  |     | 16                |     | ms            |
| Open fault resistance                   |  |  |     | > 100             |     | kΩ            |
| Short fault resistance                  |  |  |     | < 10              |     | kΩ            |
| Diagnostics current                     |  | During diagnostics mode                                  |     | < 100             |     | μA            |
| INTERNAL OSCILLATOR                     |  |  |     |                   |     |               |
| f <sub>CLKOUT</sub>                     | CLKOUT frequency   | With an 8-MHz crystal connected to the XIN and XOUT pins |     | 4                 |     | MHz           |
| DC <sub>CLKOUT</sub>                    | CLKOUT duty cycle  |  |     | 50%               |     |               |
| Crystal oscillator start-up time        |  | With an 8-MHz crystal connected to the XIN and XOUT pins |     | 200               |     | μs            |
| EXTERNAL CLOCK                          |  |  |     |                   |     |               |
| Maximum allowable external clock jitter |  |  |     |                   | 50  | ps            |
| External clock input frequency          |  | ±10%   |     | 8                 |     | MHz           |
| External clock input voltage            | Voltage input high (V <sub>IH</sub> )  |  |     | 0.75 × RX_DIG_SUP |     | V             |
|   | Voltage input low (V <sub>IL</sub> )   |  |     | 0.25 × RX_DIG_SUP |     | V             |
| External clock input current            |  |  |     | 1                 |     | μA            |
| TIMING                                  |  |  |     |                   |     |               |
| Wake-up time from complete power-down   |  |  |     | 1000              |     | ms            |
| Wake-up time from Rx power-down         |  |  |     | 100               |     | μs            |
| Wake-up time from Tx power-down         |  |  |     | 1000              |     | ms            |
| t <sub>RESET</sub>                      | Active low RESET pulse duration  |  |     | 1                 |     | ms            |
| t <sub>DIAGEND</sub>                    | DIAG_END pulse duration at diagnostics completion  |  |     | 4                 |     | CLKOUT cycles |
| t <sub>ADCRDY</sub>                     | ADC_RDY pulse duration   |  |     | 1                 |     | CLKOUT cycles |
| DIGITAL SIGNAL CHARACTERISTICS          |  |  |     |                   |     |               |
| V <sub>IH</sub>                         | Logic high input voltage   | AFE_PDN, SPI CLK, SPI SIMO, SPI STE, RESET               |     | 0.75 × RX_DIG_SUP |     | V             |
| V <sub>IL</sub>                         | Logic low input voltage  | AFE_PDN, SPI CLK, SPI SIMO, SPI STE, RESET               |     | 0.25 × RX_DIG_SUP |     | V             |
| I <sub>IN</sub>                         | Logic input current  | Digital inputs at V <sub>IH</sub> or V <sub>IL</sub>     |     | 0.1               |     | μA            |
| V <sub>OH</sub>                         | Logic high output voltage  | DIAG_END, LED_ALM, PD_ALM, SPI SOMI, ADC_RDY, CLKOUT     |     | RX_DIG_SUP – 0.1  |     | V             |
| V <sub>OL</sub>                         | Logic low output voltage   | DIAG_END, LED_ALM, PD_ALM, SPI SOMI, ADC_RDY, CLKOUT     |     |                   | 0.1 | V             |
| PIN LEAKAGE CURRENT                     |  |  |     |                   |     |               |
| Pin leakage current                     |  | To GND and supply  |     | 1                 |     | nA            |

## Electrical Characteristics (continued)

Minimum and maximum specifications are at  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Typical specifications are at  $25^{\circ}\text{C}$ .

All specifications are at  $\text{RX\_ANA\_SUP} = \text{RX\_DIG\_SUP} = 3\text{ V}$ ,  $\text{TX\_CTRL\_SUP} = \text{LED\_DRV\_SUP} = 5\text{ V}$ , stage 2 amplifier disabled, and  $f_{\text{CLK}} = 8\text{ MHz}$ , unless otherwise noted.

| PARAMETER                                  |                                    | TEST CONDITIONS  | MIN | TYP  | MAX | UNIT          |
|--|------------------------------------|--|-----|------|-----|---------------|
| <b>SUPPLY CURRENT</b>                      |                                    |  |     |      |     |               |
| Receiver analog supply current             |                                    | $\text{RX\_ANA\_SUP} = 3.0\text{ V}$ , with 8-MHz clock running, Rx stage 2 disabled |     | 0.6  |     | mA            |
|  |                                    | $\text{RX\_ANA\_SUP} = 3.0\text{ V}$ , with 8-MHz clock running, Rx stage 2 enabled  |     | 0.7  |     | mA            |
| Receiver digital supply current            |                                    | $\text{RX\_DIG\_SUP} = 3.0\text{ V}$   |     | 0.27 |     | mA            |
| ADC bypass mode                            |                                    | $\text{RX\_ANA\_SUP} + \text{RX\_DIG\_SUP}$<br>(Excluding external ADC current)      |     | 1.8  |     | mA            |
| LED_DRV_SUP                                | LED driver supply current          | With zero LED current setting  |     | 55   |     | $\mu\text{A}$ |
| TX_CTRL_SUP                                | Transmitter control supply current |  |     | 15   |     | $\mu\text{A}$ |
| Complete power-down<br>(using AFE_PDN pin) |                                    | Receiver current only<br>(RX_ANA_SUP)  |     | 3    |     | $\mu\text{A}$ |
|  |                                    | Receiver current only<br>(RX_DIG_SUP)  |     | 3    |     | $\mu\text{A}$ |
|  |                                    | Transmitter current only<br>(LED_DRV_SUP)  |     | 1    |     | $\mu\text{A}$ |
|  |                                    | Transmitter current only<br>(TX_CTRL_SUP)  |     | 1    |     | $\mu\text{A}$ |
| Power-down Rx alone                        |                                    | Receiver current only<br>(RX_ANA_SUP)  |     | 220  |     | $\mu\text{A}$ |
|  |                                    | Receiver current only<br>(RX_DIG_SUP)  |     | 220  |     | $\mu\text{A}$ |
| Power-down Tx alone                        |                                    | Transmitter current only<br>(LED_DRV_SUP)  |     | 2    |     | $\mu\text{A}$ |
|  |                                    | Transmitter current only<br>(TX_CTRL_SUP)  |     | 2    |     | $\mu\text{A}$ |

## Electrical Characteristics (continued)

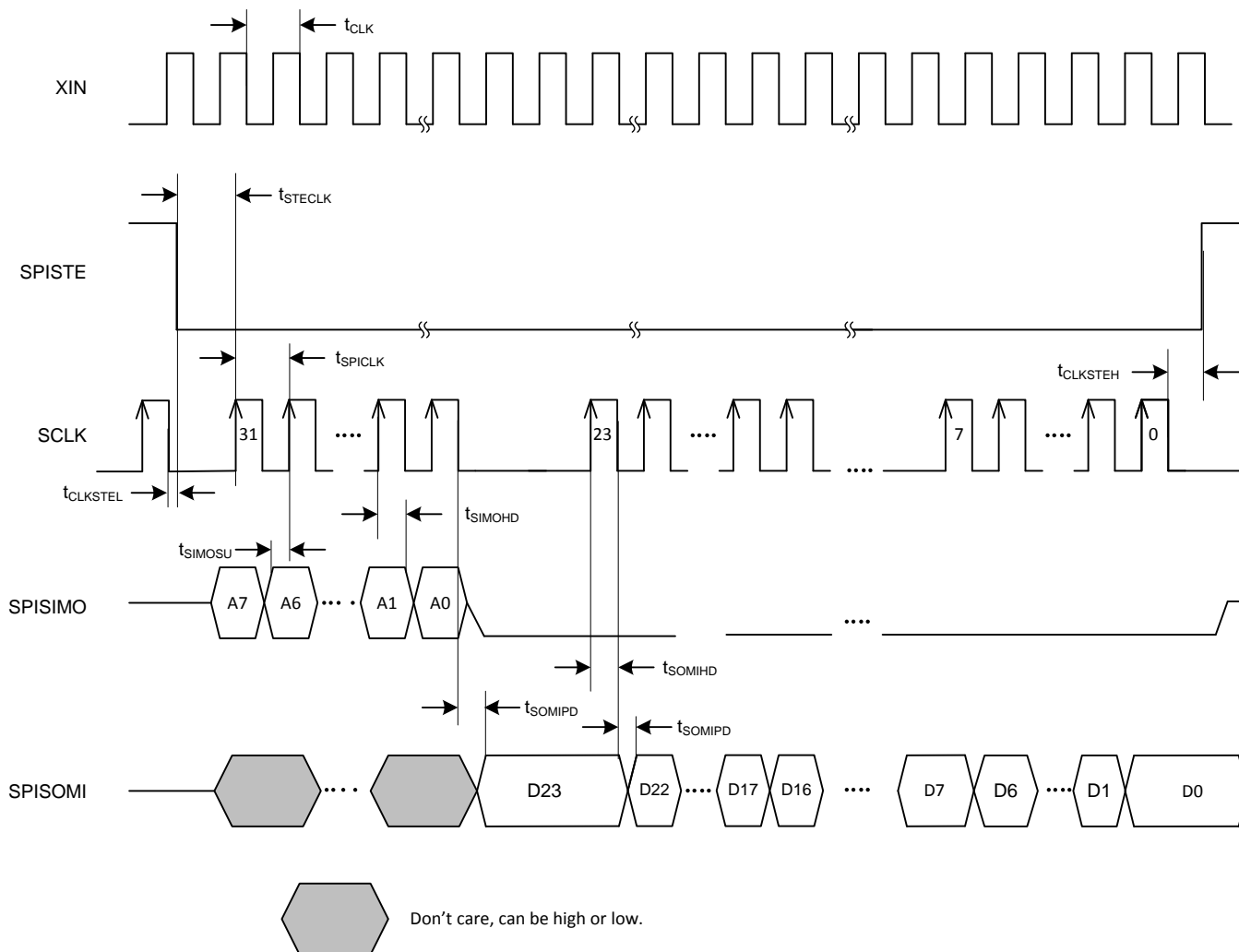
Minimum and maximum specifications are at  $T_A = -40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Typical specifications are at  $25^{\circ}\text{C}$ .

All specifications are at  $\text{RX\_ANA\_SUP} = \text{RX\_DIG\_SUP} = 3\text{ V}$ ,  $\text{TX\_CTRL\_SUP} = \text{LED\_DRV\_SUP} = 5\text{ V}$ , stage 2 amplifier disabled, and  $f_{\text{CLK}} = 8\text{ MHz}$ , unless otherwise noted.

| PARAMETER   |                             | TEST CONDITIONS  | MIN | TYP  | MAX | UNIT          |
|---|-----------------------------|--|-----|------|-----|---------------|
| <b>POWER DISSIPATION</b>                          |                             |  |     |      |     |               |
| $P_{D(q)}$  | Quiescent power dissipation | Normal operation (excluding LEDs)                        |     | 2.84 |     | mW            |
|   |                             | Power-down   |     | 0.1  |     | mW            |
| Power-down with the AFE_PDN pin                   | LED_DRV_SUP                 | LED_DRV_SUP current value. Does not include LED current. |     | 1    |     | $\mu\text{A}$ |
|   | TX_CTRL_SUP                 |  |     | 1    |     | $\mu\text{A}$ |
|   | RX_ANA_SUP                  |  |     | 5    |     | $\mu\text{A}$ |
|   | RX_DIG_SUP                  |  |     | 0.1  |     | $\mu\text{A}$ |
| Power-down with the PDNAFE register bit           | LED_DRV_SUP                 | LED_DRV_SUP current value. Does not include LED current. |     | 1    |     | $\mu\text{A}$ |
|   | TX_CTRL_SUP                 |  |     | 1    |     | $\mu\text{A}$ |
|   | RX_ANA_SUP                  |  |     | 15   |     | $\mu\text{A}$ |
|   | RX_DIG_SUP                  |  |     | 20   |     | $\mu\text{A}$ |
| Power-down Rx                                     | LED_DRV_SUP                 | LED_DRV_SUP current value. Does not include LED current. |     | 50   |     | $\mu\text{A}$ |
|   | TX_CTRL_SUP                 |  |     | 15   |     | $\mu\text{A}$ |
|   | RX_ANA_SUP                  |  |     | 220  |     | $\mu\text{A}$ |
|   | RX_DIG_SUP                  |  |     | 220  |     | $\mu\text{A}$ |
| Power-down Tx                                     | LED_DRV_SUP                 | LED_DRV_SUP current value. Does not include LED current. |     | 2    |     | $\mu\text{A}$ |
|   | TX_CTRL_SUP                 |  |     | 2    |     | $\mu\text{A}$ |
|   | RX_ANA_SUP                  |  |     | 600  |     | $\mu\text{A}$ |
|   | RX_DIG_SUP                  |  |     | 230  |     | $\mu\text{A}$ |
| After reset, with 8-MHz clock running             | LED_DRV_SUP                 | LED_DRV_SUP current value. Does not include LED current. |     | 55   |     | $\mu\text{A}$ |
|   | TX_CTRL_SUP                 |  |     | 15   |     | $\mu\text{A}$ |
|   | RX_ANA_SUP                  |  |     | 600  |     | $\mu\text{A}$ |
|   | RX_DIG_SUP                  |  |     | 230  |     | $\mu\text{A}$ |
| With stage 2 mode enabled and 8-MHz clock running | LED_DRV_SUP                 | LED_DRV_SUP current value. Does not include LED current. |     | 55   |     | $\mu\text{A}$ |
|   | TX_CTRL_SUP                 |  |     | 15   |     | $\mu\text{A}$ |
|   | RX_ANA_SUP                  |  |     | 700  |     | $\mu\text{A}$ |
|   | RX_DIG_SUP                  |  |     | 270  |     | $\mu\text{A}$ |

## 7.6 Timing Requirements: Serial Interface

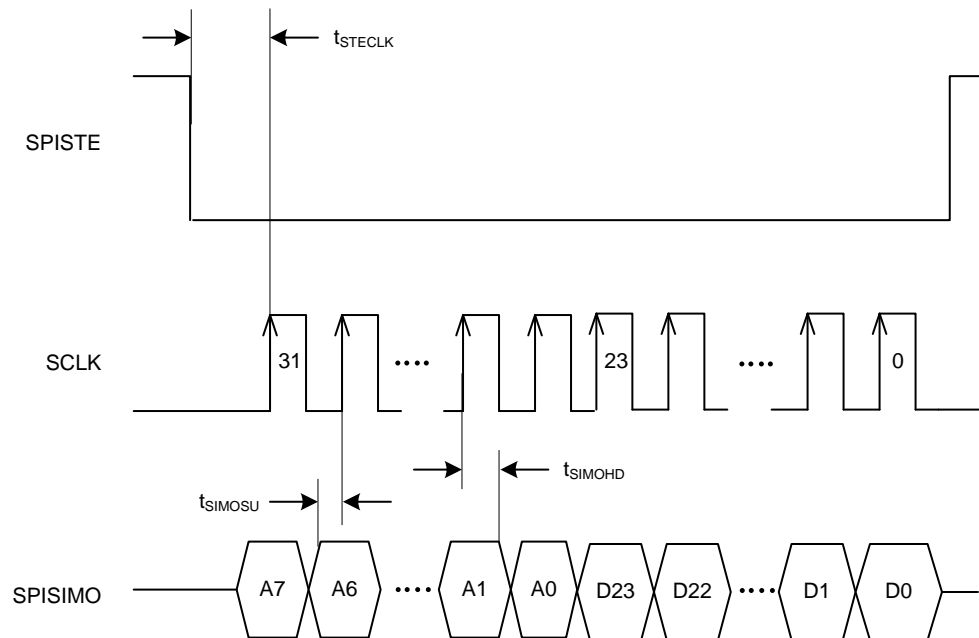
|                 |   | MIN  | TYP | MAX | UNIT       |
|-----------------|---|------|-----|-----|------------|
| $t_{CLK}$       | Clock frequency on XIN pin                        |      | 8   |     | MHz        |
| $t_{SCLK}$      | Serial shift clock period                         | 62.5 |     |     | ns         |
| $t_{STECLK}$    | STE low to SCLK rising edge, setup time           | 10   |     |     | ns         |
| $t_{CLKSTEH,L}$ | SCLK transition to SPI STE high or low            | 10   |     |     | ns         |
| $t_{SIMOSU}$    | SIMO data to SCLK rising edge, setup time         | 10   |     |     | ns         |
| $t_{SIMOHD}$    | Valid SIMO data after SCLK rising edge, hold time | 10   |     |     | ns         |
| $t_{SOMIPD}$    | SCLK falling edge to valid SOMI, setup time       | 17   |     |     | ns         |
| $t_{SOMIHD}$    | SCLK rising edge to invalid data, hold time       | 0.5  |     |     | $t_{SCLK}$ |



- (1) The SPI\_READ register bit must be enabled before attempting a register read.
- (2) Specify the register address whose contents must be read back on A[7:0].
- (3) The AFE outputs the contents of the specified register on the SOMI pin.

**Figure 1. Serial Interface Timing Diagram, Read Operation (1)(2)(3)**



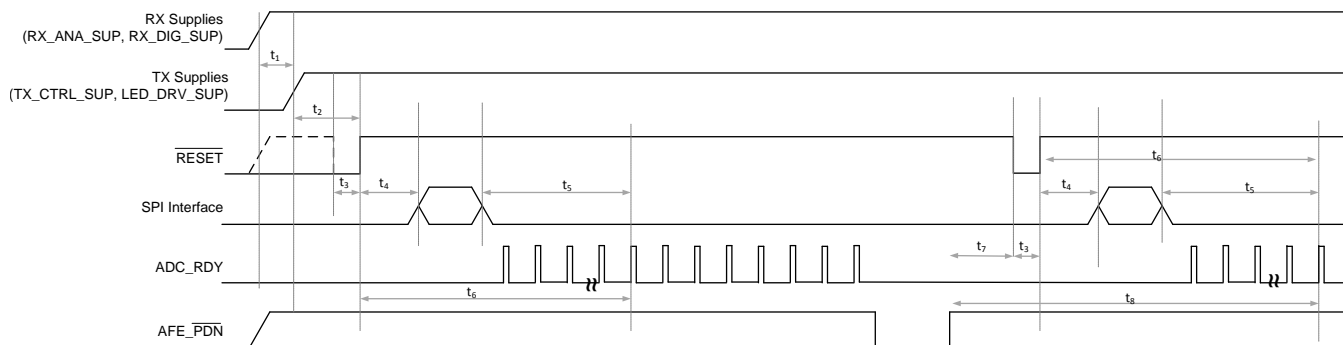


**Figure 2. Serial Interface Timing Diagram, Write Operation**

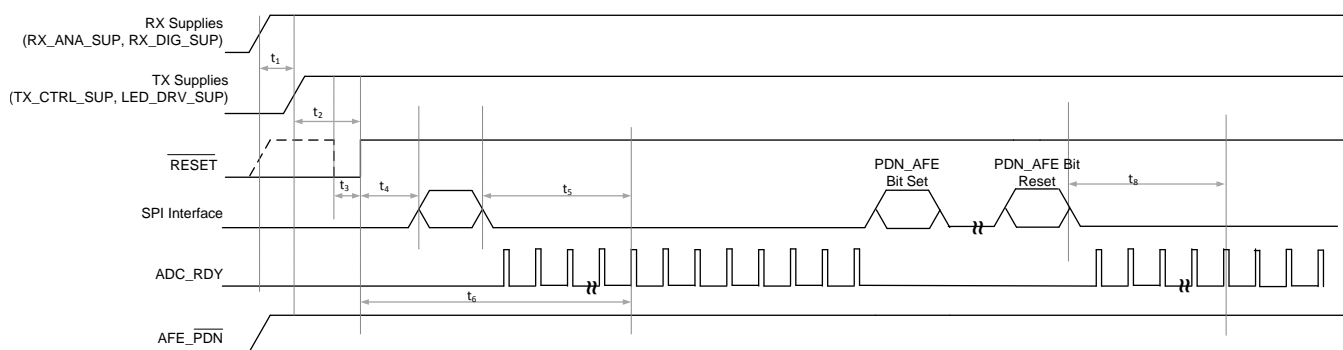
## 7.7 Supply Ramp and Power-Down Timing Requirements

|       |   | VALUE   |
|-------|---|---|
| $t_1$ | Time between Rx and Tx supplies ramping up  | Keep as small as possible (for example, $\pm 10$ ms)                    |
| $t_2$ | Time between both supplies stabilizing and high-going edge of $\overline{\text{RESET}}$   | $> 100$ ms  |
| $t_3$ | $\overline{\text{RESET}}$ pulse width   | $> 0.5$ ms  |
| $t_4$ | Time between $\overline{\text{RESET}}$ and SPI commands   | $> 1$ $\mu\text{s}$   |
| $t_5$ | Time between SPI commands and the $\text{ADC\_RESET}$ which corresponds to valid data   | $> 3$ ms of cumulative sampling time in each phase <sup>(1)(2)(3)</sup> |
| $t_6$ | Time between $\overline{\text{RESET}}$ pulse and high-accuracy data coming out of the signal chain                                | $> 1$ s <sup>(3)</sup>  |
| $t_7$ | Time from $\text{AFE\_PDN}$ high-going edge and $\overline{\text{RESET}}$ pulse <sup>(4)</sup>                                    | $> 100$ ms  |
| $t_8$ | Time from $\text{AFE\_PDN}$ high-going edge (or $\text{PDN\_AFE}$ bit reset) to high-accuracy data coming out of the signal chain | $> 1$ s <sup>(3)</sup>  |

- (1) This time is required for each of the four switched RC filters to fully settle to the new settings. The same time is applicable whenever there is a change to any of the signal chain controls (for example, LED current setting, TIA gain, and so forth)
- (2) If the SPI commands involve a change in the value of  $\text{TX\_REF}$  from its default, then there is additional wait time that is approximately 1 s (for a 2.2- $\mu\text{F}$  decoupling capacitor on the  $\text{TX\_REF}$  pin).
- (3) Dependent on the value of the capacitors on the BG and  $\text{TX\_REF}$  pins. The 1-s wait time is necessary when the capacitors are 2.2  $\mu\text{F}$  and scale down proportionate to the capacitor value. A very low capacitor (for example, 0.1  $\mu\text{F}$ ) on these pins causes the transmitter dynamic range to reduce to approximately 100 dB.
- (4) After an active power-down from  $\text{AFE\_PDN}$ , reset the device by using a low-going pulse on  $\overline{\text{RESET}}$ .



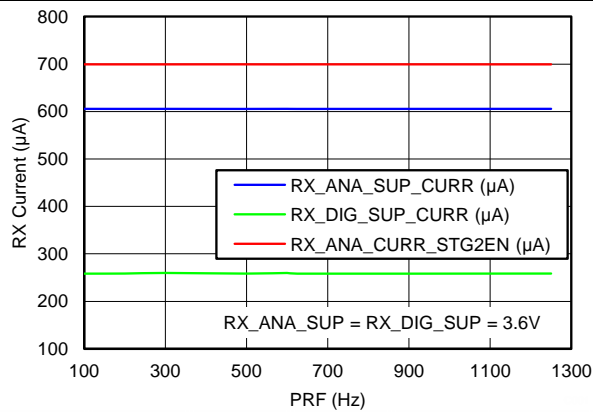
**Figure 3. Supply Ramp and Hardware Power-Down Timing**



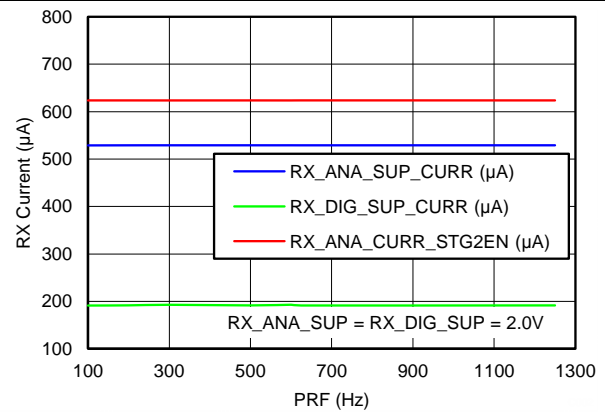
**Figure 4. Supply Ramp and Software Power-Down Timing**

## 7.8 Typical Characteristics

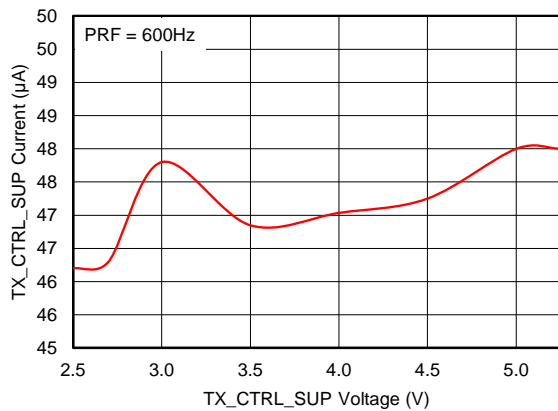
At  $T_A = 25^\circ\text{C}$ ,  $\text{RX\_ANA\_SUP} = \text{RX\_DIG\_SUP} = 3.0\text{ V}$ ,  $\text{TX\_CTRL\_SUP} = \text{LED\_DRV\_SUP} = 5\text{ V}$ , and  $f_{\text{CLK}} = 8\text{ MHz}$ , unless otherwise noted.



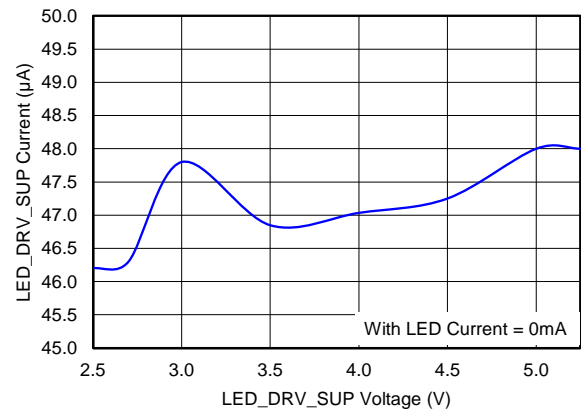
**Figure 5. Total Rx Current vs PRF**



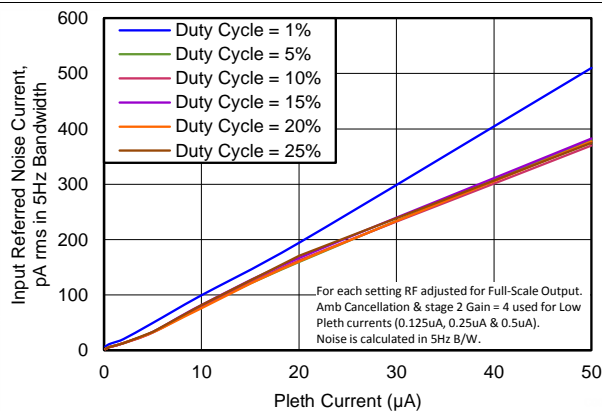
**Figure 6. Total Rx Current vs PRF**



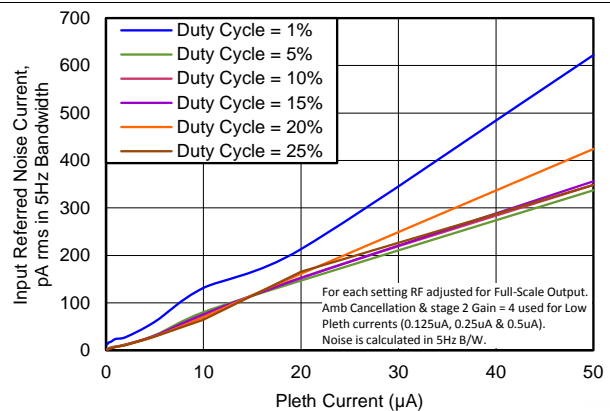
**Figure 7. TX\_CTRL\_SUP Current vs TX\_CTRL\_SUP Voltage**



**Figure 8. LED\_DRV\_SUP Current vs LED\_DRV\_SUP Voltage**



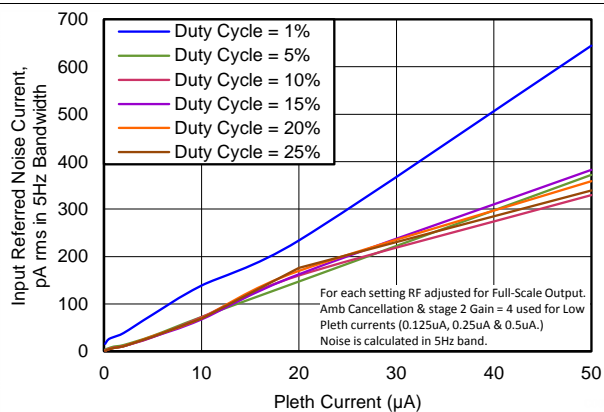
**Figure 9. Input-Referred Noise Current vs PLETH Current (BW = 5 Hz, PRF = 100 Hz)**



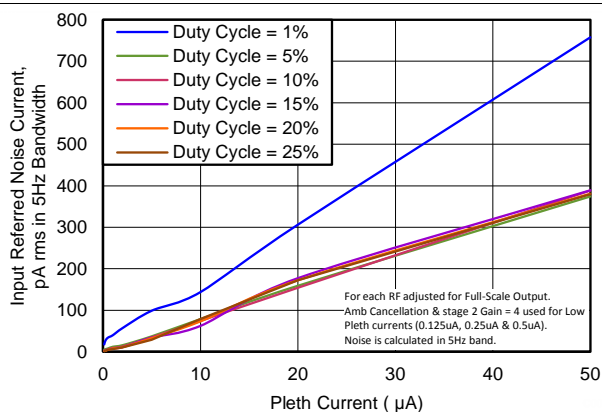
**Figure 10. Input-Referred Noise Current vs PLETH Current (BW = 5 Hz, PRF = 300 Hz)**

## Typical Characteristics (continued)

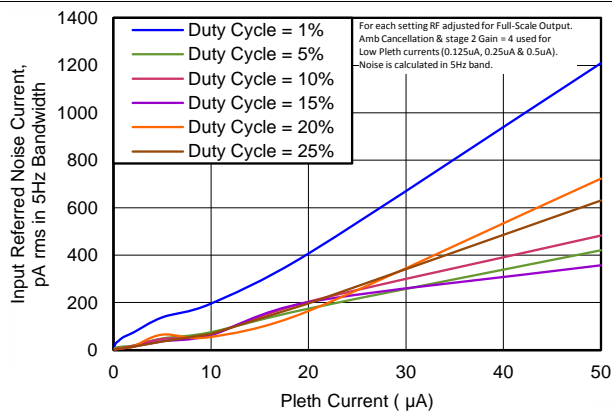
At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.



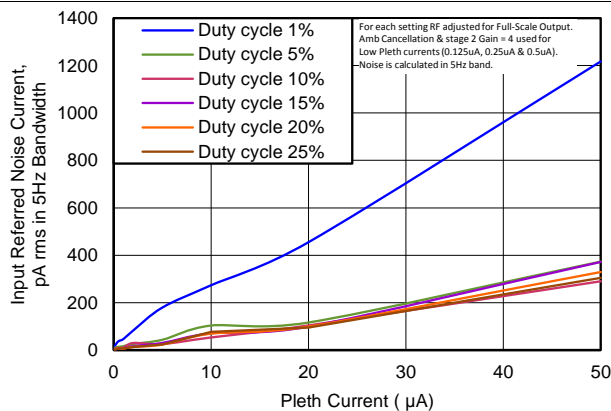
**Figure 11. Input-Referred Noise Current vs PLETH Current (BW = 5 Hz, PRF = 600 Hz)**



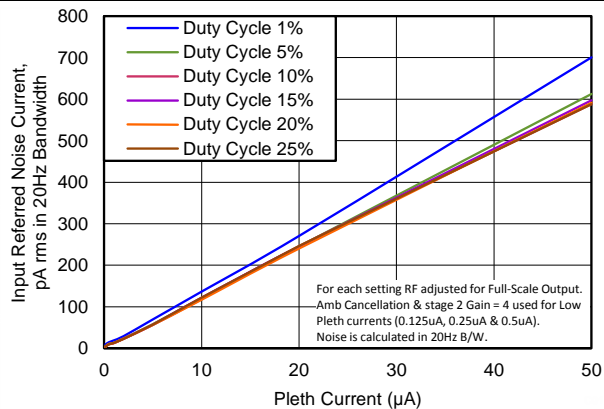
**Figure 12. Input-Referred Noise Current vs PLETH Current (BW = 5 Hz, PRF = 1200 Hz)**



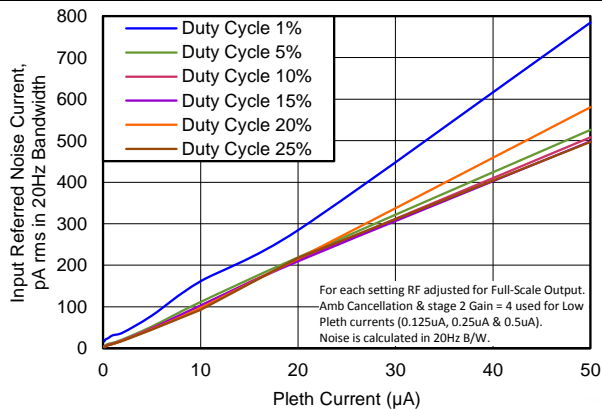
**Figure 13. Input-Referred Noise Current vs PLETH Current (BW = 5 Hz, PRF = 2500 Hz)**



**Figure 14. Input-Referred Noise Current vs PLETH Current (BW = 5 Hz, PRF = 5000 Hz)**



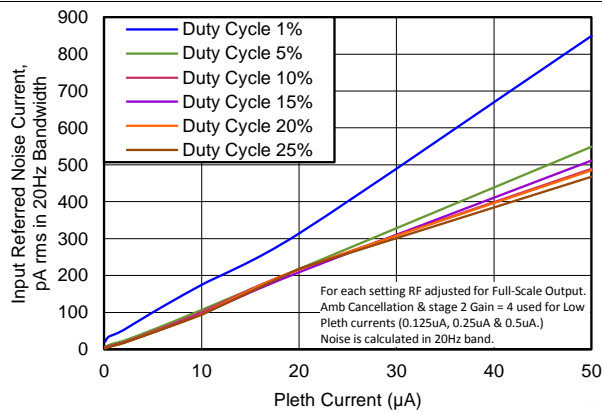
**Figure 15. Input-Referred Noise Current vs PLETH Current (BW = 20 Hz, PRF = 100 Hz)**



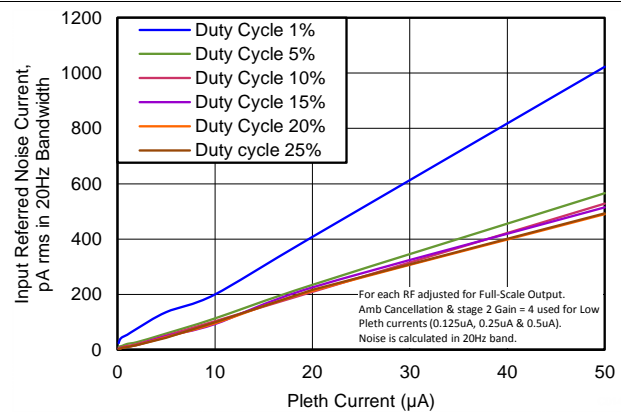
**Figure 16. Input-Referred Noise Current vs PLETH Current (BW = 20 Hz, PRF = 300 Hz)**

## Typical Characteristics (continued)

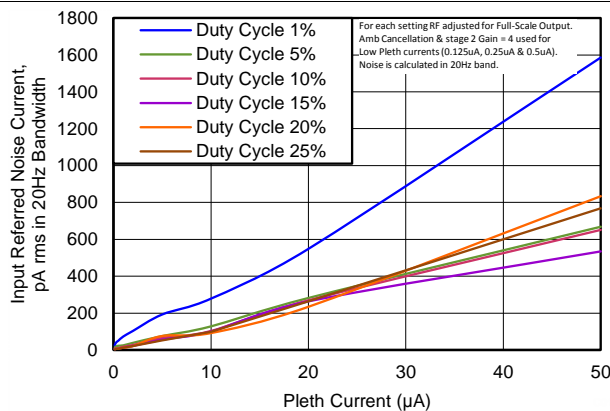
At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.



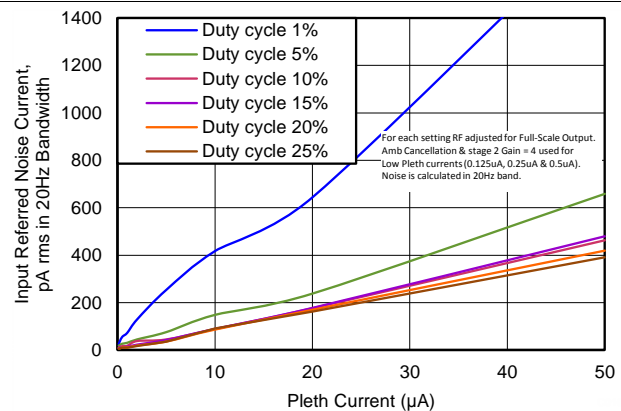
**Figure 17. Input-Referred Noise Current vs PLETH Current (BW = 20 Hz, PRF = 600 Hz)**



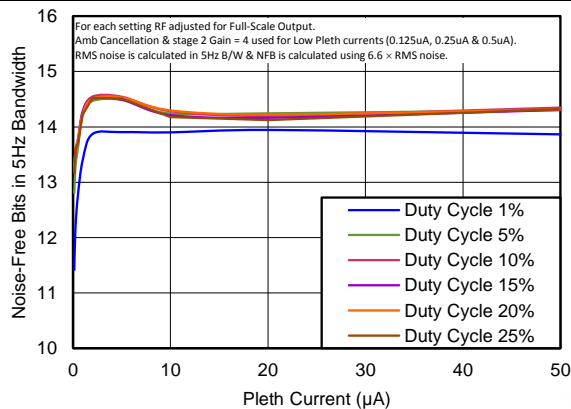
**Figure 18. Input-Referred Noise Current vs PLETH Current (BW = 20 Hz, PRF = 1200 Hz)**



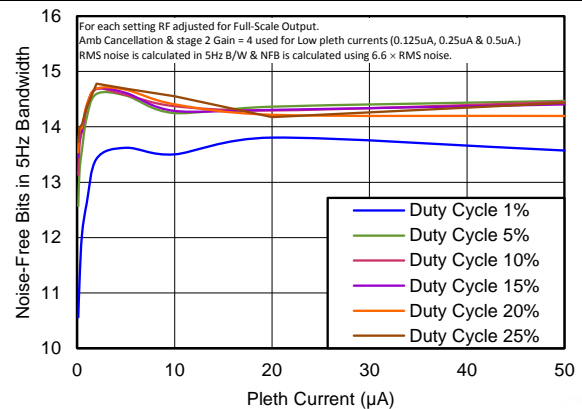
**Figure 19. Input-Referred Noise Current vs PLETH Current (BW = 20 Hz, PRF = 2500 Hz)**



**Figure 20. Input-Referred Noise Current vs PLETH Current (BW = 20 Hz, PRF = 5000 Hz)**



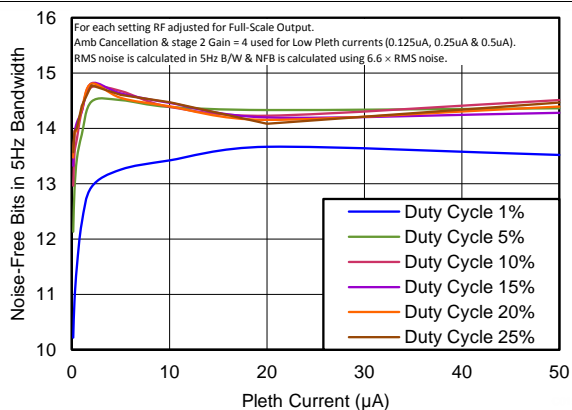
**Figure 21. Noise-Free Bits vs PLETH Current (BW = 5 Hz, PRF = 100 Hz)**



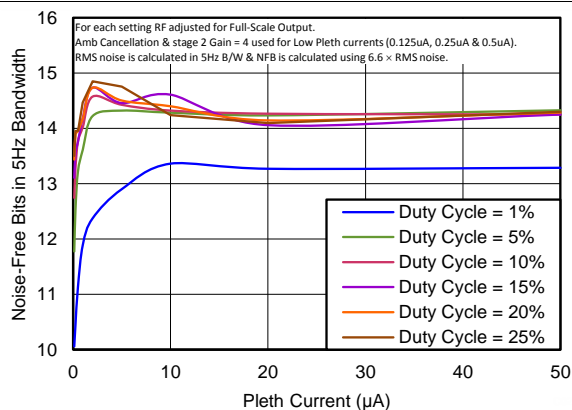
**Figure 22. Noise-Free Bits vs PLETH Current (BW = 5 Hz, PRF = 300 Hz)**

## Typical Characteristics (continued)

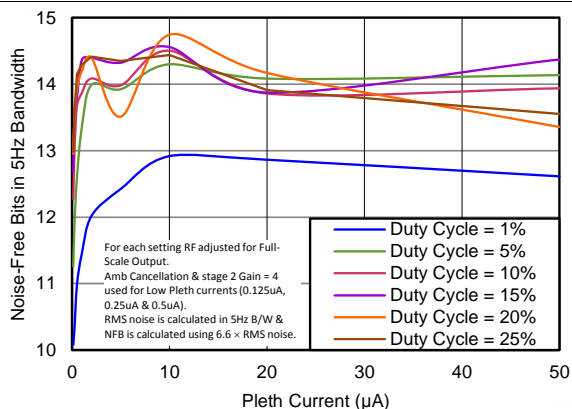
At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.



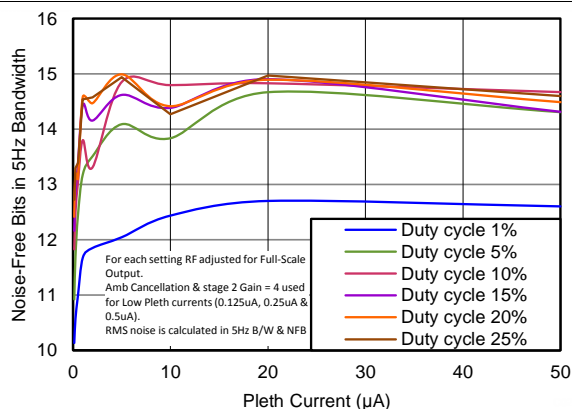
**Figure 23. Noise-Free Bits vs PLETH Current (BW = 5 Hz, PRF = 600 Hz)**



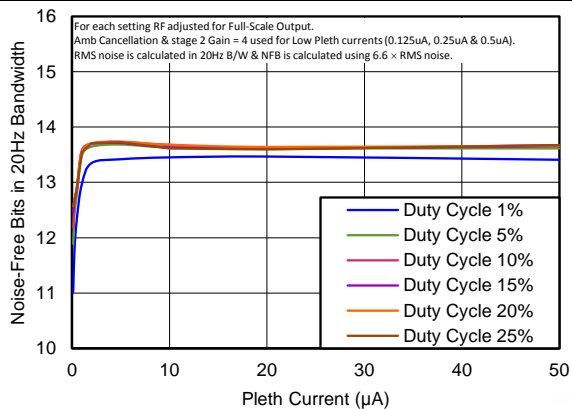
**Figure 24. Noise-Free Bits vs PLETH Current (BW = 5 Hz, PRF = 1200 Hz)**



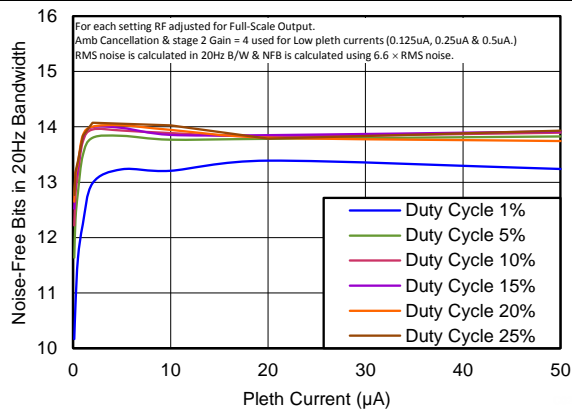
**Figure 25. Noise-Free Bits vs PLETH Current (BW = 5 Hz, PRF = 2500 Hz)**



**Figure 26. Noise-Free Bits vs PLETH Current (BW = 5 Hz, PRF = 5000 Hz)**



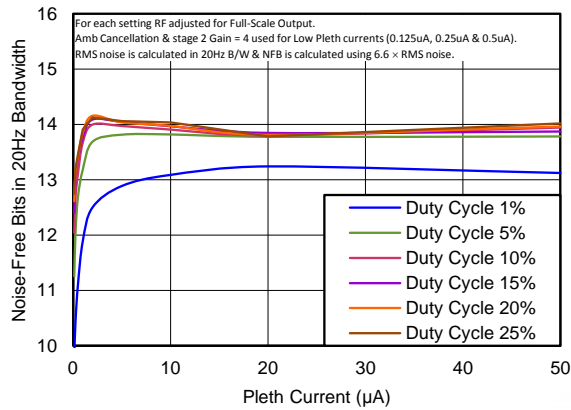
**Figure 27. Noise-Free Bits vs PLETH Current (BW = 20 Hz, PRF = 100 Hz)**



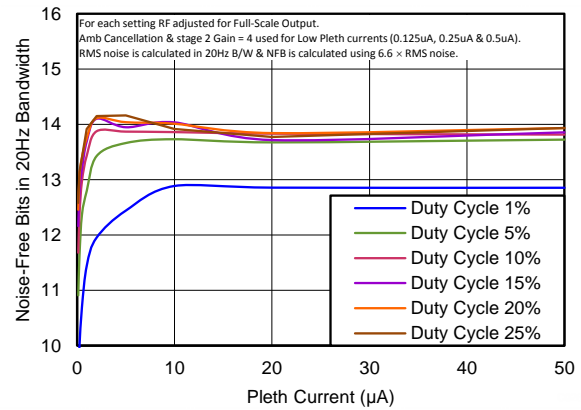
**Figure 28. Noise-Free Bits vs PLETH Current (BW = 20 Hz, PRF = 300 Hz)**

## Typical Characteristics (continued)

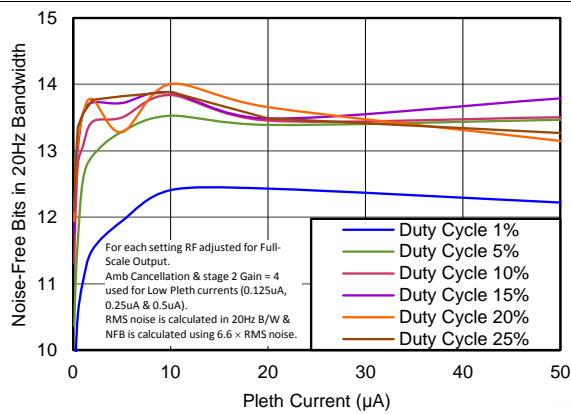
At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.



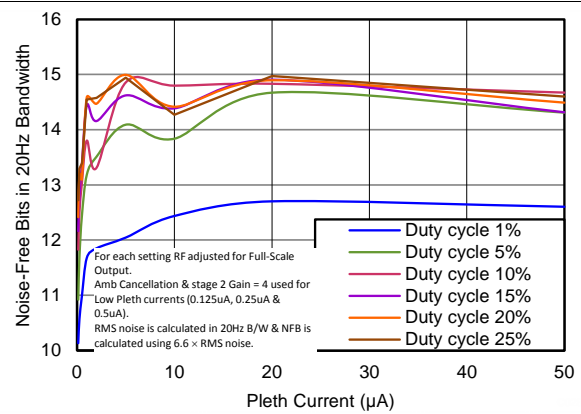
**Figure 29. Noise-Free Bits vs PLETH Current (BW = 20 Hz, PRF = 600 Hz)**



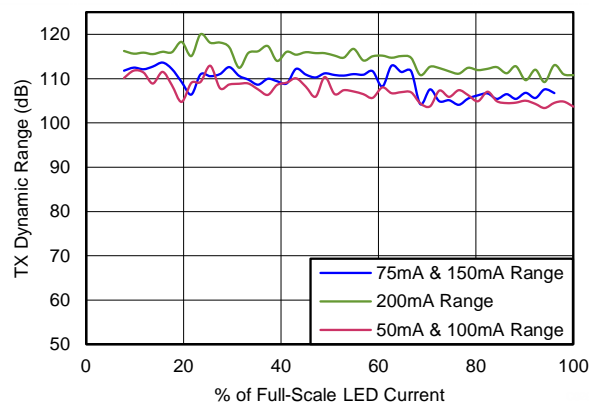
**Figure 30. Noise-Free Bits vs PLETH Current (BW = 20 Hz, PRF = 1200 Hz)**



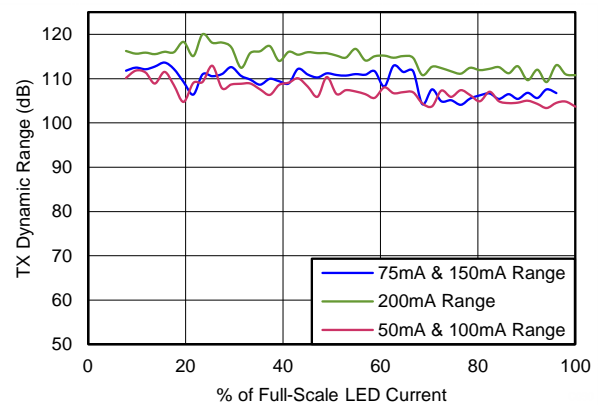
**Figure 31. Noise-Free Bits vs PLETH Current (BW = 20 Hz, PRF = 2500 Hz)**



**Figure 32. Noise-Free Bits vs PLETH Current (BW = 20 Hz, PRF = 5000 Hz)**



**Figure 33. Transmitter Dynamic Range (5-Hz BW)**

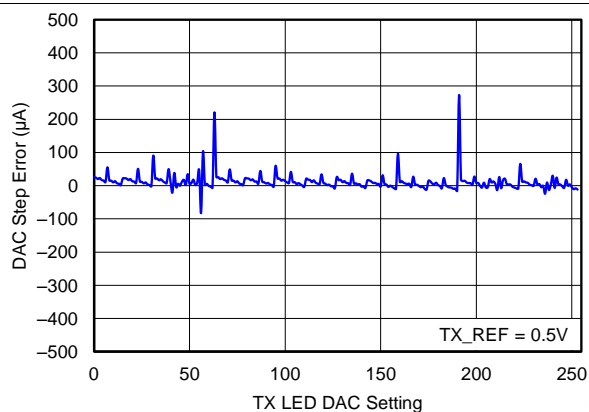


**Figure 34. Transmitter Dynamic Range (20-Hz BW)**

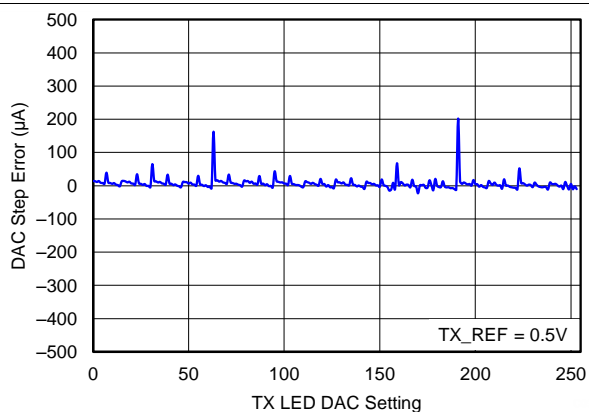


## Typical Characteristics (continued)

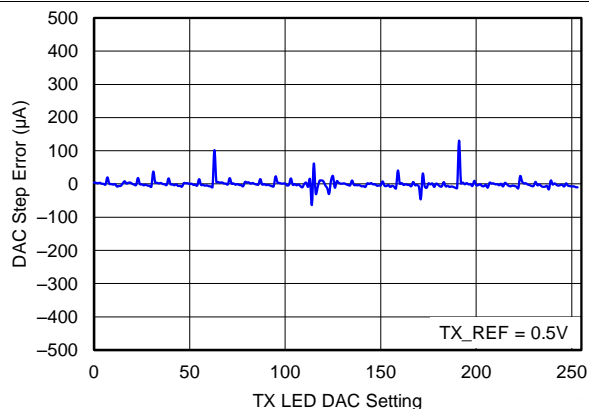
At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.



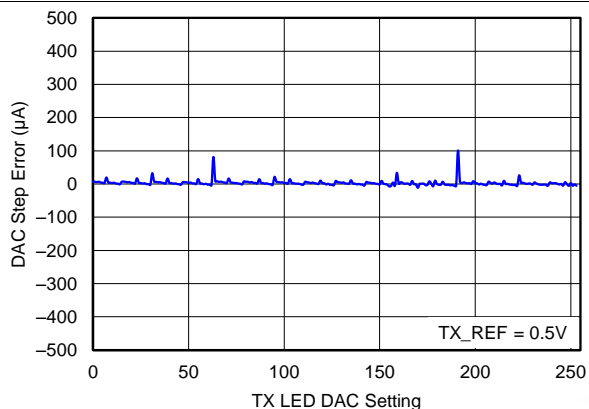
**Figure 35. Transmitter DAC Current Step Error (200 mA, Max)**



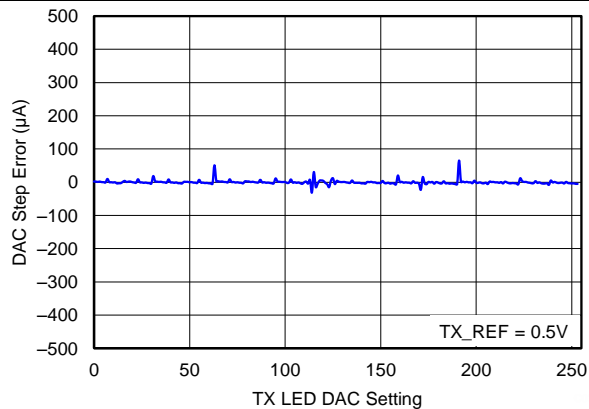
**Figure 36. Transmitter DAC Current Step Error (150 mA, Max)**



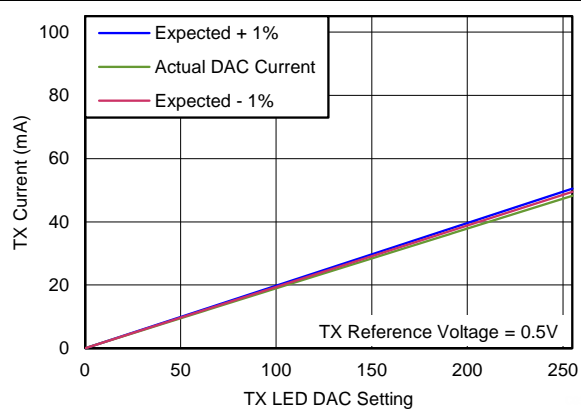
**Figure 37. Transmitter DAC Current Step Error (100 mA, Max)**



**Figure 38. Transmitter DAC Current Step Error (75 mA, Max)**



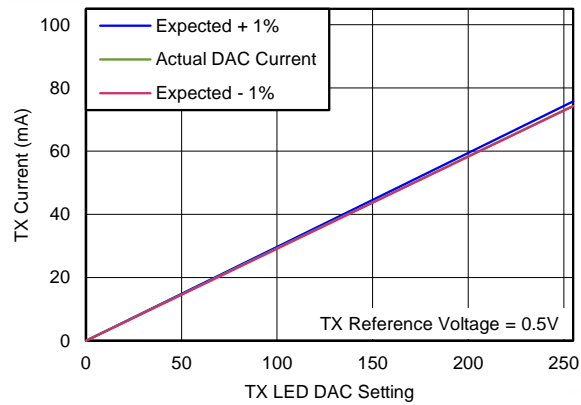
**Figure 39. Transmitter DAC Current Step Error (50 mA, Max)**



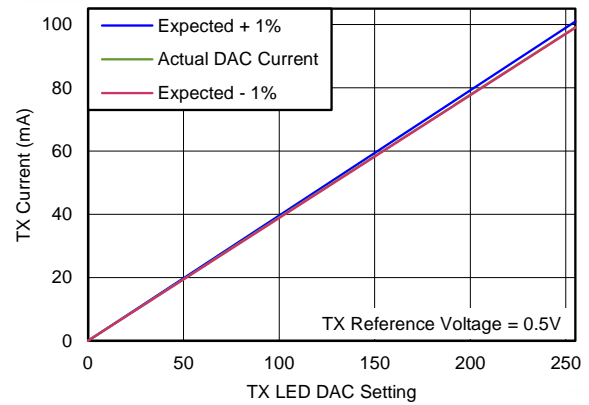
**Figure 40. Transmitter Current Linearity (50-mA Range)**

## Typical Characteristics (continued)

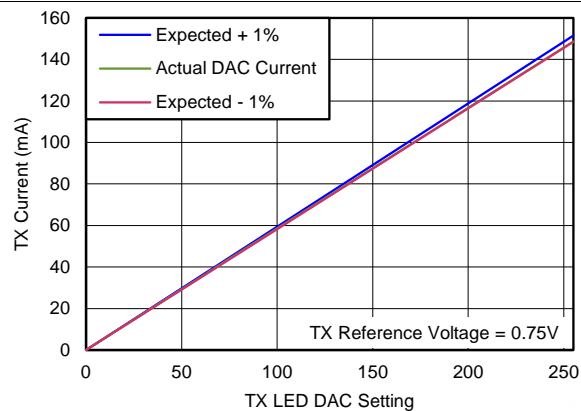
At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.



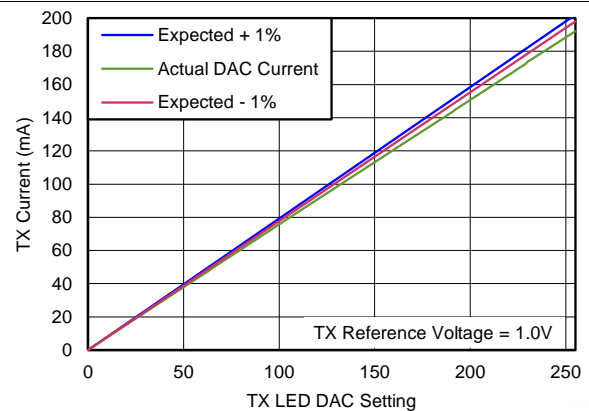
**Figure 41. Transmitter Current Linearity (75-mA Range)**



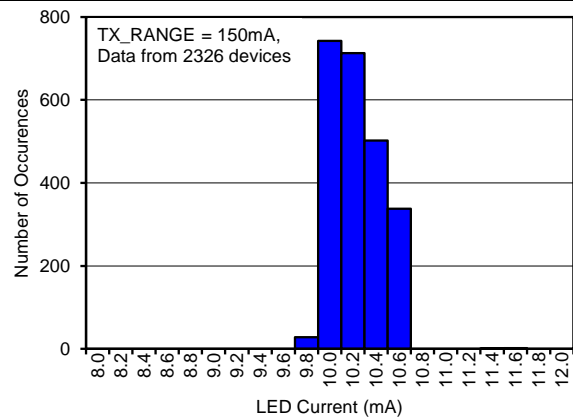
**Figure 42. Transmitter Current Linearity (100-mA Range)**



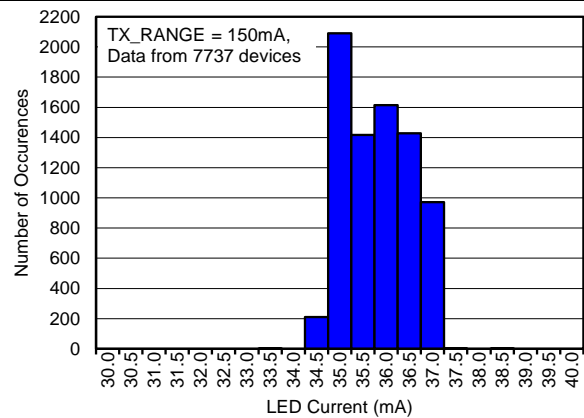
**Figure 43. Transmitter Current Linearity (150-mA Range)**



**Figure 44. Transmitter Current Linearity (200-mA Range)**



**Figure 45. LED Current with Tx DAC Setting = 17 (10 mA)**



**Figure 46. LED Current with Tx DAC Setting = 60 (35 mA)**

## Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.

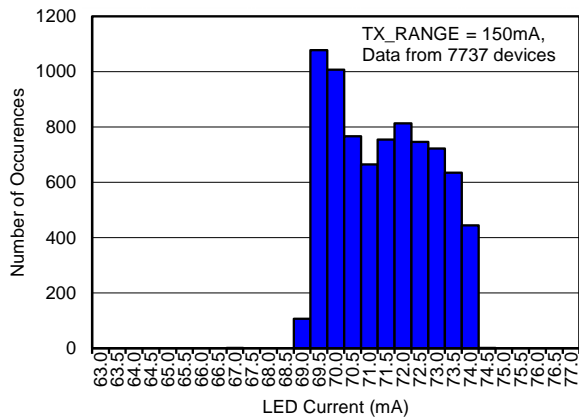


Figure 47. LED Current with Tx DAC Setting = 120 (70 mA)

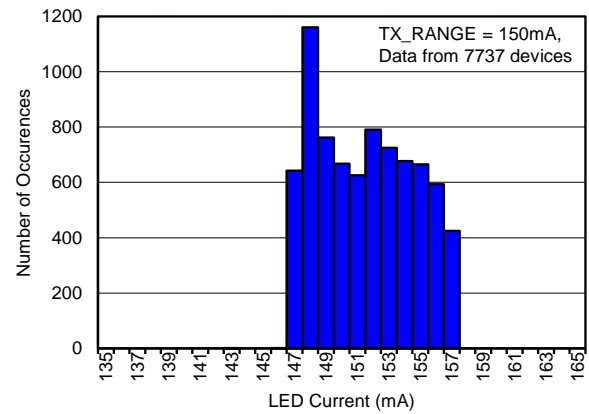


Figure 48. LED Current with Tx DAC Setting = 255 (150 mA)

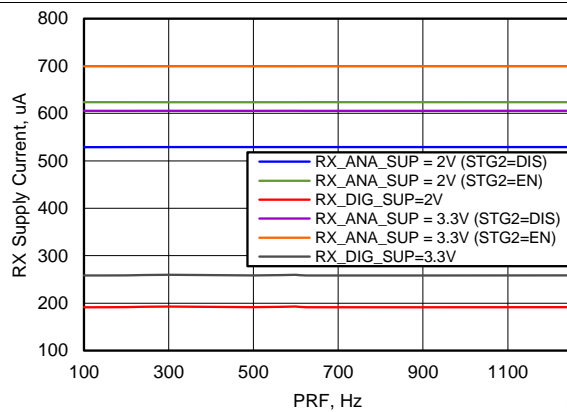


Figure 49. Receiver Supplies vs PRF

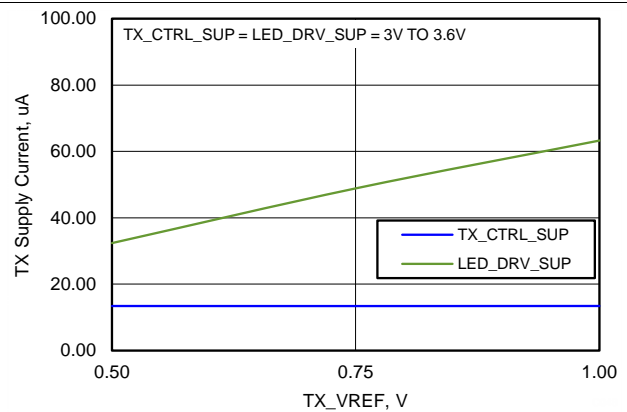


Figure 50. Transmitter Supplies vs TX\_REF

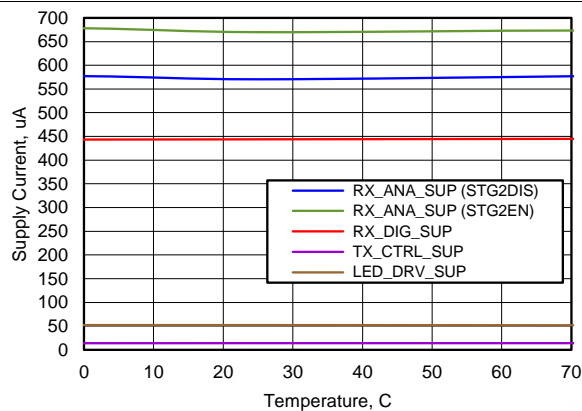


Figure 51. Power Supplies vs Temperature

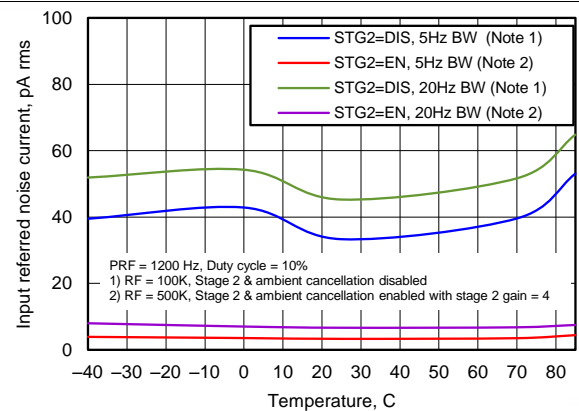
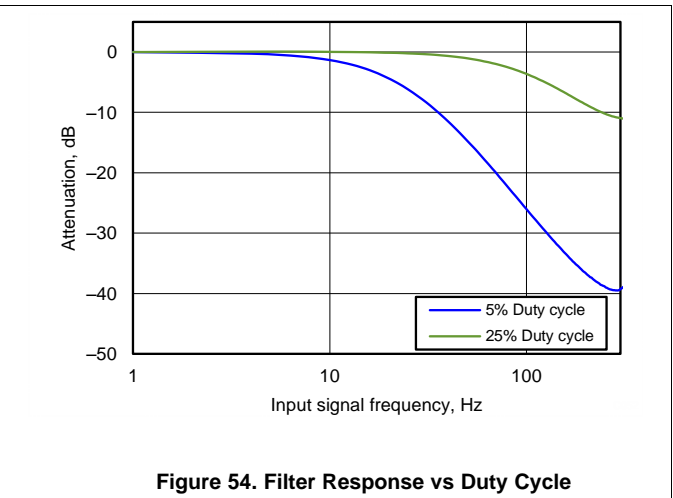
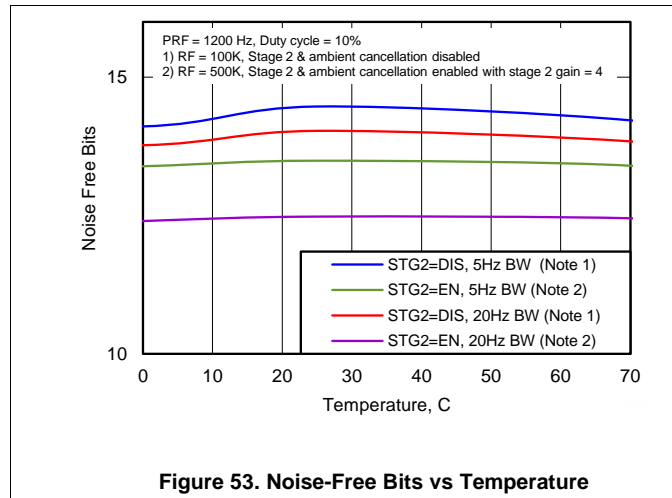


Figure 52. Input-Referred Noise vs Temperature

## Typical Characteristics (continued)

At  $T_A = 25^\circ\text{C}$ ,  $RX\_ANA\_SUP = RX\_DIG\_SUP = 3.0\text{ V}$ ,  $TX\_CTRL\_SUP = LED\_DRV\_SUP = 5\text{ V}$ , and  $f_{CLK} = 8\text{ MHz}$ , unless otherwise noted.

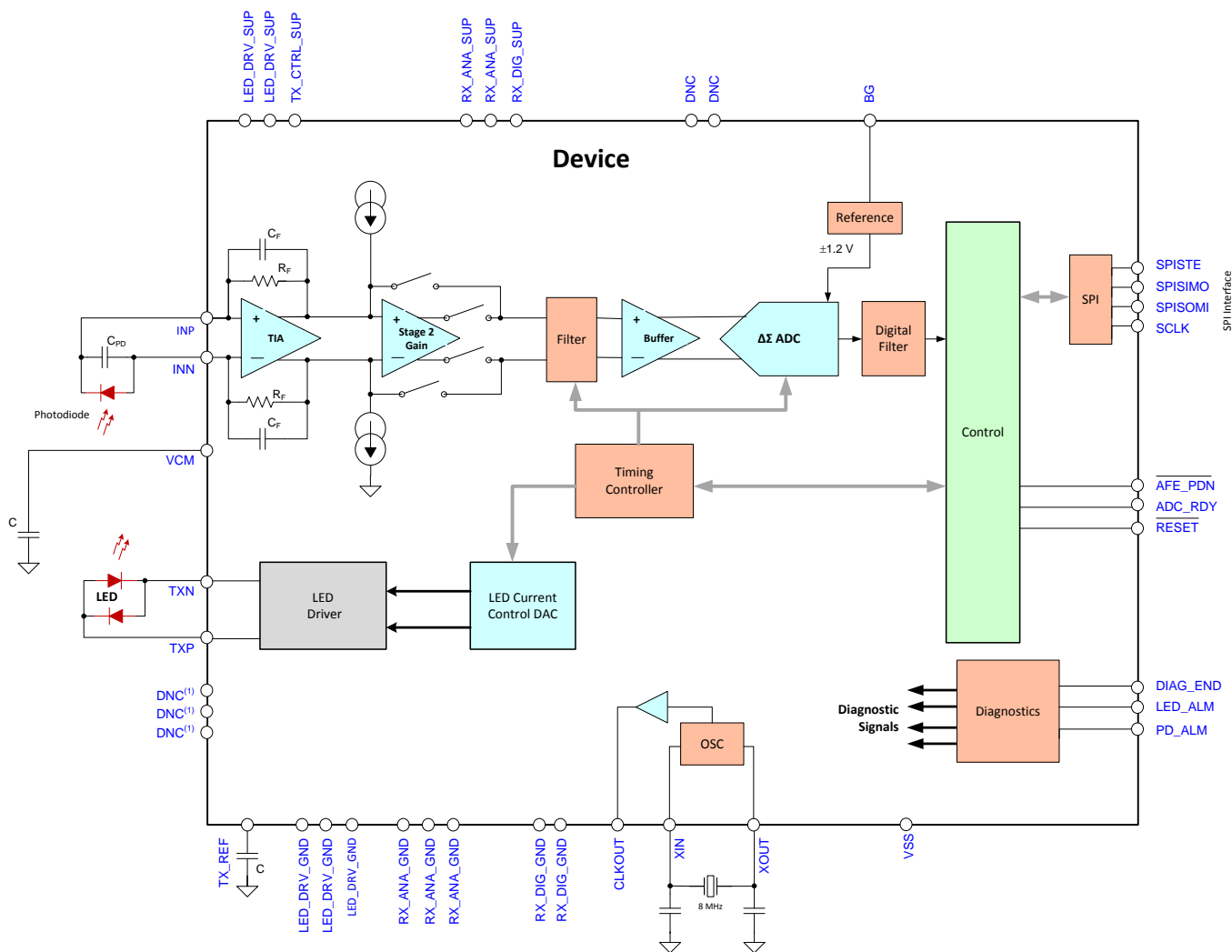


## 8 Detailed Description

### 8.1 Overview

The AFE4490 is a complete analog front-end (AFE) solution targeted for pulse-oximeter applications. The device consists of a low-noise receiver channel, an LED transmit section, and diagnostics for sensor and LED fault detection. To ease clocking requirements and provide the low-jitter clock to the AFE, an oscillator is also integrated that functions from an external crystal. The device communicates to an external microcontroller or host processor using an SPI interface. The [Functional Block Diagram](#) section provides a detailed block diagram for the device. The blocks are described in more detail in the following sections.

### 8.2 Functional Block Diagram





## Feature Description (continued)

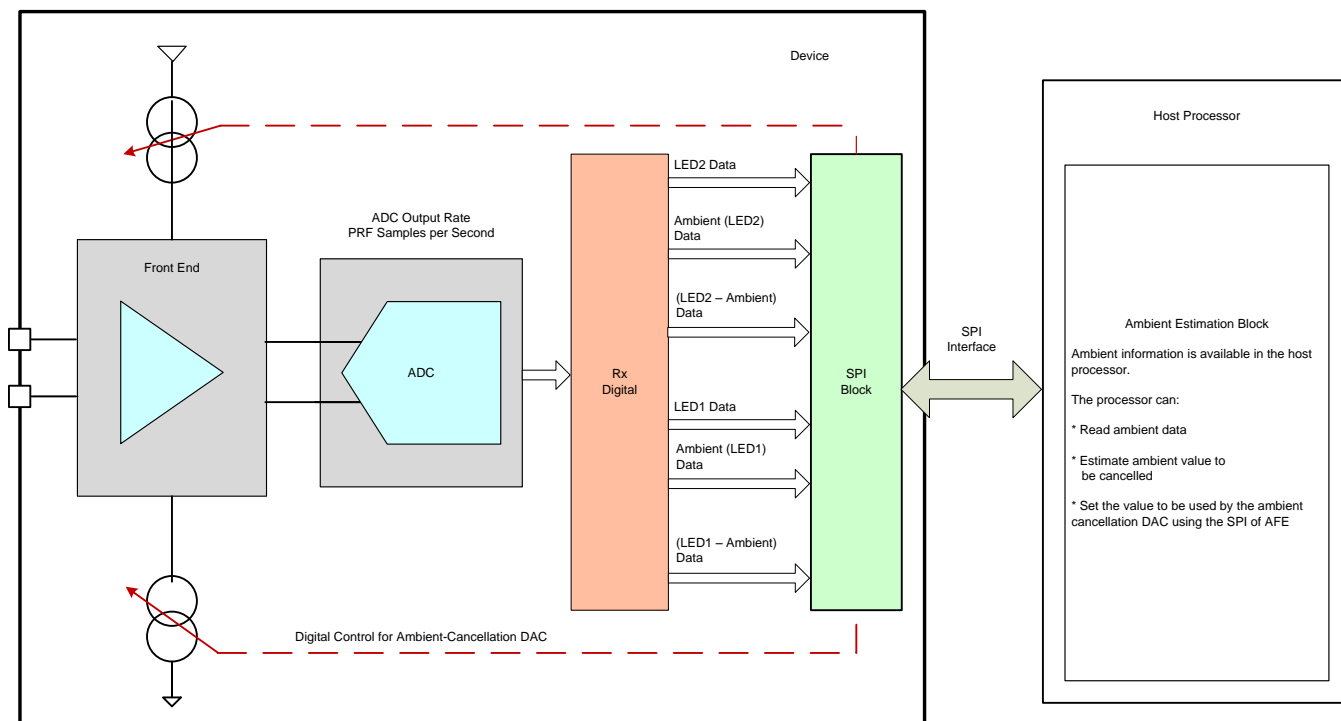
The sampling duration is termed the *Rx sample time* and is programmable for each signal, independently. Sampling can start after the I-V amplifier output is stable (to account for LED and cable settling times). The Rx sample time is used for all dynamic range calculations; the minimum time supported is 50  $\mu$ s.

A single, 22-bit ADC converts the sampled LED2, LED1, and ambient signals sequentially. Each conversion takes a maximum of 25% of the pulse repetition period (PRP) and provides a single digital code at the ADC output. As discussed in the [Receiver Timing](#) section, the conversions are staggered so that the LED2 conversion starts after the end of the LED2 sample phase, and so on. This configuration also means that the Rx sample time for each signal is no greater than 25% of the pulse repetition period.

Note that four data streams are available at the ADC output (LED2, LED1, ambient LED2, and ambient LED1) at the same rate as the pulse repetition frequency. The ADC is followed by a digital ambient subtraction block that additionally outputs the (LED2 – ambient LED2) and (LED1 – ambient LED1) data values.

### 8.3.1.2 Ambient Cancellation Scheme

The receiver provides digital samples corresponding to ambient duration. The host processor (external to the AFE) can use these ambient values to estimate the amount of ambient light leakage. The processor must then set the value of the ambient cancellation DAC using the SPI, as shown in [Figure 56](#).

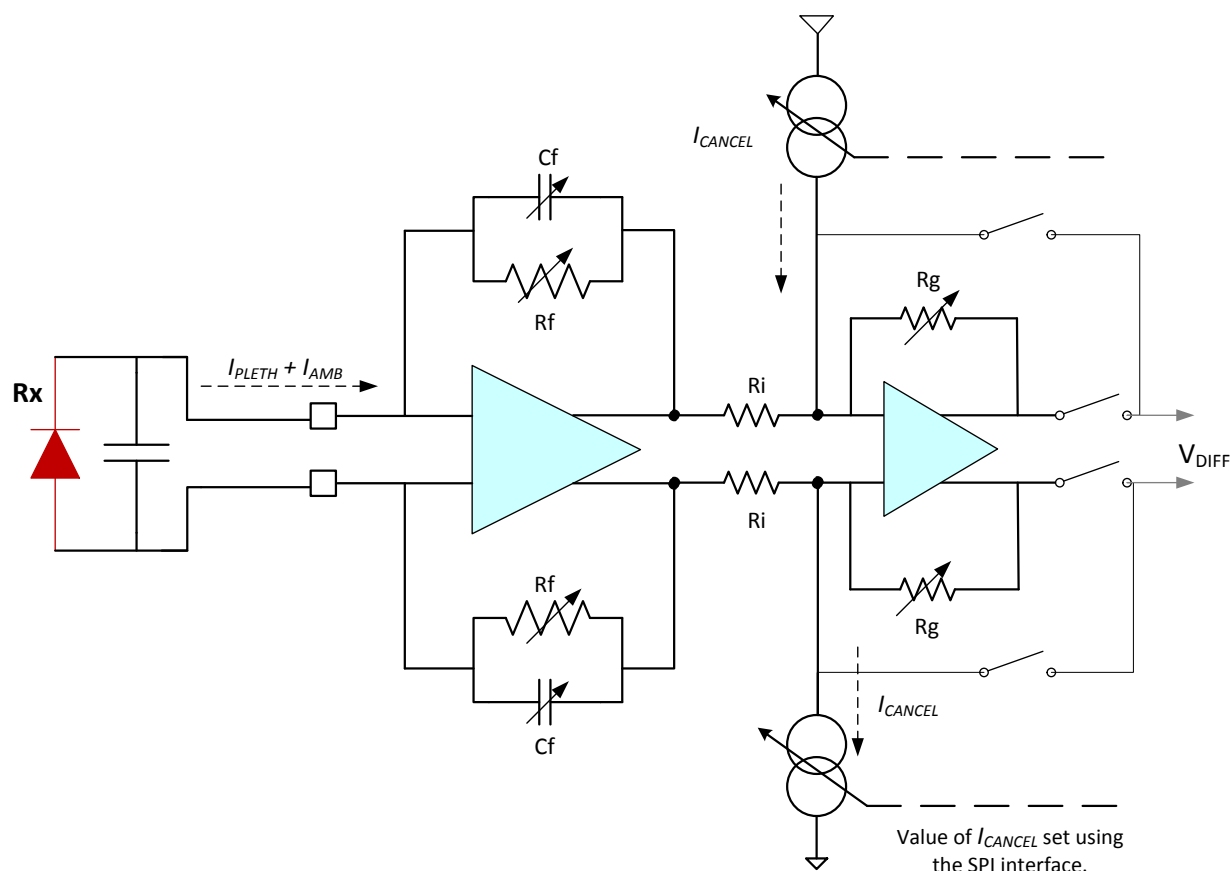


**Figure 56. Ambient Cancellation Loop (Closed by the Host Processor)**



## Feature Description (continued)

Using the set value, the ambient cancellation stage subtracts the ambient component and gains up only the pleth component of the received signal, as shown in Figure 57. The amplifier gain is programmable to 0 dB, 3.5 dB, 6 dB, 9.5 dB, and 12 dB.



**Figure 57. Front-End (I-V Amplifier and Cancellation Stage)**

The differential output of the second stage is  $V_{DIFF}$ , as given by Equation 2:

$$V_{DIFF} = 2 \times \left[ I_{PLETH} \times \frac{R_F}{R_I} + I_{AMB} \times \frac{R_F}{R_I} - I_{CANCEL} \right] \times R_G$$

where:

- $R_I = 100 \text{ k}\Omega$ ,
- $I_{PLETH}$  = photodiode current pleth component,
- $I_{AMB}$  = photodiode current ambient component, and
- $I_{CANCEL}$  = the cancellation current DAC value (as estimated by the host processor).

(2)

## Feature Description (continued)

$R_G$  values with various gain settings are listed in [Table 1](#).

**Table 1.  $R_G$  Values**

| $R_G$ (dB) | GAIN (k $\Omega$ ) |
|------------|--------------------|
| 0 (x1)     | 100                |
| 3.5 (x1.5) | 150                |
| 6 (x2)     | 200                |
| 9.5 (x3)   | 300                |
| 12 (x4)    | 400                |

### 8.3.1.3 Receiver Control Signals

**LED2 sample phase ( $S_{LED2}$ ):** When this signal is high, the amplifier output corresponds to the LED2 on-time. The amplifier output is filtered and sampled into capacitor  $C_{LED2}$ . To avoid settling effects resulting from the LED or cable, program  $S_{LED2}$  to start after the LED turns on. This settling delay is programmable.

**Ambient sample phase ( $S_{LED2\_amb}$ ):** When this signal is high, the amplifier output corresponds to the LED2 off-time and can be used to estimate the ambient signal (for the LED2 phase). The amplifier output is filtered and sampled into capacitor  $C_{LED2\_amb}$ .

**LED1 sample phase ( $S_{LED1}$ ):** When this signal is high, the amplifier output corresponds to the LED1 on-time. The amplifier output is filtered and sampled into capacitor  $C_{LED1}$ . To avoid settling effects resulting from the LED or cable, program  $S_{LED1}$  to start after the LED turns on. This settling delay is programmable.

**Ambient sample phase ( $S_{LED1\_amb}$ ):** When this signal is high, the amplifier output corresponds to the LED1 off-time and can be used to estimate the ambient signal (for the LED1 phase). The amplifier output is filtered and sampled into capacitor  $C_{LED1\_amb}$ .

**LED2 convert phase ( $CONV_{LED2}$ ):** When this signal is high, the voltage sampled on  $C_{LED2}$  is buffered and applied to the ADC for conversion. The conversion time duration is always 25% of the pulse repetition period. At the end of the conversion, the ADC provides a single digital code corresponding to the LED2 sample.

**Ambient convert phases ( $CONV_{LED2\_amb}$ ,  $CONV_{LED1\_amb}$ ):** When this signal is high, the voltage sampled on  $C_{LED2\_amb}$  (or  $C_{LED1\_amb}$ ) is buffered and applied to the ADC for conversion. The conversion time duration is always 25% of the pulse repetition period. At the end of the conversion, the ADC provides a single digital code corresponding to the ambient sample.

**LED1 convert phase ( $CONV_{LED1}$ ):** When this signal is high, the voltage sampled on  $C_{LED1}$  is buffered and applied to the ADC for conversion. The conversion time duration is always 25% of the pulse repetition period. At the end of the conversion, the ADC provides a single digital code corresponding to the LED1 sample.

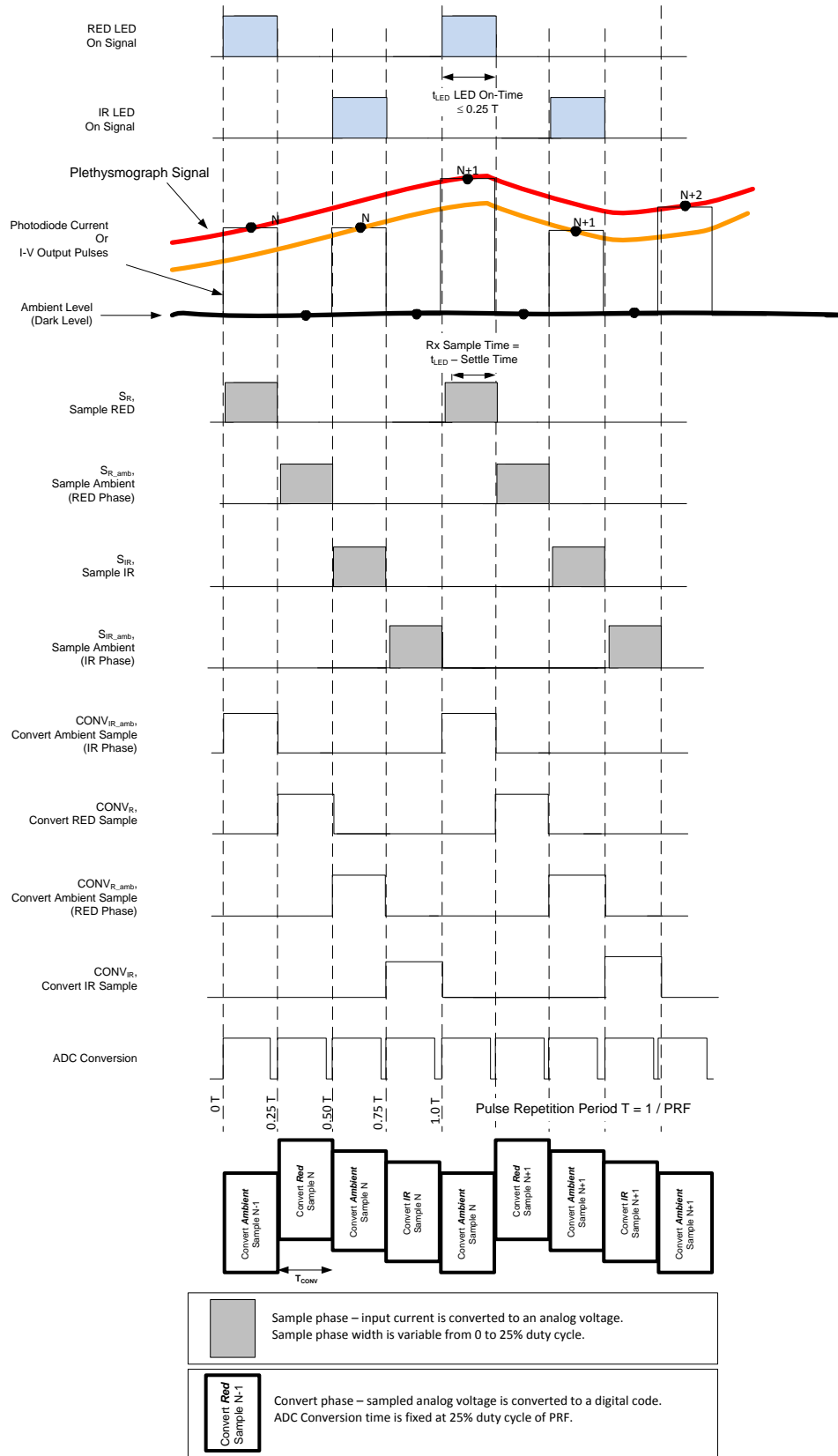
### 8.3.1.4 Receiver Timing

See [Figure 58](#) for a timing diagram detailing the control signals related to the LED on-time, Rx sample time, and the ADC conversion times for each channel.

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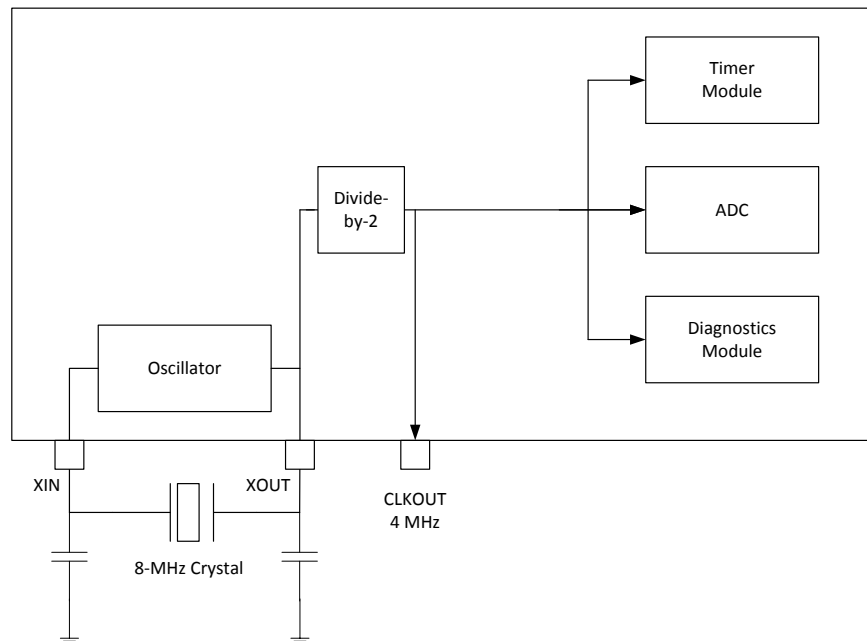


NOTE: Relationship to the AFE4490EVM is: LED1 = IR and LED2 = RED.

**Figure 58. Rx Timing Diagram**

### 8.3.2 Clocking and Timing Signal Generation

The crystal oscillator generates a master clock signal using an external 8-MHz crystal. A divide-by-2 block converts the 8-MHz clock to 4 MHz, which is used by the AFE to operate the timer modules, ADC, and diagnostics. The 4-MHz clock is buffered and output from the AFE in order to clock an external microcontroller. The clocking functionality is shown in [Figure 59](#).

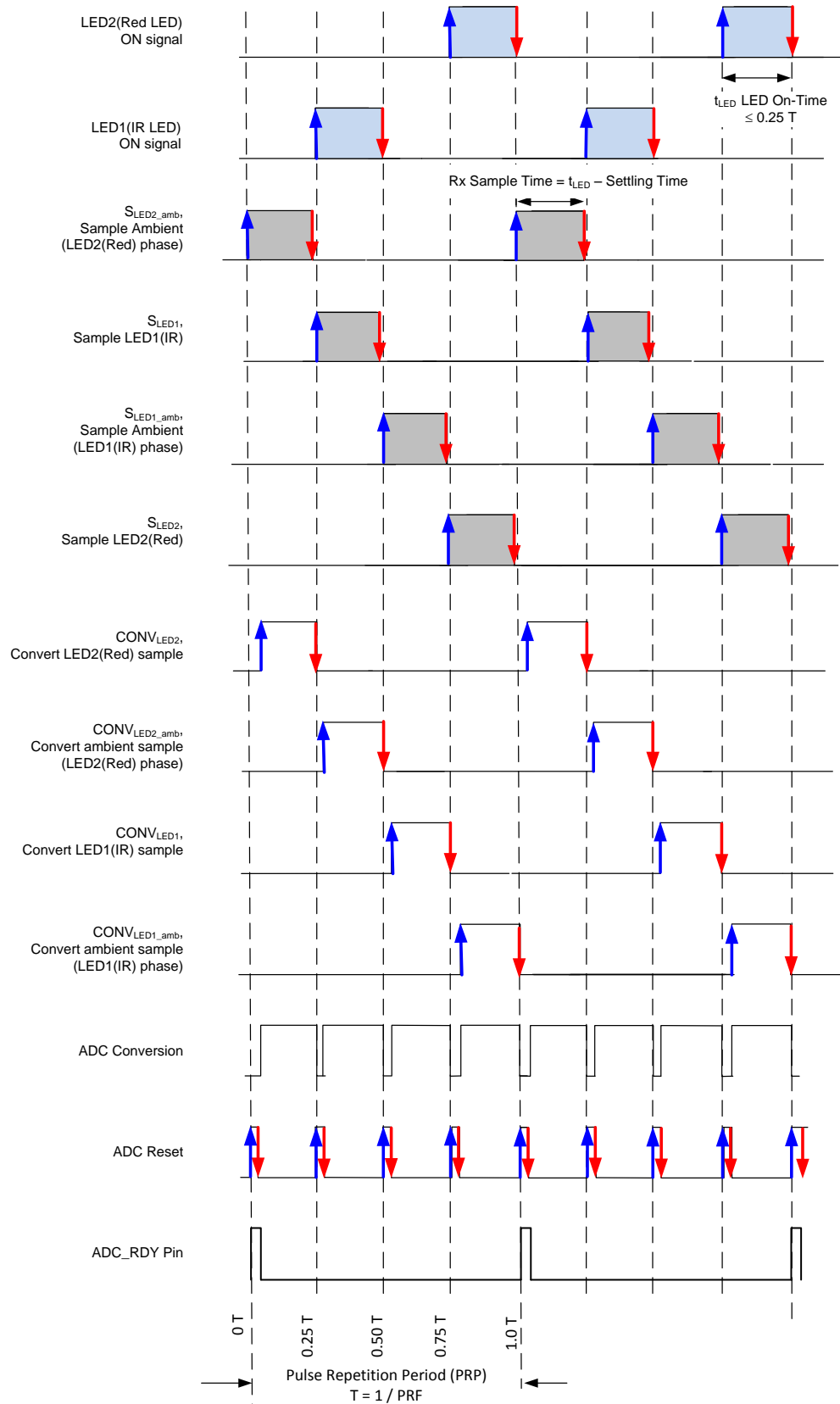


**Figure 59. AFE Clocking**

### 8.3.3 Timer Module

See [Figure 60](#) for a timing diagram detailing the various timing edges that are programmable using the timer module. The rising and falling edge positions of 11 signals can be controlled. The module uses a single 16-bit counter (running off of the 4-MHz clock) to set the time-base.

All timing signals are set with reference to the pulse repetition period (PRP). Therefore, a dedicated compare register compares the 16-bit counter value with the reference value specified in the PRF register. Every time that the 16-bit counter value is equal to the reference value in the PRF register, the counter is reset to '0'.

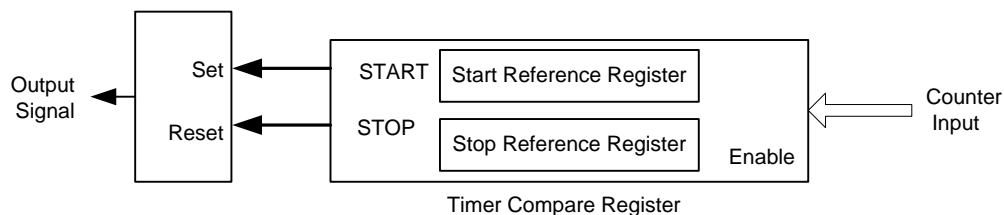


NOTE: Programmable edges are shown in blue and red.

**Figure 60. AFE Control Signals**

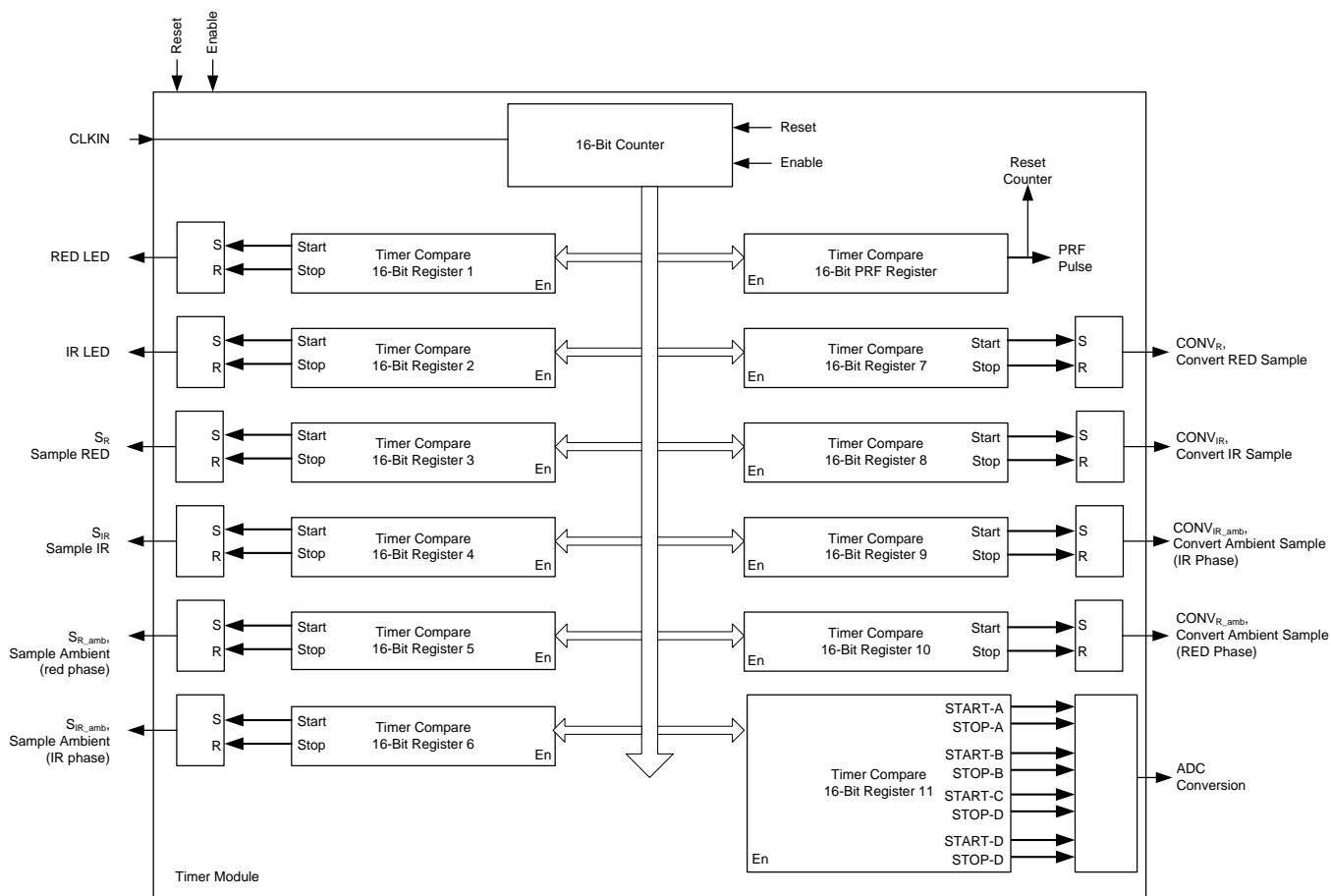
For the 11 signals in [Figure 58](#), the start and stop edge positions are programmable with respect to the PRF period. Each signal uses a separate timer compare module that compares the counter value with preprogrammed reference values for the start and stop edges. All reference values can be set using the SPI interface.

When the counter value equals the start reference value, the output signal is set. When the counter value equals the stop reference value, the output signal is reset. [Figure 61](#) shows a diagram of the timer compare register. With a 4-MHz clock, the edge placement resolution is 0.25  $\mu$ s. The ADC conversion signal requires four pulses in each PRF clock period. The 11th timer compare register uses four sets of start and stop registers to control the ADC conversion signal.



**Figure 61. Compare Register**

The ADC conversion signal requires four pulses in each PRF clock period. Timer compare register 11 uses four sets of start and stop registers to control the ADC conversion signal, as shown in [Figure 62](#).



**Figure 62. Timer Module**

### 8.3.3.1 Using the Timer Module

The timer module registers can be used to program the start and end instants in units of 4-MHz clock cycles. These timing instants and the corresponding registers are listed in [Table 2](#).

Note that the device does not restrict the values in these registers; thus, the start and end edges can be positioned anywhere within the pulse repetition period. Care must be taken by the user to program suitable values in these registers to avoid overlapping the signals and to make sure none of the edges exceed the value programmed in the PRP register. Writing the same value in the start and end registers results in a pulse duration of one clock cycle. The following steps describe the timer sequencing configuration:

1. With respect to the start of the PRP period (indicated by timing instant  $t_0$  in [Figure 63](#) and [Figure 64](#)), the sequence of conversions must be followed in order: convert LED2 → LED2 ambient → LED1 → LED1 ambient.
2. Also, starting from  $t_0$ , the sequence of sampling instants must be staggered with respect to the respective conversions as follows: sample LED2 ambient → LED1 → LED1 ambient → LED2.
3. Finally, align the edges for the two LED pulses with the respective sampling instants.

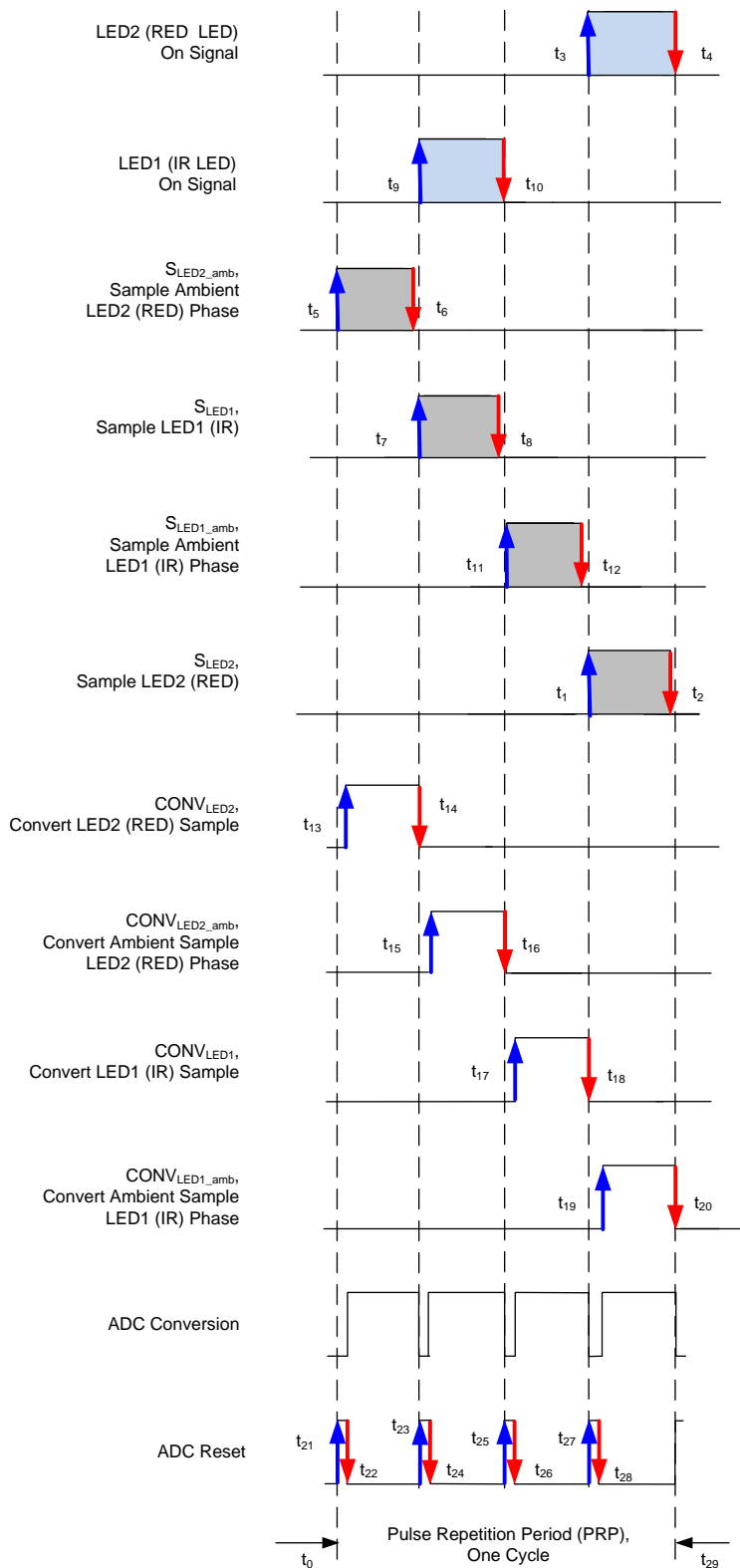
**Table 2. Clock Edge Mapping to SPI Registers**

| TIME INSTANT<br>(See <a href="#">Figure 63</a> and<br><a href="#">Figure 64</a> ) | DESCRIPTION   | CORRESPONDING REGISTER ADDRESS AND REGISTER BITS   | EXAMPLE <sup>(1)</sup><br>(Decimal) |
|---|---|--|-------------------------------------|
| $t_0$   | Start of pulse repetition period                        | No register control  | —                                   |
| $t_1$   | Start of sample LED2 pulse                              | Sample LED2 start count (bits 15-0 of register 01h)  | 6050                                |
| $t_2$   | End of sample LED2 pulse                                | Sample LED2 end count (bits 15-0 of register 02h)  | 7998                                |
| $t_3$   | Start of LED2 pulse                                     | LED2 start count (bits 15-0 of register 03h)   | 6000                                |
| $t_4$   | End of LED2 pulse                                       | LED2 end count (bits 15-0 of register 04h)   | 7999                                |
| $t_5$   | Start of sample LED2 ambient pulse                      | Sample ambient LED2 start count (bits 15-0 of register 05h)  | 50                                  |
| $t_6$   | End of sample LED2 ambient pulse                        | Sample ambient LED2 end count (bits 15-0 of register 06h)  | 1998                                |
| $t_7$   | Start of sample LED1 pulse                              | Sample LED1 start count (bits 15-0 of register 07h)  | 2050                                |
| $t_8$   | End of sample LED1 pulse                                | Sample LED1 end count (bits 15-0 of register 08h)  | 3998                                |
| $t_9$   | Start of LED1 pulse                                     | LED1 start count (bits 15-0 of register 09h)   | 2000                                |
| $t_{10}$  | End of LED1 pulse                                       | LED1 end count (bits 15-0 of register 0Ah)   | 3999                                |
| $t_{11}$  | Start of sample LED1 ambient pulse                      | Sample ambient LED1 start count (bits 15-0 of register 0Bh)  | 4050                                |
| $t_{12}$  | End of sample LED1 ambient pulse                        | Sample ambient LED1 end count (bits 15-0 of register 0Ch)  | 5998                                |
| $t_{13}$  | Start of convert LED2 pulse                             | LED2 convert start count (bits 15-0 of register 0Dh)<br>Must start one AFE clock cycle after the ADC reset pulse ends.         | 4                                   |
| $t_{14}$  | End of convert LED2 pulse                               | LED2 convert end count (bits 15-0 of register 0Eh)   | 1999                                |
| $t_{15}$  | Start of convert LED2 ambient pulse                     | LED2 ambient convert start count (bits 15-0 of register 0Fh)<br>Must start one AFE clock cycle after the ADC reset pulse ends. | 2004                                |
| $t_{16}$  | End of convert LED2 ambient pulse                       | LED2 ambient convert end count (bits 15-0 of register 10h)   | 3999                                |
| $t_{17}$  | Start of convert LED1 pulse                             | LED1 convert start count (bits 15-0 of register 11h)<br>Must start one AFE clock cycle after the ADC reset pulse ends.         | 4004                                |
| $t_{18}$  | End of convert LED1 pulse                               | LED1 convert end count (bits 15-0 of register 12h)   | 5999                                |
| $t_{19}$  | Start of convert LED1 ambient pulse                     | LED1 ambient convert start count (bits 15-0 of register 13h)<br>Must start one AFE clock cycle after the ADC reset pulse ends. | 6004                                |
| $t_{20}$  | End of convert LED1 ambient pulse                       | LED1 ambient convert end count (bits 15-0 of register 14h)   | 7999                                |
| $t_{21}$  | Start of first ADC conversion reset pulse               | ADC reset 0 start count (bits 15-0 of register 15h)  | 0                                   |
| $t_{22}$  | End of first ADC conversion reset pulse <sup>(2)</sup>  | ADC reset 0 end count (bits 15-0 of register 16h)  | 3                                   |
| $t_{23}$  | Start of second ADC conversion reset pulse              | ADC reset 1 start count (bits 15-0 of register 17h)  | 2000                                |
| $t_{24}$  | End of second ADC conversion reset pulse <sup>(2)</sup> | ADC reset 1 end count (bits 15-0 of register 18h)  | 2003                                |
| $t_{25}$  | Start of third ADC conversion reset pulse               | ADC reset 2 start count (bits 15-0 of register 19h)  | 4000                                |
| $t_{26}$  | End of third ADC conversion reset pulse <sup>(2)</sup>  | ADC reset 2 end count (bits 15-0 of register 1Ah)  | 4003                                |
| $t_{27}$  | Start of fourth ADC conversion reset pulse              | ADC reset 3 start count (bits 15-0 of register 1Bh)  | 6000                                |
| $t_{28}$  | End of fourth ADC conversion reset pulse <sup>(2)</sup> | ADC reset 3 end count (bits 15-0 of register 1Ch)  | 6003                                |
| $t_{29}$  | End of pulse repetition period                          | Pulse repetition period count (bits 15-0 of register 1Dh)  | 7999                                |

(1) Values are based off of a pulse repetition frequency (PRF) = 500 Hz and duty cycle = 25%.

(2) See [Figure 64](#), note 2 for the affect of the ADC reset time crosstalk.

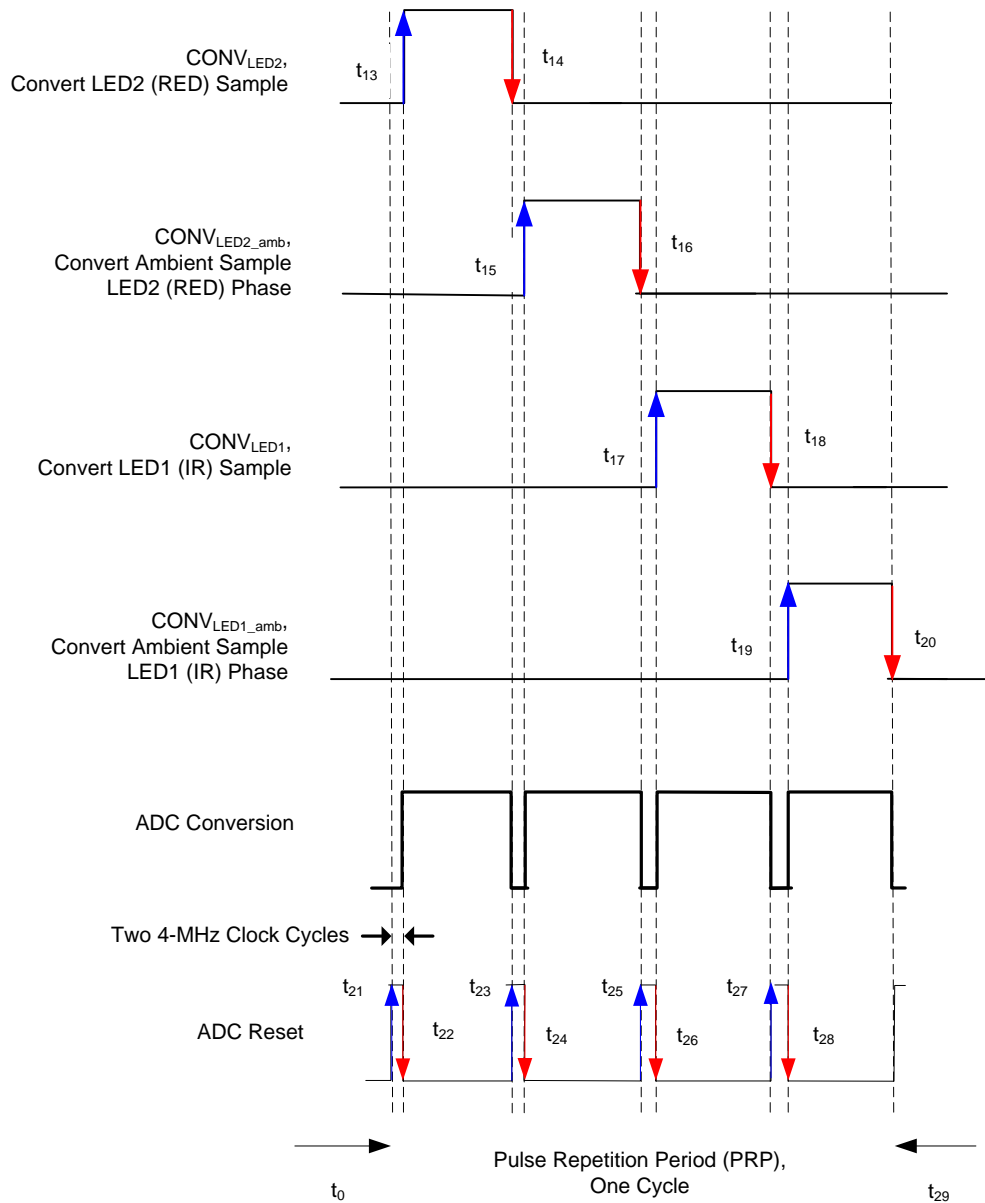




(1) RED = LED2, IR = LED1.

(2) A low ADC reset time can result in a small component of the LED signal leaking into the ambient phase. With an ADC reset of two clock cycles, a –60-dB leakage is expected. In many cases, this leakage does not affect system performance. However, if this crosstalk must be completely eliminated, a longer ADC reset time of approximately six clock cycles is recommended for  $t_{22}$ ,  $t_{24}$ ,  $t_{26}$ , and  $t_{28}$ .

**Figure 63. Programmable Clock Edges<sup>(1)(2)</sup>**



(1) RED = LED2, IR = LED1.

(2) A low ADC reset time can result in a small component of the LED signal leaking into the ambient phase. With an ADC reset of two clock cycles, a –60-dB leakage is expected. In many cases, this leakage does not affect system performance. However, if this crosstalk must be completely eliminated, a longer ADC reset time of approximately six clock cycles is recommended for  $t_{22}$ ,  $t_{24}$ ,  $t_{26}$ , and  $t_{28}$ .

**Figure 64. Relationship Between the ADC Reset and ADC Conversion Signals<sup>(1)(2)</sup>**

### 8.3.4 Receiver Subsystem Power Path

The block diagram in Figure 65 shows the device Rx subsystem power routing.

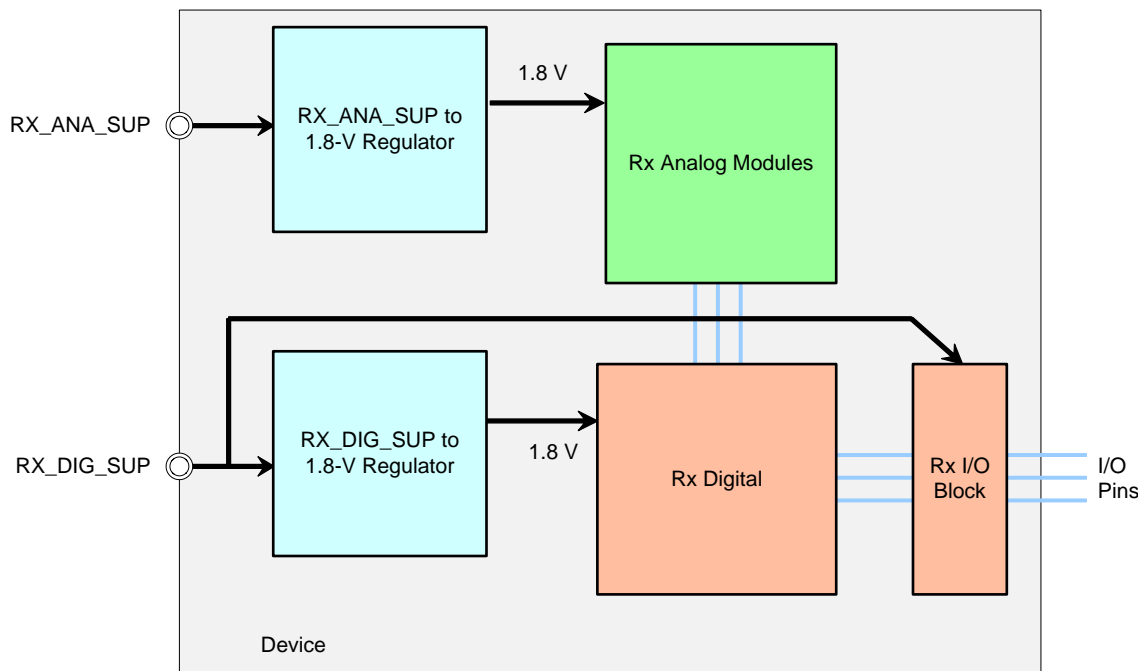


Figure 65. Receive Subsystem Power Routing

### 8.3.5 Transmit Section

The transmit section integrates the LED driver and the LED current control section with 8-bit resolution. This integration is designed to meet a dynamic range of better than 105 dB (based on a 1-sigma LED current noise).

The RED and IR LED reference currents can be independently set. The current source ( $I_{LED}$ ) locally regulates and ensures that the actual LED current tracks the specified reference. The transmitter section uses a reference voltage for operation. This reference voltage is available on the REF\_TX pin and must be decoupled to ground with a 2.2-μF capacitor. The TX\_REF voltage is derived from the TX\_CTRL\_SUP. The maximum LED current setting depends on the transmitter reference voltage. By default, after reset, this voltage is 0.75 V and supports up to a 150-mA LED current. For higher LED currents up to 200 mA, the reference can be programmed to 1.0 V (using the LED\_RANGE[1:0] register bits).

The minimum LED\_DRV\_SUP voltage required for operation depends on the:

- Voltage drop across the LED ( $V_{LED}$ ),
- Voltage drop across the external cable, connector, and any other component in series with the LED ( $V_{CABLE}$ ), and
- Transmitter reference voltage.

Using the default reference voltage of 0.75 V, the minimum LED\_DRV\_SUP voltage can be as low as 3.25 V, provided that Equation 3 is met. Refer to the [Recommended Operating Conditions](#) table.

$$3.25 \text{ V} - (V_{LED} + V_{CABLE}) > 1.4 \text{ V} \quad (3)$$

To lower the minimum LED\_DRV\_SUP voltage even further, the transmitter reference voltage can be programmed to 0.5 V. By doing so, the minimum LED\_DRV\_SUP voltage can be reduced to 3.0 V, provided that Equation 4 is met. Refer to the [Recommended Operating Conditions](#) table.

$$3.0 \text{ V} - (V_{LED} + V_{CABLE}) > 1.4 \text{ V} \quad (4)$$

Note that with the 0.5-V transmitter reference voltage, the maximum LED current supported is 100 mA.

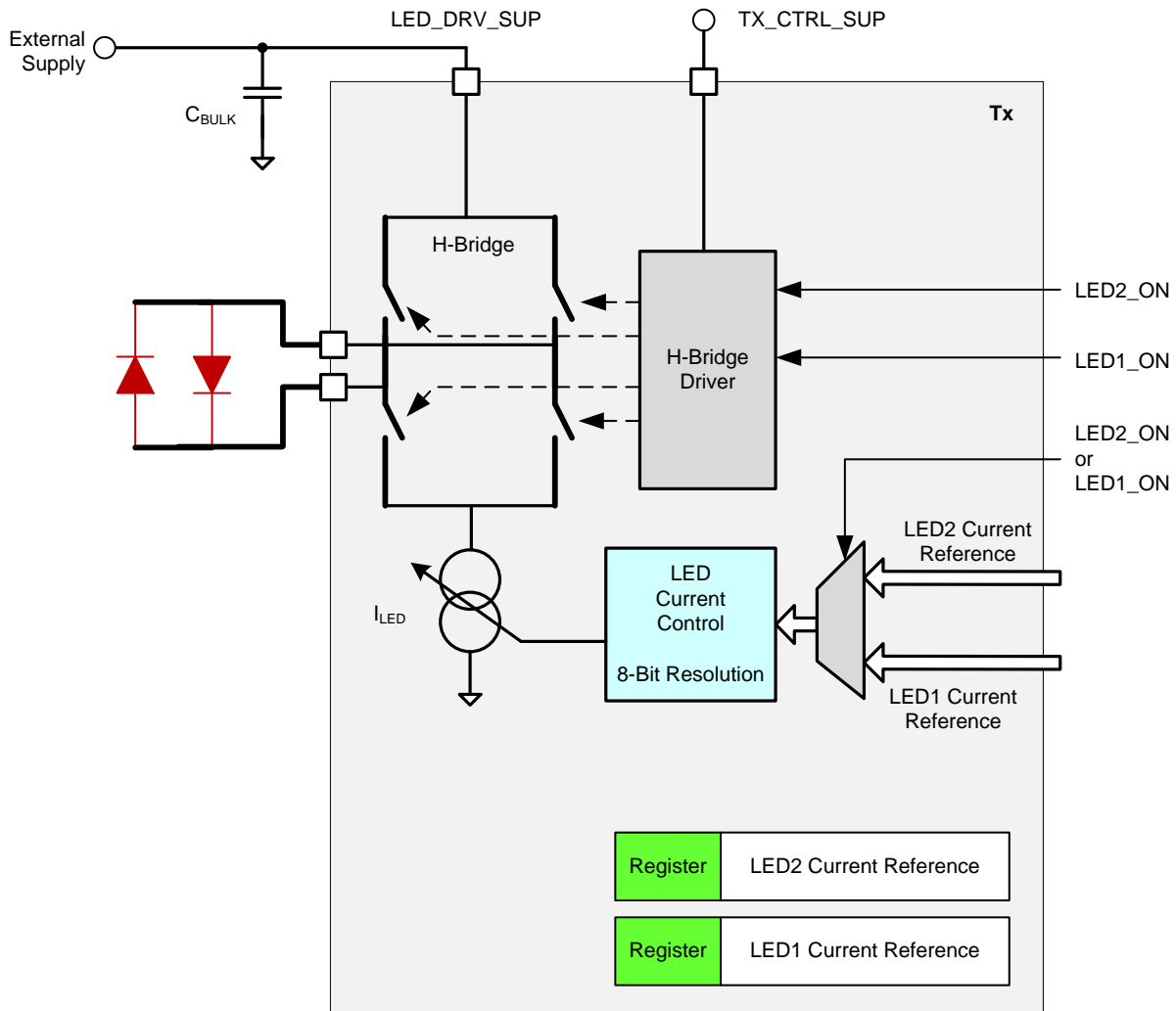
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Two LED driver schemes are supported:

- An H-bridge drive for a two-pin, back-to-back LED package, as shown in [Figure 66](#).
- A push-pull drive for a three-pin, common-anode LED package; see [Figure 67](#).



**Figure 66. Transmit: H-Bridge Drive**

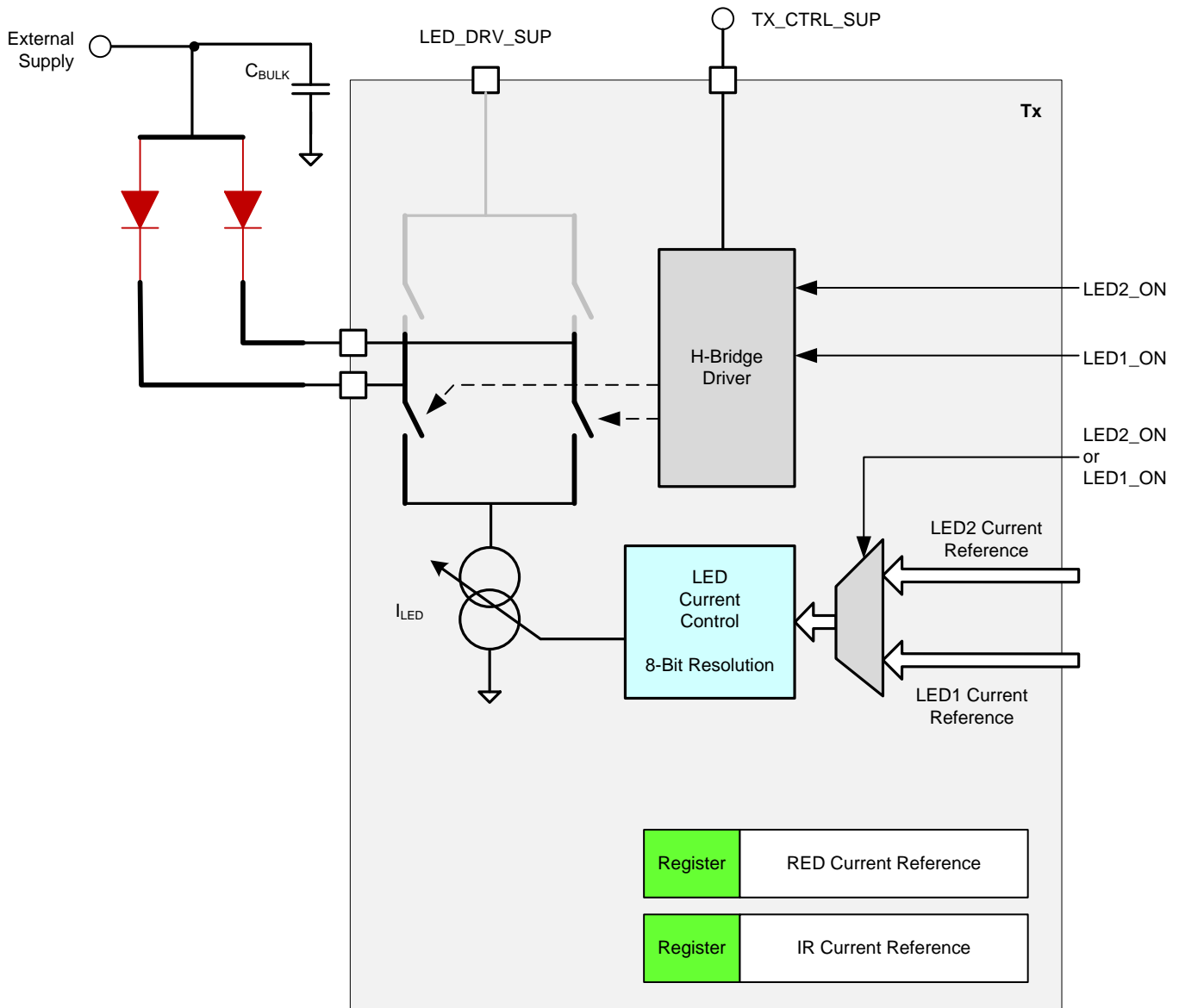
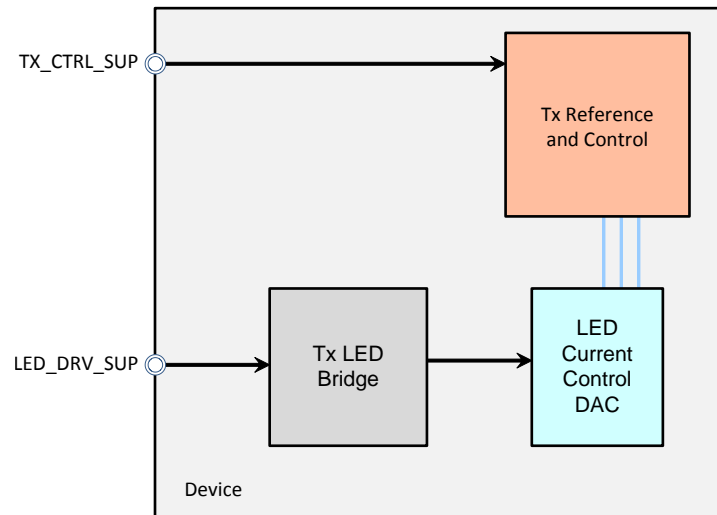


Figure 67. Transmit: Push-Pull LED Drive for Common Anode LED Configuration

### 8.3.5.1 Transmitter Power Path

The block diagram in [Figure 68](#) shows the device Tx subsystem power routing.

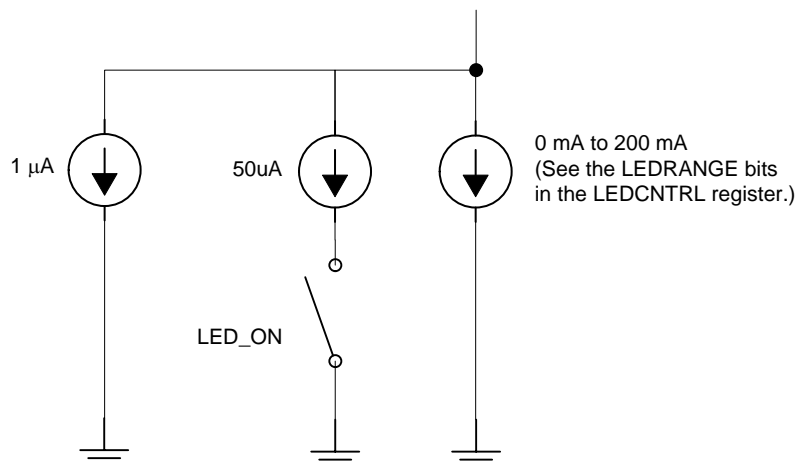


**Figure 68. Transmit Subsystem Power Routing**

### 8.3.5.2 LED Power Reduction During Periods of Inactivity

The diagram in [Figure 69](#) shows how LED bias current passes 50  $\mu$ A whenever LED\_ON occurs. In order to minimize power consumption in periods of inactivity, the LED\_ON control must be turned off. Furthermore, disable the TIMEREN bit in the CONTROL1 register by setting the value to '0'.

Note that depending on the LEDs used, the LED may sometimes appear dimly lit even when the LED current is set to 0 mA. This appearance is because of the switching leakage currents (as shown in [Figure 69](#)) inherent to the timer function. The dimmed appearance does not effect the ambient light level measurement because during the ambient cycle, LED\_ON is turned off for the duration of the ambient measurement.



**Figure 69. LED Bias Current**

## 8.4 Device Functional Modes

### 8.4.1 ADC Operation and Averaging Module

After the falling edge of the ADC reset signal, the ADC conversion phase starts (refer to [Figure 64](#)). Each ADC conversion takes 50  $\mu$ s.

There are two modes of operation: without averaging and with averaging. The averaging mode can average multiple ADC samples and reduce noise to improve dynamic range because the ADC conversion time is usually shorter than 25% of the pulse repetition period. [Figure 70](#) shows a diagram of the averaging module. The ADC output format is in 22-bit two's complement. The two MSB bits of the 24-bit data can be ignored.

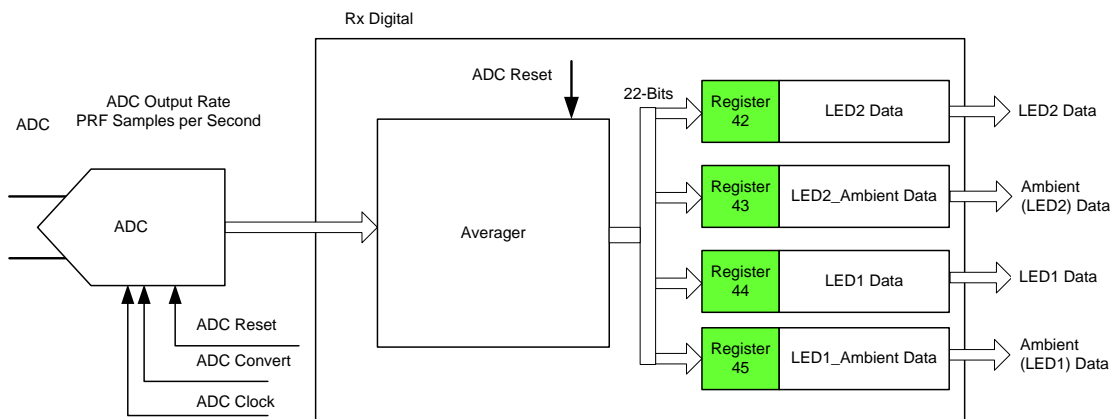


Figure 70. Averaging Module

#### 8.4.1.1 Operation Without Averaging

In this mode, the ADC outputs a digital sample one time for every 50  $\mu$ s. At the next rising edge of the ADC reset signal, the first 22-bit conversion value is written into the result registers sequentially as follows (see [Figure 71](#)):

- At the 25% reset signal, the first 22-bit ADC sample is written to register 2Ah.
- At the 50% reset signal, the first 22-bit ADC sample is written to register 2Bh.
- At the 75% reset signal, the first 22-bit ADC sample is written to register 2Ch.
- At the next 0% reset signal, the first 22-bit ADC sample is written to register 2Dh. The contents of registers 2Ah and 2Bh are written to register 2Eh and the contents of registers 2Ch and 2Dh are written to register 2Fh.

At the rising edge of the ADC\_RDY signal, the contents of all six result registers can be read out.

#### 8.4.1.2 Operation With Averaging

In this mode, all ADC digital samples are accumulated and averaged after every 50  $\mu$ s. At the next rising edge of the ADC reset signal, the average value (22-bit) is written into the output registers sequentially as follows (see [Figure 72](#)):

- At the 25% reset signal, the averaged 22-bit word is written to register 2Ah.
- At the 50% reset signal, the averaged 22-bit word is written to register 2Bh.
- At the 75% reset signal, the averaged 22-bit word is written to register 2Ch.
- At the next 0% reset signal, the averaged 22-bit word is written to register 2Dh. The contents of registers 2Ah and 2Bh are written to register 2Eh and the contents of registers 2Ch and 2Dh are written to register 2Fh.

At the rising edge of the ADC\_RDY signal, the contents of all six result registers can be read out.

## Device Functional Modes (continued)

The number of samples to be used per conversion phase is specified in the CONTROL1 register (NUMAV[7:0]). The user must specify the correct value for the number of averages, as described in [Equation 5](#):

$$\text{NUMAV}[7:0] + 1 = \left\lceil \frac{0.25 \times \text{Pulse Repetition Period}}{50 \mu\text{s}} \right\rceil - 1 \quad (5)$$

When the number of averages is '0', the averaging is disabled and only one ADC sample is written to the result registers.

Note that the number of average conversions is limited by 25% of the PRF. For example, eight samples can be averaged with PRF = 625 Hz, and four samples can be averaged with PRF = 1250 Hz.



## Device Functional Modes (continued)

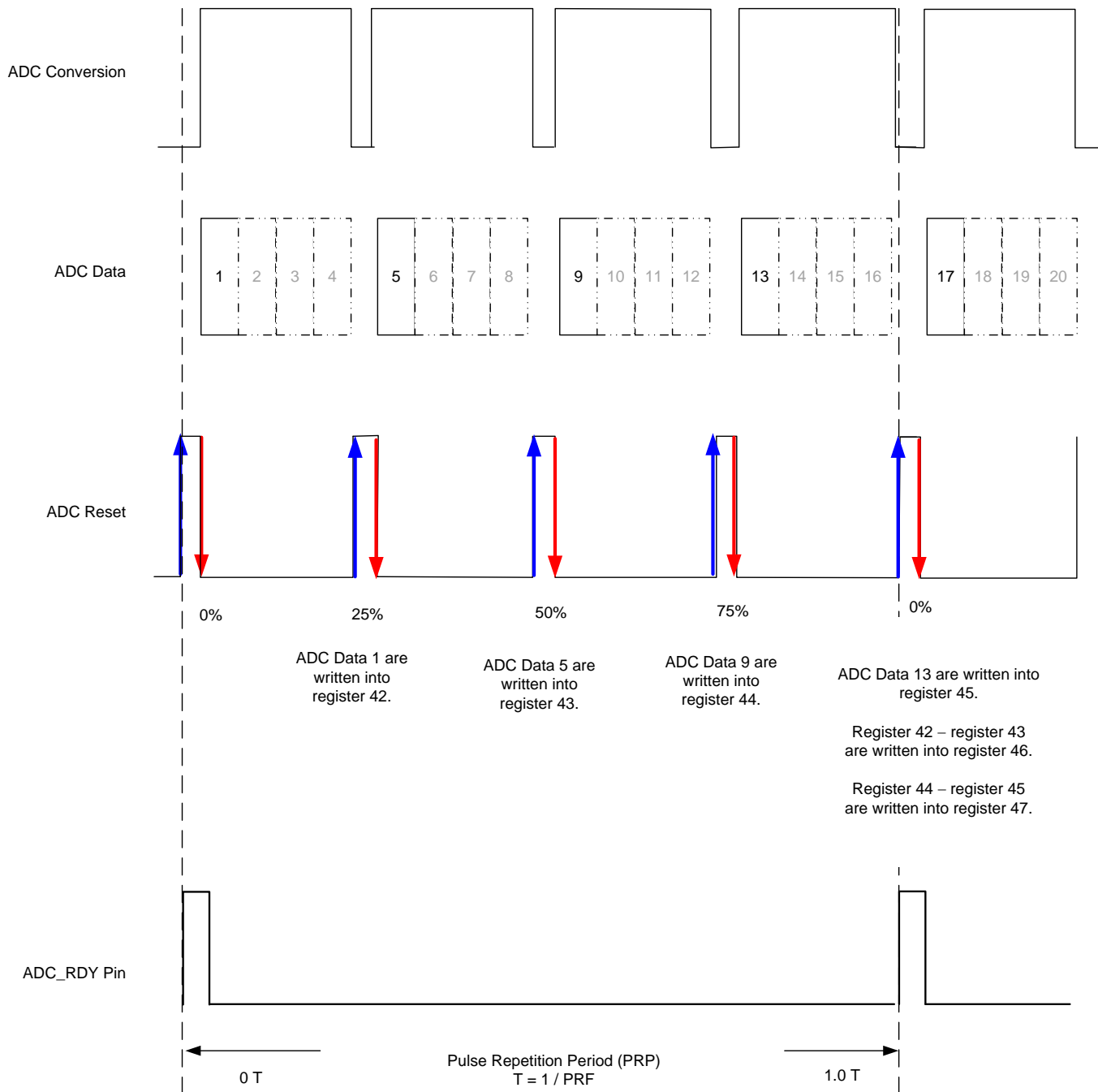
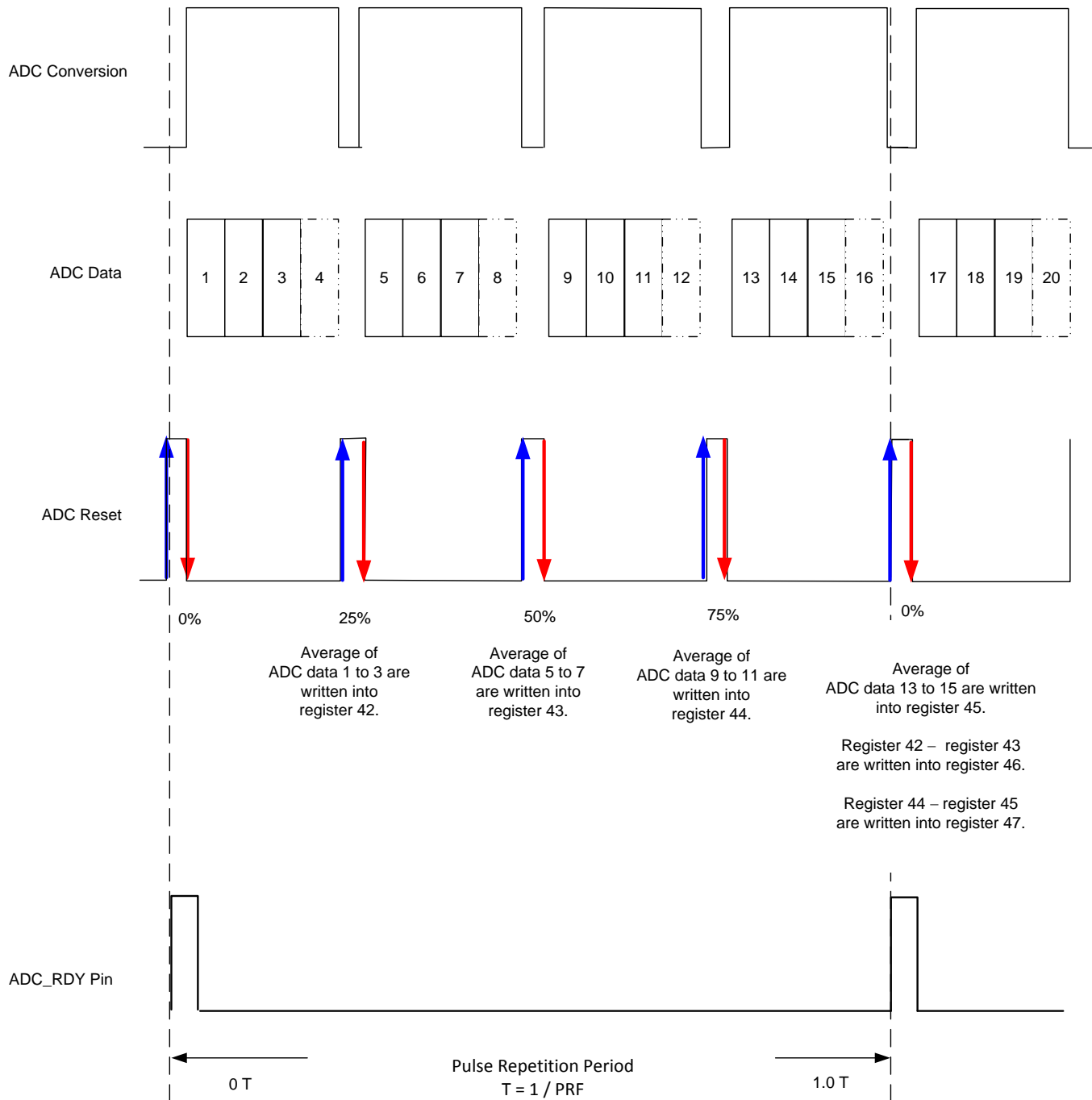


Figure 71. ADC Data without Averaging (when Number of Averages = 0)

**Device Functional Modes (continued)**


NOTE: Example is with three averages. The value of the NUMAVG[7:0] register bits = 2.

**Figure 72. ADC Data with Averaging Enabled**

## Device Functional Modes (continued)

### 8.4.2 AFE Analog Output Mode (ADC Bypass Mode)

This mode is only intended for use in system debug. Note that this function is not recommended for production use because of the minimal device production testing performed on this function.

The ADC bypass mode brings out the analog output voltage of the receiver front-end on two pins (RXOUTP, RXOUTN), around a common-mode voltage of approximately 0.9 V. In this mode, the internal ADC of the AFE4490 is disabled. [Figure 73](#) shows a block diagram of this mode.

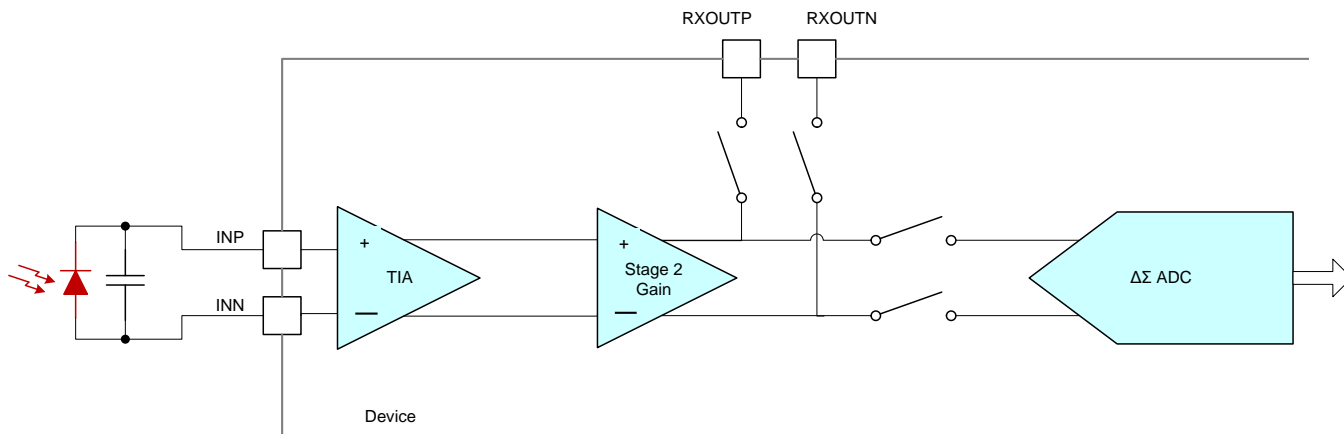


Figure 73. Device Set to ADC Bypass Mode

In ADC bypass mode, one of the internal clocks (ADC\_Reset) can be brought out on the PD\_ALM pin, as shown in [Figure 74](#). This signal can be used to convert each of the four phases (within every pulse repetition period). Additionally, the ADC\_RDY signal can be used to synchronize the external ADC with the AFE. See [Figure 75](#) for the timing of this mode.

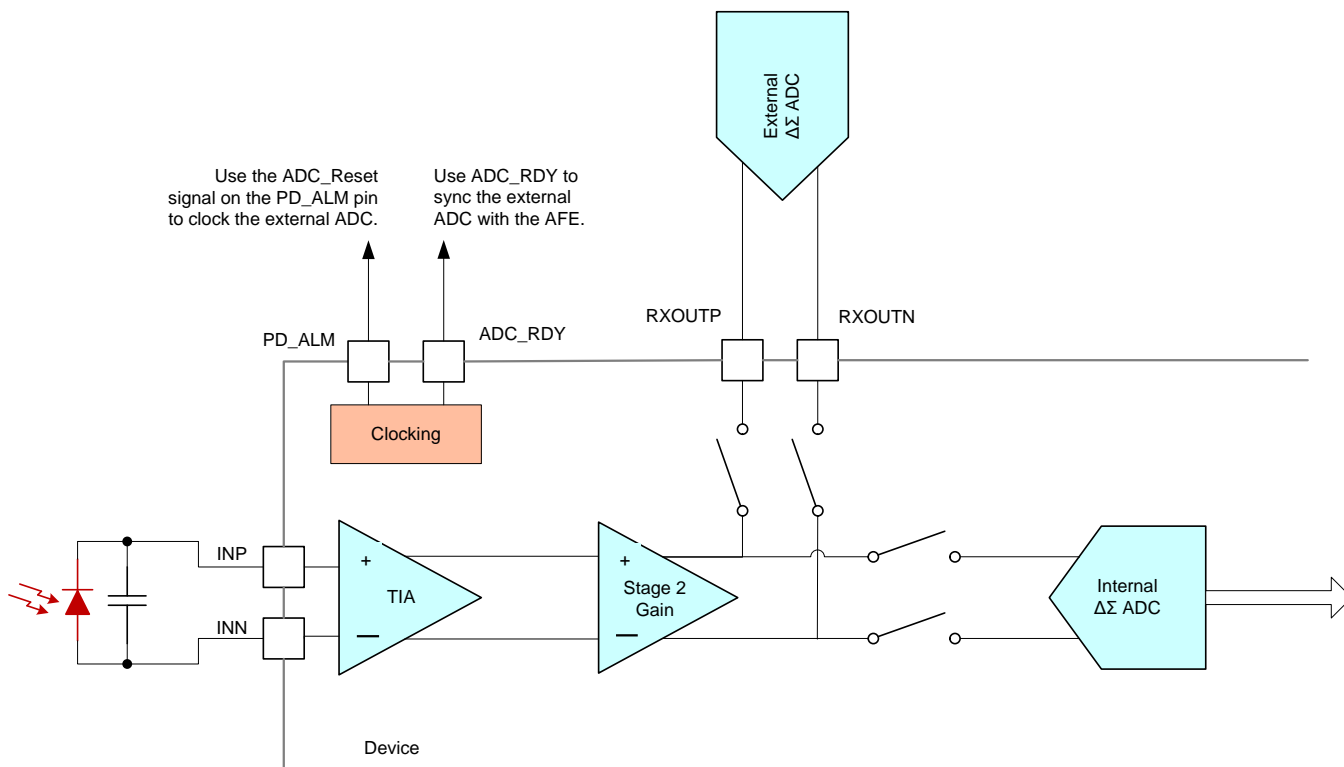
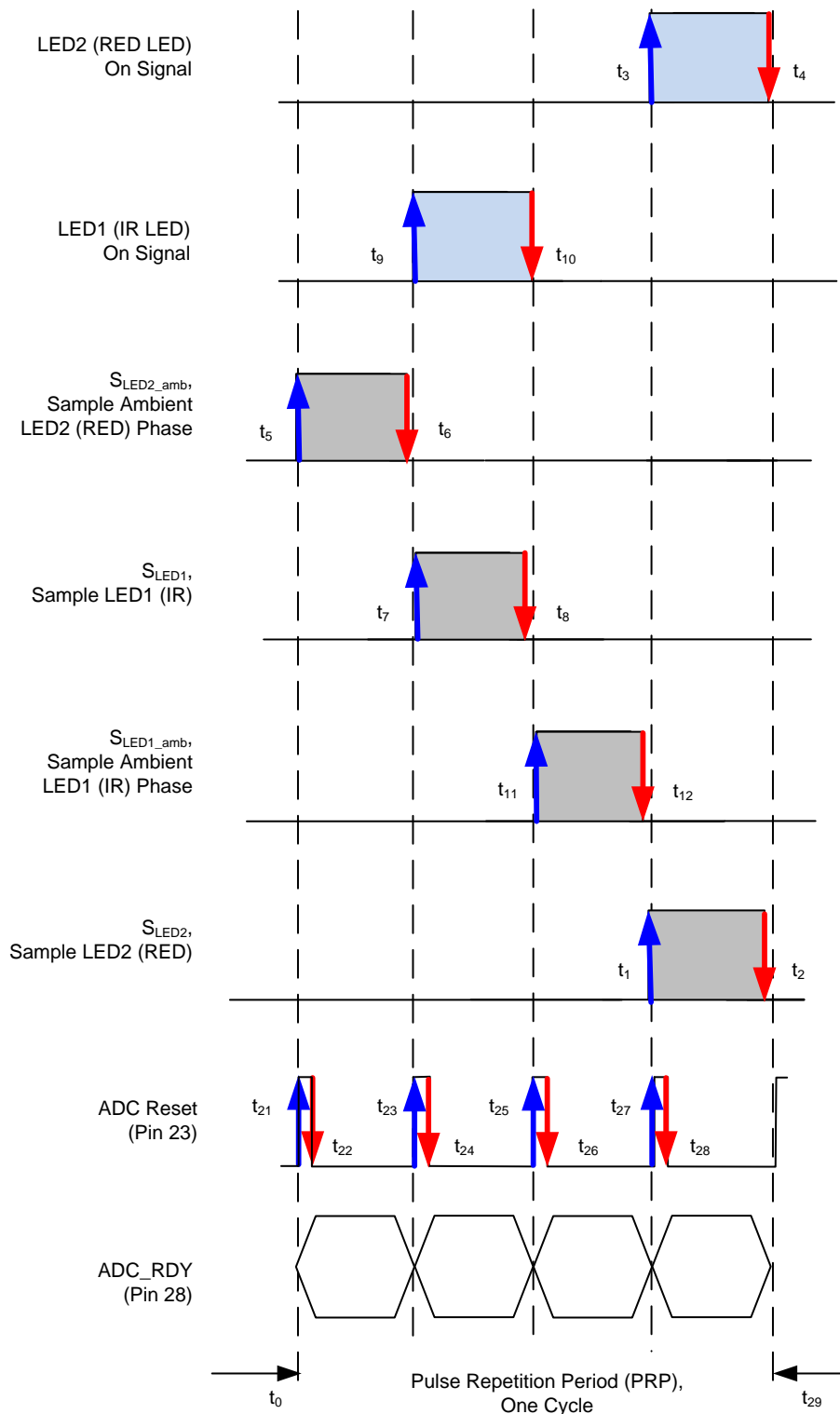


Figure 74. Device in ADC Bypass Mode with ADC\_Reset to PD\_ALM Pin

**Device Functional Modes (continued)**


NOTE: RED = LED2, IR = LED1.

**Figure 75. Device Analog Output Mode (ADC Bypass) Timing Diagram**

## Device Functional Modes (continued)

In ADC bypass mode, the ADC reset signal can be used to start conversions with the external ADC. Use registers 15h through 1Ch to position the ADC reset signal edges appropriately. Also, use the CLKALMPIN[2:0] bits on the PD\_ALM pin register bit to bring out the ADC reset signal to the PD\_ALM pin. ADC\_RDY can be used to indicate the start of the pulse repetition period to the external ADC.

### 8.4.3 Diagnostics

The device includes diagnostics to detect open or short conditions of the LED and photosensor, LED current profile feedback, and cable on or off detection.

#### 8.4.3.1 Photodiode-Side Fault Detection

Figure 76 shows the diagnostic for the photodiode-side fault detection.

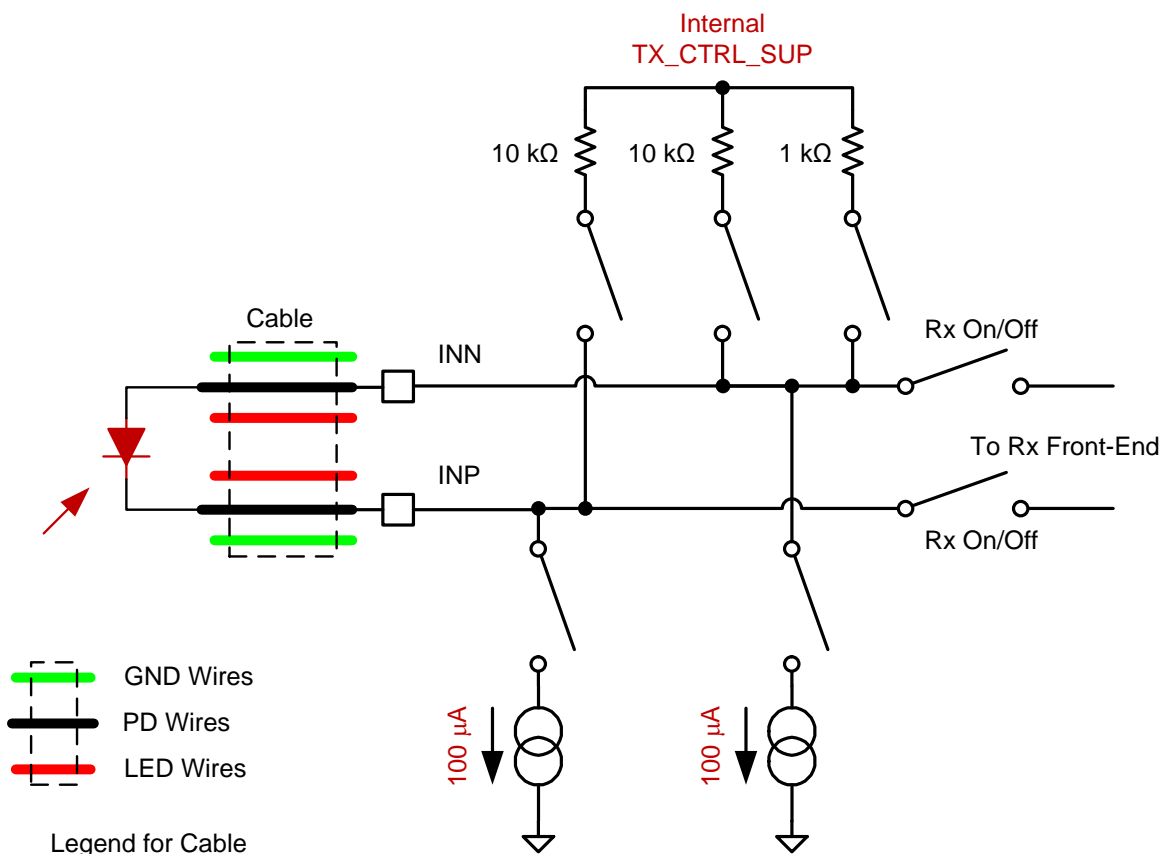


Figure 76. Photodiode Diagnostic

Figure 77 shows the diagnostic for the transmitter-side fault detection.



## Device Functional Modes (continued)

### 8.4.3.3 Diagnostics Module

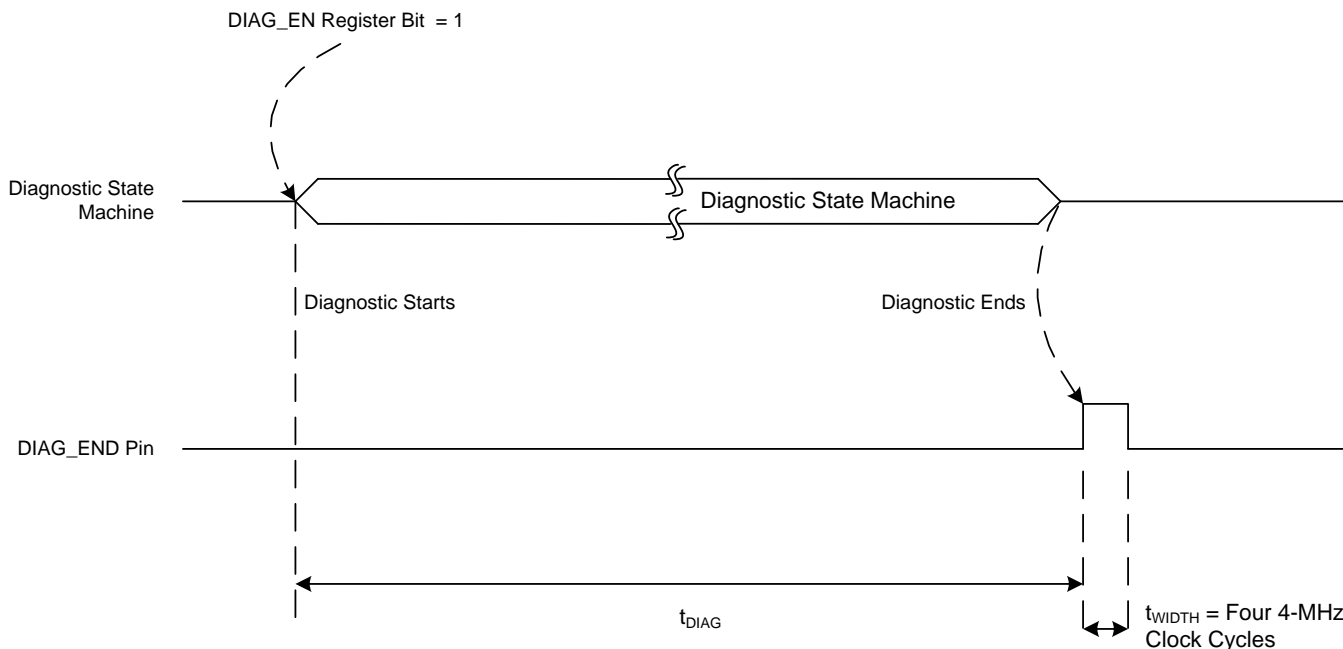
The diagnostics module, when enabled, checks for nine types of faults sequentially. The results of all faults are latched in 11 separate flags. At the end of the sequence, the state of the 11 flags are combined to generate two interrupt signals: PD\_ALM for photodiode-related faults and LED\_ALM for transmit-related faults. The status of all flags can also be read using the SPI interface. [Table 3](#) details each fault and flag used. Note that the diagnostics module requires all AFE blocks to be enabled in order to function reliably.

**Table 3. Fault and Flag Diagnostics<sup>(1)</sup>**

| MODULE | SEQ. | FAULT                             | FLAG1 | FLAG2 | FLAG3 | FLAG4 | FLAG5 | FLAG6 | FLAG7 | FLAG8 | FLAG9 | FLAG10 | FLAG11 |
|--------|------|-----------------------------------|-------|-------|-------|-------|-------|-------|-------|-------|-------|--------|--------|
| —      | —    | No fault                          | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0      | 0      |
| PD     | 1    | Rx INP cable shorted to LED cable | 1     |       |       |       |       |       |       |       |       |        |        |
|        | 2    | Rx INN cable shorted to LED cable |       | 1     |       |       |       |       |       |       |       |        |        |
|        | 3    | Rx INP cable shorted to GND cable |       |       | 1     |       |       |       |       |       |       |        |        |
|        | 4    | Rx INN cable shorted to GND cable |       |       |       | 1     |       |       |       |       |       |        |        |
|        | 5    | PD open or shorted                |       |       |       |       | 1     | 1     |       |       |       |        |        |
| LED    | 6    | Tx OUTM line shorted to GND cable |       |       |       |       |       |       | 1     |       |       |        |        |
|        | 7    | Tx OUTP line shorted to GND cable |       |       |       |       |       |       |       | 1     |       |        |        |
|        | 8    | LED open or shorted               |       |       |       |       |       |       |       |       | 1     | 1      |        |
|        | 9    | LED open or shorted               |       |       |       |       |       |       |       |       |       |        | 1      |

(1) Resistances below 10 kΩ are considered to be shorted.

[Figure 78](#) shows the timing for the diagnostic function.



**Figure 78. Diagnostic Timing Diagram**

By default, the diagnostic function takes  $t_{\text{DIAG}} = 8$  ms to complete after the DIAG\_EN register bit is enabled. By setting the EN\_SLOW\_DIAG register bit (CONTROL2 register, bit D8) the diagnostic time can be increased to 16 ms.

After completion of the diagnostics function, time must be allowed for the device filter to settle. See the [Electrical Characteristics](#) for the filter settling time. The slow diagnostics feature is provided for use in systems where high-capacitance sensors (such as photodiodes, capacitors, cables, and so forth) are connected to the INP, INN, TXP, or TXN pins.

## 8.5 Programming

### 8.5.1 Serial Programming Interface

The SPI-compatible serial interface consists of four signals: SCLK (serial clock), SPISOMI (serial interface data output), SPISIMO (serial interface data input), and SPISTE (serial interface enable).

The serial clock (SCLK) is the serial peripheral interface (SPI) serial clock. SCLK shifts in commands and shifts out data from the device. SCLK features a Schmitt-triggered input and clocks data out on SPISOMI. Data are clocked in on the SPISIMO pin. Even though the input has hysteresis, TI recommends keeping SCLK as clean as possible to prevent glitches from accidentally shifting the data. When the serial interface is idle, hold SCLK low.

The SPISOMI (SPI serial out master in) pin is used with SCLK to clock out device data. The SPISIMO (SPI serial in master out) pin is used with SCLK to clock in data to the device. The SPISTE (SPI serial interface enable) pin enables the serial interface to clock data on the SPISIMO pin in to the device.

### 8.5.2 Reading and Writing Data

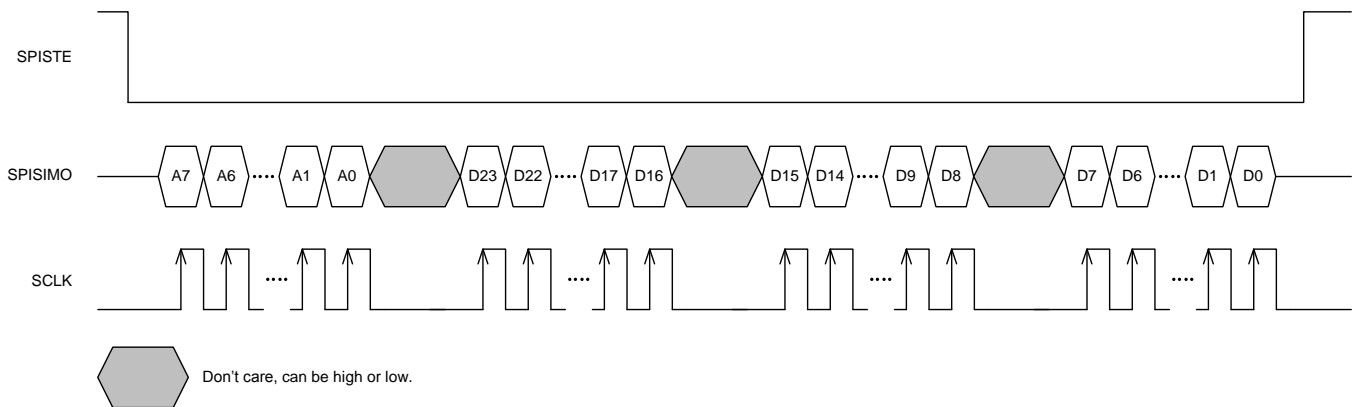
The device has a set of internal registers that can be accessed by the serial programming interface formed by the SPISTE, SCLK, SPISIMO, and SPISOMI pins.

#### 8.5.2.1 Writing Data

The SPI\_READ register bit must be first set to '0' before writing to a register. When SPISTE is low,

- Serially shifting bits into the device is enabled.
- Serial data (on the SPISIMO pin) are latched at every SCLK rising edge.
- The serial data are loaded into the register at every 32nd SCLK rising edge.

In case the word length exceeds a multiple of 32 bits, the excess bits are ignored. Data can be loaded in multiples of 32-bit words within a single active SPISTE pulse. The first eight bits form the register address and the remaining 24 bits form the register data. [Figure 79](#) shows an SPI timing diagram for a single write operation. For multiple read and write cycles, refer to the [Multiple Data Reads and Writes](#) section.



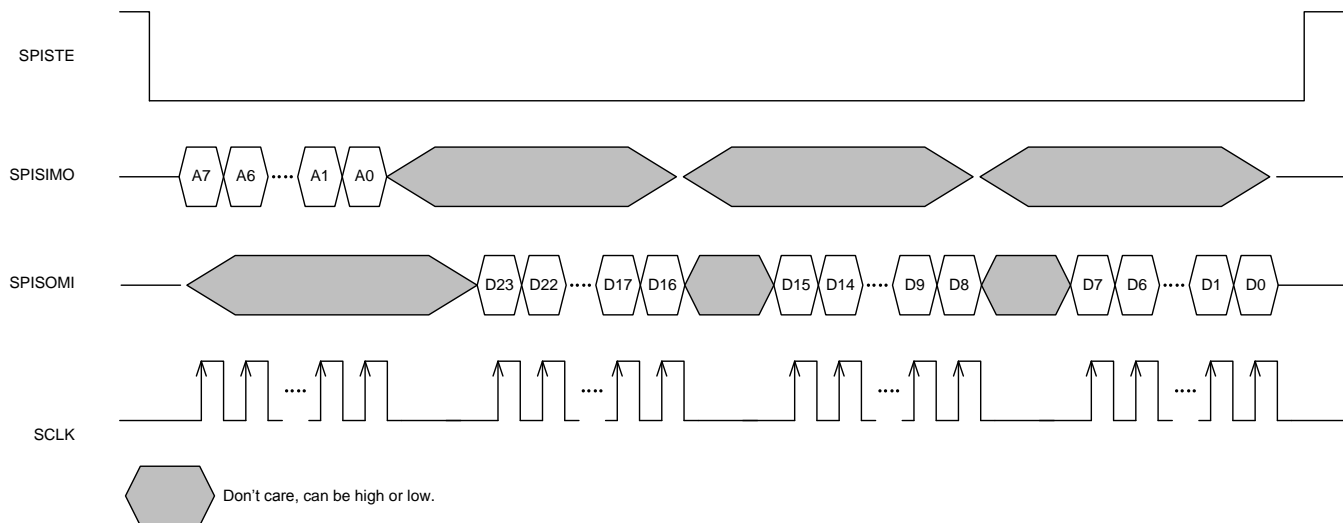
**Figure 79. AFE SPI Write Timing Diagram**



## Programming (continued)

### 8.5.2.2 Reading Data

The SPI\_READ register bit must be first set to '1' before reading from a register. The device includes a mode where the contents of the internal registers can be read back on the SPISOMI pin. This mode may be useful as a diagnostic check to verify the serial interface communication between the external controller and the AFE. To enable this mode, first set the SPI\_READ register bit using the SPI write command, as described in the [Writing Data](#) section. In the next command, specify the SPI register address with the desired content to be read. Within the same SPI command sequence, the AFE outputs the contents of the specified register on the SPISOMI pin. [Figure 80](#) shows an SPI timing diagram for a single read operation. For multiple read and write cycles, refer to the [Multiple Data Reads and Writes](#) section.

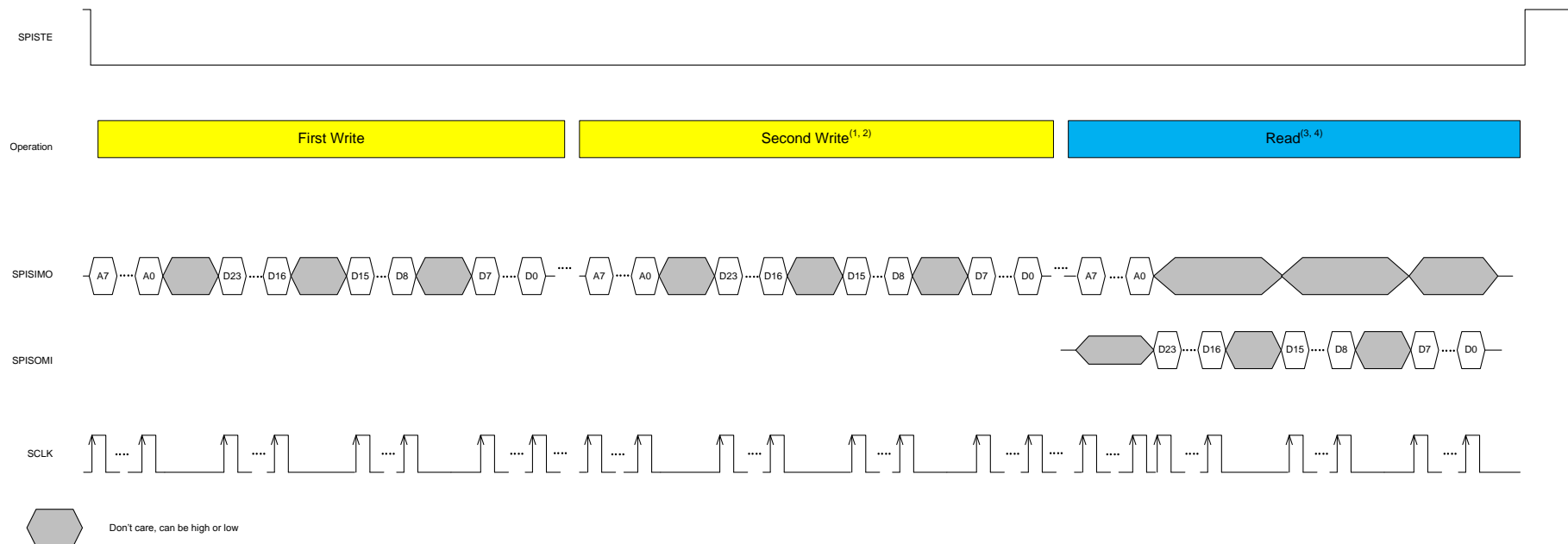


- (1) The SPI\_READ register bit must be enabled before attempting a serial readout from the AFE.
- (2) Specify the register address of the content that must be readback on bits A[7:0].
- (3) The AFE outputs the contents of the specified register on the SPISOMI pin.

**Figure 80. AFE SPI Read Timing Diagram<sup>(1)(2)(3)</sup>**

### 8.5.2.3 Multiple Data Reads and Writes

The device includes functionality where multiple read and write operations can be performed during a single SPISTE event. To enable this functionality, the first eight bits determine the register address to be written and the remaining 24 bits determine the register data. Perform two writes with the SPI read bit enabled during the second write operation in order to prepare for the read operation, as described in the [Writing Data](#) section. In the next command, specify the SPI register address with the desired content to be read. Within the same SPI command sequence, the AFE outputs the contents of the specified register on the SPISOMI pin. This functionality is described in the [Writing Data](#) and [Reading Data](#) sections. [Figure 81](#) shows a timing diagram for the SPI multiple read and write operations.



- (1) The SPI read register bit must be enabled before attempting a serial readout from the AFE.
- (2) The second write operation must be configured for register 0 with data 000001h.
- (3) Specify the register address whose contents must be read back on A[7:0].
- (4) The AFE outputs the contents of the specified register on the SOMI pin.

**Figure 81. Serial Multiple Read and Write Operations**

#### **8.5.2.4 Register Initialization**

After power-up, the internal registers must be initialized to the default values. This initialization can be done in one of two ways:

- Through a hardware reset by applying a low-going pulse on the  $\overline{\text{RESET}}$  pin, or
- By applying a software reset. Using the serial interface, set SW\_RESET (bit D3 in register 00h) high. This setting initializes the internal registers to the default values and then self-resets to '0'. In this case, the  $\overline{\text{RESET}}$  pin is kept high (inactive).

#### **8.5.2.5 AFE SPI Interface Design Considerations**

Note that when the device is deselected, the SPISOMI, CLKOUT, ADC\_RDY, PD\_ALM, LED\_ALM, and DIAG\_END digital output pins do not enter a 3-state mode. This condition, therefore, must be taken into account when connecting multiple devices to the SPI port and for power-management considerations. In order to avoid loading the SPI bus when multiple devices are connected, the DIGOUT\_TRISTATE register bit must be to '1' whenever the AFE SPI is inactive.

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## 8.6 Register Maps

The AFE consists of a set of registers that can be used to configure it, such as receiver timings, I-V amplifier settings, transmit LED currents, and so forth. The registers and their contents are listed in [Table 4](#). These registers can be accessed using the AFE SPI interface.

**Table 4. AFE Register Map**

| NAME         | REGISTER CONTROL <sup>(1)</sup> | ADDRESS |     | REGISTER DATA |     |     |     |     |     |     |     |                    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
|--------------|---------------------------------|---------|-----|---------------|-----|-----|-----|-----|-----|-----|-----|--------------------|-----|-----|-----|-----|-----|----|----|----|----|----|----|----|----|----|----|---|---|---|--|--|--|--|--|--|--|
|              |                                 | Hex     | Dec | D23           | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15                | D14 | D13 | D12 | D11 | D10 | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |   |   |   |  |  |  |  |  |  |  |
| CONTROL0     | W                               | 00      | 0   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0                  | 0   | 0   | 0   | 0   | 0   | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0 | 0 | 0 |  |  |  |  |  |  |  |
| LED2STC      | R/W                             | 01      | 1   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED2STC[15:0]      |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED2ENDC     | R/W                             | 02      | 2   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED2ENDC[15:0]     |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED2LEDSTC   | R/W                             | 03      | 3   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED2LEDSTC[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED2LEDENDC  | R/W                             | 04      | 4   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED2LEDENDC[15:0]  |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED2STC     | R/W                             | 05      | 5   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED2STC[15:0]     |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED2ENDC    | R/W                             | 06      | 6   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED2ENDC[15:0]    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED1STC      | R/W                             | 07      | 7   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED1STC[15:0]      |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED1ENDC     | R/W                             | 08      | 8   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED1ENDC[15:0]     |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED1LEDSTC   | R/W                             | 09      | 9   | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED1LEDSTC[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED1LEDENDC  | R/W                             | 0A      | 10  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED1LEDENDC[15:0]  |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED1STC     | R/W                             | 0B      | 11  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED1STC[15:0]     |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED1ENDC    | R/W                             | 0C      | 12  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED1ENDC[15:0]    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED2CONVST   | R/W                             | 0D      | 13  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED2CONVST[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED2CONVEND  | R/W                             | 0E      | 14  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED2CONVEND[15:0]  |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED2CONVST  | R/W                             | 0F      | 15  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED2CONVST[15:0]  |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED2CONVEND | R/W                             | 10      | 16  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED2CONVEND[15:0] |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED1CONVST   | R/W                             | 11      | 17  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED1CONVST[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| LED1CONVEND  | R/W                             | 12      | 18  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | LED1CONVEND[15:0]  |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED1CONVST  | R/W                             | 13      | 19  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED1CONVST[15:0]  |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ALED1CONVEND | R/W                             | 14      | 20  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ALED1CONVEND[15:0] |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTSTCT0  | R/W                             | 15      | 21  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRSTCT0[15:0]    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTENDCT0 | R/W                             | 16      | 22  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRENDCT0[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTSTCT1  | R/W                             | 17      | 23  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRSTCT1[15:0]    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTENDCT1 | R/W                             | 18      | 24  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRENDCT1[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTSTCT2  | R/W                             | 19      | 25  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRSTCT2[15:0]    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTENDCT2 | R/W                             | 1A      | 26  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRENDCT2[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTSTCT3  | R/W                             | 1B      | 27  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRSTCT3[15:0]    |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |
| ADCRSTENDCT3 | R/W                             | 1C      | 28  | 0             | 0   | 0   | 0   | 0   | 0   | 0   | 0   | ADCRENDCT3[15:0]   |     |     |     |     |     |    |    |    |    |    |    |    |    |    |    |   |   |   |  |  |  |  |  |  |  |

(1) R = read only, R/W = read or write, N/A = not available, and W = write only.

## Register Maps (continued)

**Table 4. AFE Register Map (continued)**

| NAME         | REGISTER CONTROL <sup>(1)</sup> | ADDRESS |     | REGISTER DATA |     |     |     |             |         |                |                   |             |           |           |           |                |                |                 |            |                |    |    |              |    |              |       |       |              |  |
|--------------|---------------------------------|---------|-----|---------------|-----|-----|-----|-------------|---------|----------------|-------------------|-------------|-----------|-----------|-----------|----------------|----------------|-----------------|------------|----------------|----|----|--------------|----|--------------|-------|-------|--------------|--|
|              |                                 | Hex     | Dec | D23           | D22 | D21 | D20 | D19         | D18     | D17            | D16               | D15         | D14       | D13       | D12       | D11            | D10            | D9              | D8         | D7             | D6 | D5 | D4           | D3 | D2           | D1    | D0    |              |  |
| PRPCOUNT     | R/W                             | 1D      | 29  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | PRPCT[15:0] |           |           |           |                |                |                 |            |                |    |    |              |    |              |       |       |              |  |
| CONTROL1     | R/W                             | 1E      | 30  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | 0           | 0         | 0         | 0         | CLKALMPIN[2:0] |                |                 | TIMEREN    | NUMAV[7:0]     |    |    |              |    |              |       |       |              |  |
| SPARE1       | N/A                             | 1F      | 31  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | 0           | 0         | 0         | 0         | 0              | 0              | 0               |            | 0              | 0  | 0  | 0            | 0  | 0            | 0     | 0     |              |  |
| TIAGAIN      | R/W                             | 20      | 32  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | ENSEPGAN    | STAGE2EN1 | 0         | 0         | 0              | STG2GAIN1[2:0] |                 |            | CF_LED1[4:0]   |    |    |              |    | RF_LED1[2:0] |       |       |              |  |
| TIA_AMB_GAIN | R/W                             | 21      | 33  | 0             | 0   | 0   | 0   | AMBDAC[3:0] |         |                |                   |             |           | FLTRCNSEL | STAGE2EN2 | 0              | 0              | 0               |            | STG2GAIN2[2:0] |    |    | CF_LED2[4:0] |    |              |       |       | RF_LED2[2:0] |  |
| LEDCNTRL     | R/W                             | 22      | 34  | 0             | 0   | 0   | 0   | 0           | 0       | LED RANGE[1:0] |                   | LED1[7:0]   |           |           |           |                |                |                 |            | LED2[7:0]      |    |    |              |    |              |       |       |              |  |
| CONTROL2     | R/W                             | 23      | 35  | 0             | 0   | 0   | 0   | 0           | TX_REF1 | TX_REF0        | RST_CLK_ON_PD_ALM | EN_ADC_BYP  | 0         | 0         |           | 0              | TXBRGMOD       | DIGOUT_TRISTATE | XTALDIS    | EN_SLOW_DIAG   | 0  | 0  | 0            | 0  | 0            | PDNTX | PDNRX | PDNAFE       |  |
| SPARE2       | N/A                             | 24      | 36  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | 0           | 0         | 0         | 0         | 0              | 0              | 0               | 0          | 0              | 0  | 0  | 0            | 0  | 0            | 0     |       |              |  |
| SPARE3       | N/A                             | 25      | 37  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | 0           | 0         | 0         | 0         | 0              | 0              | 0               | 0          | 0              | 0  | 0  | 0            | 0  | 0            | 0     |       |              |  |
| SPARE4       | N/A                             | 26      | 38  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | 0           | 0         | 0         | 0         | 0              | 0              | 0               | 0          | 0              | 0  | 0  | 0            | 0  | 0            | 0     |       |              |  |
| RESERVED1    | N/A                             | 27      | 39  | X             | X   | X   | X   | X           | X       | X              | X                 | X           | X         | X         | X         | X              | X              | X               | X          | X              | X  | X  | X            | X  | X            | X     |       |              |  |
| RESERVED2    | N/A                             | 28      | 40  | X             | X   | X   | X   | X           | X       | X              | X                 | X           | X         | X         | X         | X              | X              | X               | X          | X              | X  | X  | X            | X  | X            | X     |       |              |  |
| ALARM        | R/W                             | 29      | 41  | 0             | 0   | 0   | 0   | 0           | 0       | 0              | 0                 | 0           | 0         | 0         | 0         | 0              | 0              | 0               | ALMPINLKEN | 0              | 0  | 0  | 0            | 0  | 0            | 0     |       |              |  |

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**Register Maps (continued)**
**Table 4. AFE Register Map (continued)**

| NAME          | REGISTER CONTROL <sup>(1)</sup> | ADDRESS |     | REGISTER DATA       |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
|---------------|---------------------------------|---------|-----|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|--------|---------|----------|----------|-------|----------|----------|------|------|----------|----------|----------|----------|--|--|--|--|
|               |                                 | Hex     | Dec | D23                 | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12    | D11     | D10      | D9       | D8    | D7       | D6       | D5   | D4   | D3       | D2       | D1       | D0       |  |  |  |  |
| LED2VAL       | R                               | 2A      | 42  | LED2VAL[23:0]       |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
| ALED2VAL      | R                               | 2B      | 43  | ALED2VAL[23:0]      |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
| LED1VAL       | R                               | 2C      | 44  | LED1VAL[23:0]       |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
| ALED1VAL      | R                               | 2D      | 45  | ALED1VAL[23:0]      |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
| LED2-ALED2VAL | R                               | 2E      | 46  | LED2-ALED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
| LED1-ALED1VAL | R                               | 2F      | 47  | LED1-ALED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
| DIAG          | R                               | 30      | 48  | 0                   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | 0   | PD_ALM | LED_ALM | LED1OPEN | LED2OPEN | LEDSC | OUTPSHGN | OUTNSHGN | PDOC | PDSC | INNSCGND | INPSCGND | INNSCLED | INPSCLED |  |  |  |  |
|               |                                 |         |     |                     |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
|               |                                 |         |     |                     |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
|               |                                 |         |     |                     |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
|               |                                 |         |     |                     |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
|               |                                 |         |     |                     |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |
|               |                                 |         |     |                     |     |     |     |     |     |     |     |     |     |     |        |         |          |          |       |          |          |      |      |          |          |          |          |  |  |  |  |

## 8.6.1 AFE Register Description

**Figure 82. CONTROL0: Control Register 0 (Address = 00h, Reset Value = 0000h)**

| D23  | D22  | D21  | D20  | D19  | D18  | D17  | D16  | D15    | D14     | D13           | D12      |
|------|------|------|------|------|------|------|------|--------|---------|---------------|----------|
| 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0      | 0       | 0             | 0        |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h   | W-0h    | W-0h          | W-0h     |
| D11  | D10  | D9   | D8   | D7   | D6   | D5   | D4   | D3     | D2      | D1            | D0       |
| 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | SW_RST | DIAG_EN | TIM_COUNT_RST | SPI_READ |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h   | W-0h    | W-0h          | W-0h     |

LEGEND: W = Write only; -n = value after reset

This register is write-only. CONTROL0 is used for AFE software and count timer reset, diagnostics enable, and SPI read functions.

**Bits D[23:4] Must be '0'**

**Bit D3 SW\_RST: Software reset**

0 = No action (default after reset)

1 = Software reset applied; resets all internal registers to the default values and self-clears to '0'

**Bit D2 DIAG\_EN: Diagnostic enable**

0 = No Action (default after reset)

1 = Diagnostic mode is enabled and the diagnostics sequence starts when this bit is set.

At the end of the sequence, all fault statuses are stored in the [DIAG: Diagnostics Flag Register](#). Afterwards, the DIAG\_EN register bit self-clears to '0'.

Note that the diagnostics enable bit is automatically reset after the diagnostics completes (slow =16 ms, fast = 8 ms). During diagnostics mode, the ADC data are invalid because of toggling diagnostics switches.

**Bit D1 TIM\_CNT\_RST: Timer counter reset**

0 = Disables timer counter reset, required for normal timer operation (default after reset)

1 = Timer counters are in reset state

**Bit D0 SPI\_READ: SPI read**

0 = SPI read is disabled (default after reset)

1 = SPI read is enabled

**Figure 83. LED2STC: Sample LED2 Start Count Register (Address = 01h, Reset Value = 0000h)**

| D23           | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15           | D14 | D13 | D12 |
|---------------|--------|--------|--------|--------|--------|--------|--------|---------------|-----|-----|-----|
| 0             | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED2STC[15:0] |     |     |     |
| R/W-0h        | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h        |     |     |     |
| D11           | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3            | D2  | D1  | D0  |
| LED2STC[15:0] |        |        |        |        |        |        |        |               |     |     |     |
| R/W-0h        |        |        |        |        |        |        |        |               |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the LED2 signal sample.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED2STC[15:0]: Sample LED2 start count**

The contents of this register can be used to position the start of the sample LED2 signal with respect to the pulse repetition period (PRP), as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 84. LED2ENDC: Sample LED2 End Count Register (Address = 02h, Reset Value = 0000h)**

| D23            | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15            | D14 | D13 | D12 |
|----------------|--------|--------|--------|--------|--------|--------|--------|----------------|-----|-----|-----|
| 0              | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED2ENDC[15:0] |     |     |     |
| R/W-0h         | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h         |     |     |     |
| D11            | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3             | D2  | D1  | D0  |
| LED2ENDC[15:0] |        |        |        |        |        |        |        |                |     |     |     |
| R/W-0h         |        |        |        |        |        |        |        |                |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the LED2 signal sample.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED2ENDC[15:0]: Sample LED2 end count**

The contents of this register can be used to position the end of the sample LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 85. LED2LEDSTC: LED2 LED Start Count Register (Address = 03h, Reset Value = 0000h)**

| D23              | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15              | D14 | D13 | D12 |
|------------------|--------|--------|--------|--------|--------|--------|--------|------------------|-----|-----|-----|
| 0                | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED2LEDSTC[15:0] |     |     |     |
| R/W-0h           | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h           |     |     |     |
| D11              | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3               | D2  | D1  | D0  |
| LED2LEDSTC[15:0] |        |        |        |        |        |        |        |                  |     |     |     |
| R/W-0h           |        |        |        |        |        |        |        |                  |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for when the LED2 signal turns on.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED2LEDSTC[15:0]: LED2 start count**

The contents of this register can be used to position the start of the LED2 with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.



**Figure 86. LED2LEDENDC: LED2 LED End Count Register (Address = 04h, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED2LEDENDC[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| LED2LEDENDC[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for when the LED2 signal turns off.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED2LEDENDC[15:0]: LED2 end count**

The contents of this register can be used to position the end of the LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 87. ALED2STC: Sample Ambient LED2 Start Count Register (Address = 05h, Reset Value = 0000h)**

| D23            | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15            | D14 | D13 | D12 |
|----------------|--------|--------|--------|--------|--------|--------|--------|----------------|-----|-----|-----|
| 0              | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED2STC[15:0] |     |     |     |
| R/W-0h         | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h         |     |     |     |
| D11            | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3             | D2  | D1  | D0  |
| ALED2STC[15:0] |        |        |        |        |        |        |        |                |     |     |     |
| R/W-0h         |        |        |        |        |        |        |        |                |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the ambient LED2 signal sample.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED2STC[15:0]: Sample ambient LED2 start count**

The contents of this register can be used to position the start of the sample ambient LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 88. ALED2ENDC: Sample Ambient LED2 End Count Register  
(Address = 06h, Reset Value = 0000h)**

| D23             | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15             | D14 | D13 | D12 |
|-----------------|--------|--------|--------|--------|--------|--------|--------|-----------------|-----|-----|-----|
| 0               | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED2ENDC[15:0] |     |     |     |
| R/W-0h          | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h          |     |     |     |
| D11             | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3              | D2  | D1  | D0  |
| ALED2ENDC[15:0] |        |        |        |        |        |        |        |                 |     |     |     |
| R/W-0h          |        |        |        |        |        |        |        |                 |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the ambient LED2 signal sample.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED2ENDC[15:0]: Sample ambient LED2 end count**

The contents of this register can be used to position the end of the sample ambient LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 89. LED1STC: Sample LED1 Start Count Register (Address = 07h, Reset Value = 0000h)**

| D23           | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15           | D14 | D13 | D12 |
|---------------|--------|--------|--------|--------|--------|--------|--------|---------------|-----|-----|-----|
| 0             | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED1STC[15:0] |     |     |     |
| R/W-0h        | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h        |     |     |     |
| D11           | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3            | D2  | D1  | D0  |
| LED1STC[15:0] |        |        |        |        |        |        |        |               |     |     |     |
| R/W-0h        |        |        |        |        |        |        |        |               |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the LED1 signal sample.

**Bits D[23:17] Must be '0'**

**Bits D[16:0] LED1STC[15:0]: Sample LED1 start count**

The contents of this register can be used to position the start of the sample LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 90. LED1ENDC: Sample LED1 End Count (Address = 08h, Reset Value = 0000h)**

| D23            | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15            | D14 | D13 | D12 |
|----------------|--------|--------|--------|--------|--------|--------|--------|----------------|-----|-----|-----|
| 0              | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED1ENDC[15:0] |     |     |     |
| R/W-0h         | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h         |     |     |     |
| D11            | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3             | D2  | D1  | D0  |
| LED1ENDC[15:0] |        |        |        |        |        |        |        |                |     |     |     |
| R/W-0h         |        |        |        |        |        |        |        |                |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the LED1 signal sample.

**Bits D[23:17] Must be '0'**

**Bits D[16:0] LED1ENDC[15:0]: Sample LED1 end count**

The contents of this register can be used to position the end of the sample LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 91. LED1LEDSTC: LED1 LED Start Count Register (Address = 09h, Reset Value = 0000h)**

| D23              | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15              | D14 | D13 | D12 |
|------------------|--------|--------|--------|--------|--------|--------|--------|------------------|-----|-----|-----|
| 0                | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED1LEDSTC[15:0] |     |     |     |
| R/W-0h           | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h           |     |     |     |
| D11              | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3               | D2  | D1  | D0  |
| LED1LEDSTC[15:0] |        |        |        |        |        |        |        |                  |     |     |     |
| R/W-0h           |        |        |        |        |        |        |        |                  |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for when the LED1 signal turns on.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED1LEDSTC[15:0]: LED1 start count**

The contents of this register can be used to position the start of the LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 92. LED1LEDENDC: LED1 LED End Count Register (Address = 0Ah, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED1LEDENDC[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| LED1LEDENDC[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for when the LED1 signal turns off.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED1LEDENDC[15:0]: LED1 end count**

The contents of this register can be used to position the end of the LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 93. ALED1STC: Sample Ambient LED1 Start Count Register (Address = 0Bh, Reset Value = 0000h)**

| D23            | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15            | D14 | D13 | D12 |
|----------------|--------|--------|--------|--------|--------|--------|--------|----------------|-----|-----|-----|
| 0              | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED1STC[15:0] |     |     |     |
| R/W-0h         | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h         |     |     |     |
| D11            | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3             | D2  | D1  | D0  |
| ALED1STC[15:0] |        |        |        |        |        |        |        |                |     |     |     |
| R/W-0h         |        |        |        |        |        |        |        |                |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the ambient LED1 signal sample.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED1STC[15:0]: Sample ambient LED1 start count**

The contents of this register can be used to position the start of the sample ambient LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 94. ALED1ENDC: Sample Ambient LED1 End Count Register (Address = 0Ch, Reset Value = 0000h)**

| D23             | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15             | D14 | D13 | D12 |
|-----------------|--------|--------|--------|--------|--------|--------|--------|-----------------|-----|-----|-----|
| 0               | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED1ENDC[15:0] |     |     |     |
| R/W-0h          | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h          |     |     |     |
| D11             | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3              | D2  | D1  | D0  |
| ALED1ENDC[15:0] |        |        |        |        |        |        |        |                 |     |     |     |
| R/W-0h          |        |        |        |        |        |        |        |                 |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the ambient LED1 signal sample.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED1ENDC[15:0]: Sample ambient LED1 end count**

The contents of this register can be used to position the end of the sample ambient LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 95. LED2CONVST: LED2 Convert Start Count Register (Address = 0Dh, Reset Value = 0000h)**

| D23              | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15              | D14 | D13 | D12 |
|------------------|--------|--------|--------|--------|--------|--------|--------|------------------|-----|-----|-----|
| 0                | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED2CONVST[15:0] |     |     |     |
| R/W-0h           | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h           |     |     |     |
| D11              | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3               | D2  | D1  | D0  |
| LED2CONVST[15:0] |        |        |        |        |        |        |        |                  |     |     |     |
| R/W-0h           |        |        |        |        |        |        |        |                  |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the LED2 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED2CONVST[15:0]: LED2 convert start count**

The contents of this register can be used to position the start of the LED2 conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 96. LED2CONVEND: LED2 Convert End Count Register (Address = 0Eh, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED2CONVEND[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| LED2CONVEND[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the LED2 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED2CONVEND[15:0]: LED2 convert end count**

The contents of this register can be used to position the end of the LED2 conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 97. ALED2CONVST: LED2 Ambient Convert Start Count Register**  
(Address = 0Fh, Reset Value = 0000h)

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED2CONVST[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| ALED2CONVST[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the ambient LED2 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED2CONVST[15:0]: LED2 ambient convert start count**

The contents of this register can be used to position the start of the LED2 ambient conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 98. ALED2CONVEND: LED2 Ambient Convert End Count Register**  
(Address = 10h, Reset Value = 0000h)

| D23                | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15                | D14 | D13 | D12 |
|--------------------|--------|--------|--------|--------|--------|--------|--------|--------------------|-----|-----|-----|
| 0                  | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED2CONVEND[15:0] |     |     |     |
| R/W-0h             | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h             |     |     |     |
| D11                | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                 | D2  | D1  | D0  |
| ALED2CONVEND[15:0] |        |        |        |        |        |        |        |                    |     |     |     |
| R/W-0h             |        |        |        |        |        |        |        |                    |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the ambient LED2 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED2CONVEND[15:0]: LED2 ambient convert end count**

The contents of this register can be used to position the end of the LED2 ambient conversion signal with respect to the PRP. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 99. LED1CONVST: LED1 Convert Start Count Register (Address = 11h, Reset Value = 0000h)**

| D23              | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15              | D14 | D13 | D12 |
|------------------|--------|--------|--------|--------|--------|--------|--------|------------------|-----|-----|-----|
| 0                | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED1CONVST[15:0] |     |     |     |
| R/W-0h           | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h           |     |     |     |
| D11              | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3               | D2  | D1  | D0  |
| LED1CONVST[15:0] |        |        |        |        |        |        |        |                  |     |     |     |
| R/W-0h           |        |        |        |        |        |        |        |                  |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the LED1 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED1CONVST[15:0]: LED1 convert start count**

The contents of this register can be used to position the start of the LED1 conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 100. LED1CONVEND: LED1 Convert End Count Register (Address = 12h, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | LED1CONVEND[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| LED1CONVEND[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the LED1 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] LED1CONVEND[15:0]: LED1 convert end count**

The contents of this register can be used to position the end of the LED1 conversion signal with respect to the PRP. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 101. ALED1CONVST: LED1 Ambient Convert Start Count Register**  
(Address = 13h, Reset Value = 0000h)

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED1CONVST[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| ALED1CONVST[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start timing value for the ambient LED1 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED1CONVST[15:0]: LED1 ambient convert start count**

The contents of this register can be used to position the start of the LED1 ambient conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.

**Figure 102. ALED1CONVEND: LED1 Ambient Convert End Count Register**  
(Address = 14h, Reset Value = 0000h)

| D23                | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15                | D14 | D13 | D12 |
|--------------------|--------|--------|--------|--------|--------|--------|--------|--------------------|-----|-----|-----|
| 0                  | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ALED1CONVEND[15:0] |     |     |     |
| R/W-0h             | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h             |     |     |     |
| D11                | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                 | D2  | D1  | D0  |
| ALED1CONVEND[15:0] |        |        |        |        |        |        |        |                    |     |     |     |
| R/W-0h             |        |        |        |        |        |        |        |                    |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end timing value for the ambient LED1 conversion.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ALED1CONVEND[15:0]: LED1 ambient convert end count**

The contents of this register can be used to position the end of the LED1 ambient conversion signal with respect to the PRP. The count is specified as the number of 4-MHz clock cycles. Refer to the [Using the Timer Module](#) section for details.



**Figure 103. ADCRSTSTCT0: ADC Reset 0 Start Count Register (Address = 15h, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTSTCT0[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| ADCRSTSTCT0[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start position of the ADC0 reset conversion signal.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ADCRSTSTCT0[15:0]: ADC RESET 0 start count**

The contents of this register can be used to position the start of the ADC reset conversion signal (default value after reset is 0000h). Refer to the [Using the Timer Module](#) section for details.

**Figure 104. ADCRSTENDCT0: ADC Reset 0 End Count Register (Address = 16h, Reset Value = 0000h)**

| D23                | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15                | D14 | D13 | D12 |
|--------------------|--------|--------|--------|--------|--------|--------|--------|--------------------|-----|-----|-----|
| 0                  | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTENDCT0[15:0] |     |     |     |
| R/W-0h             | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h             |     |     |     |
| D11                | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                 | D2  | D1  | D0  |
| ADCRSTENDCT0[15:0] |        |        |        |        |        |        |        |                    |     |     |     |
| R/W-0h             |        |        |        |        |        |        |        |                    |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end position of the ADC0 reset conversion signal.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ADCRSTENDCT0[15:0]: ADC RESET 0 end count**

The contents of this register can be used to position the end of the ADC reset conversion signal (default value after reset is 0000h). Refer to the [Using the Timer Module](#) section for details.

**Figure 105. ADCRSTSTCT1: ADC Reset 1 Start Count Register (Address = 17h, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTSTCT1[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| ADCRSTSTCT1[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start position of the ADC1 reset conversion signal.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ADCRSTSTCT1[15:0]: ADC RESET 1 start count**

The contents of this register can be used to position the start of the ADC reset conversion. Refer to the [Using the Timer Module](#) section for details.

**Figure 106. ADCRSTENDCT1: ADC Reset 1 End Count Register (Address = 18h, Reset Value = 0000h)**

| D23                | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15                | D14 | D13 | D12 |
|--------------------|--------|--------|--------|--------|--------|--------|--------|--------------------|-----|-----|-----|
| 0                  | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTENDCT1[15:0] |     |     |     |
| R/W-0h             | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h             |     |     |     |
| D11                | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                 | D2  | D1  | D0  |
| ADCRSTENDCT1[15:0] |        |        |        |        |        |        |        |                    |     |     |     |
| R/W-0h             |        |        |        |        |        |        |        |                    |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end position of the ADC1 reset conversion signal.

**Bits D[23:16]      Must be '0'**

**Bits D[15:0]      ADCRSTENDCT1[15:0]: ADC RESET 1 end count**

The contents of this register can be used to position the end of the ADC reset conversion. Refer to the [Using the Timer Module](#) section for details.

**Figure 107. ADCRSTSTCT2: ADC Reset 2 Start Count Register (Address = 19h, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTSTCT2[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| ADCRSTSTCT2[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start position of the ADC2 reset conversion signal.

**Bits D[23:16]      Must be '0'**

**Bits D[15:0]      ADCRSTSTCT2[15:0]: ADC RESET 2 start count**

The contents of this register can be used to position the start of the ADC reset conversion. Refer to the [Using the Timer Module](#) section for details.

**Figure 108. ADCRSTENDCT2: ADC Reset 2 End Count Register (Address = 1Ah, Reset Value = 0000h)**

| D23                | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15                | D14 | D13 | D12 |
|--------------------|--------|--------|--------|--------|--------|--------|--------|--------------------|-----|-----|-----|
| 0                  | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTENDCT2[15:0] |     |     |     |
| R/W-0h             | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h             |     |     |     |
| D11                | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                 | D2  | D1  | D0  |
| ADCRSTENDCT2[15:0] |        |        |        |        |        |        |        |                    |     |     |     |
| R/W-0h             |        |        |        |        |        |        |        |                    |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end position of the ADC2 reset conversion signal.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ADCRSTENDCT2[15:0]: ADC RESET 2 end count**

The contents of this register can be used to position the end of the ADC reset conversion. Refer to the [Using the Timer Module](#) section for details.

**Figure 109. ADCRSTSTCT3: ADC Reset 3 Start Count Register (Address = 1Bh, Reset Value = 0000h)**

| D23               | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15               | D14 | D13 | D12 |
|-------------------|--------|--------|--------|--------|--------|--------|--------|-------------------|-----|-----|-----|
| 0                 | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTSTCT3[15:0] |     |     |     |
| R/W-0h            | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h            |     |     |     |
| D11               | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                | D2  | D1  | D0  |
| ADCRSTSTCT3[15:0] |        |        |        |        |        |        |        |                   |     |     |     |
| R/W-0h            |        |        |        |        |        |        |        |                   |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the start position of the ADC3 reset conversion signal.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ADCRSTSTCT3[15:0]: ADC RESET 3 start count**

The contents of this register can be used to position the start of the ADC reset conversion. Refer to the [Using the Timer Module](#) section for details.

**Figure 110. ADCRSTENDCT3: ADC Reset 3 End Count Register (Address = 1Ch, Reset Value = 0000h)**

| D23                | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15                | D14 | D13 | D12 |
|--------------------|--------|--------|--------|--------|--------|--------|--------|--------------------|-----|-----|-----|
| 0                  | 0      | 0      | 0      | 0      | 0      | 0      | 0      | ADCRSTENDCT3[15:0] |     |     |     |
| R/W-0h             | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h             |     |     |     |
| D11                | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3                 | D2  | D1  | D0  |
| ADCRSTENDCT3[15:0] |        |        |        |        |        |        |        |                    |     |     |     |
| R/W-0h             |        |        |        |        |        |        |        |                    |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the end position of the ADC3 reset conversion signal.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] ADCRSTENDCT3[15:0]: ADC RESET 3 end count**

The contents of this register can be used to position the end of the ADC reset conversion signal (default value after reset is 0000h). Refer to the [Using the Timer Module](#) section for details.

**Figure 111. PRPCOUNT: Pulse Repetition Period Count Register (Address = 1Dh, Reset Value = 0000h)**

| D23            | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15            | D14 | D13 | D12 |
|----------------|--------|--------|--------|--------|--------|--------|--------|----------------|-----|-----|-----|
| 0              | 0      | 0      | 0      | 0      | 0      | 0      | 0      | PRPCOUNT[15:0] |     |     |     |
| R/W-0h         | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h         |     |     |     |
| D11            | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3             | D2  | D1  | D0  |
| PRPCOUNT[15:0] |        |        |        |        |        |        |        |                |     |     |     |
| R/W-0h         |        |        |        |        |        |        |        |                |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the device pulse repetition period count.

**Bits D[23:16] Must be '0'**

**Bits D[15:0] PRPCOUNT[15:0]: Pulse repetition period count**

The contents of this register can be used to set the pulse repetition period (in number of clock cycles of the 4-MHz clock). The PRPCOUNT value must be set in the range of 800 to 64000. Values below 800 do not allow sufficient sample time for the four samples; see the [Electrical Characteristics](#) table.

**Figure 112. CONTROL1: Control Register 1 (Address = 1Eh, Reset Value = 0000h)**

| D23            | D22    | D21    | D20     | D19        | D18    | D17    | D16    | D15    | D14    | D13    | D12    |
|----------------|--------|--------|---------|------------|--------|--------|--------|--------|--------|--------|--------|
| 0              | 0      | 0      | 0       | 0          | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h         | R/W-0h | R/W-0h | R/W-0h  | R/W-0h     | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |
| D11            | D10    | D9     | D8      | D7         | D6     | D5     | D4     | D3     | D2     | D1     | D0     |
| CLKALMPIN[2:0] |        |        | TIMEREN | NUMAV[7:0] |        |        |        |        |        |        |        |
| R/W-0h         |        |        | R/W-0h  | R/W-0h     |        |        |        |        |        |        |        |

LEGEND: R/W = Read/Write; -n = value after reset

This register configures the clock alarm pin, timer, and number of averages.

**Bits D[23:12] Must be '0'**

**Bits D[11:9] CLKALMPIN[2:0]: Clocks on ALM pins**

Internal clocks can be brought to the PD\_ALM and LED\_ALM pins for monitoring. Note that the ALMPINCLKEN register bit must be set before using this register bit. [Table 5](#) defines the settings for the two alarm pins.

**Bit D8 TIMEREN: Timer enable**

0 = Timer module is disabled and all internal clocks are off (default after reset)  
1 = Timer module is enabled

**Bits D[7:0] NUMAV[7:0]: Number of averages**

Specify an 8-bit value corresponding to the number of ADC samples to be averaged – 1. For example, to average four ADC samples, set NUMAV[7:0] equal to 3. The maximum number of averages is 16. Any NUMAV[7:0] setting greater than or equal to a decimal value of 15 results in the number of averages being set to 16.

**Table 5. PD\_ALM and LED\_ALM Pin Settings**

| CLKALMPIN[2:0] | PD_ALM PIN SIGNAL         | LED_ALM PIN SIGNAL        |
|----------------|---------------------------|---------------------------|
| 000            | Sample LED2 pulse         | Sample LED1 pulse         |
| 001            | LED2 LED pulse            | LED1 LED pulse            |
| 010            | Sample LED2 ambient pulse | Sample LED1 ambient pulse |
| 011            | LED2 convert              | LED1 convert              |
| 100            | LED2 ambient convert      | LED1 ambient convert      |
| 101            | No output                 | No output                 |
| 110            | No output                 | No output                 |
| 111            | No output                 | No output                 |

**Figure 113. SPARE1: SPARE1 Register For Future Use (Address = 1Fh, Reset Value = 0000h)**

| D23    | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15    | D14    | D13    | D12    |
|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |
| D11    | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3     | D2     | D1     | D0     |
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; -n = value after reset

This register is a spare register and is reserved for future use.

**Bits D[23:0]      Must be '0'**

**Figure 114. TIAGAIN: Transimpedance Amplifier Gain Setting Register**  
(Address = 20h, Reset Value = 0000h)

| D23    | D22            | D21    | D20    | D19          | D18    | D17    | D16    | D15           | D14           | D13    | D12    |
|--------|----------------|--------|--------|--------------|--------|--------|--------|---------------|---------------|--------|--------|
| 0      | 0              | 0      | 0      | 0            | 0      | 0      | 0      | ENSEP<br>GAIN | STAGE2<br>EN1 | 0      | 0      |
| R/W-0h | R/W-0h         | R/W-0h | R/W-0h | R/W-0h       | R/W-0h | R/W-0h | R/W-0h | R/W-0h        | R/W-0h        | R/W-0h | R/W-0h |
| D11    | D10            | D9     | D8     | D7           | D6     | D5     | D4     | D3            | D2            | D1     | D0     |
| 0      | STG2GAIN1[2:0] |        |        | CF_LED1[4:0] |        |        |        | RF_LED1[2:0]  |               |        |        |
| R/W-0h | R/W-0h         |        |        | R/W-0h       |        |        |        | R/W-0h        |               |        |        |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the device transimpedance amplifier gain mode and feedback resistor and capacitor values.

**Bits D[23:16] Must be '0'**

**Bit D15 ENSEPGAIN: Enable separate gain mode**

0 = The  $R_F$ ,  $C_F$  values and stage 2 gain settings are the same for both the LED2 and LED1 signals; the values are specified by the RF\_LED2, CF\_LED2, STAGE2EN2, and STG2GAIN2 bits in the TIA\_AMB\_GAIN register (default after reset)

1 = The  $R_F$ ,  $C_F$  values and stage 2 gain settings can be independently set for the LED2 and LED1 signals. The values for LED1 are specified using the RF\_LED1, CF\_LED1, STAGE2EN1, and STG2GAIN1 bits in the TIAGAIN register, whereas the values for LED2 are specified using the corresponding bits in the TIA\_AMB\_GAIN register.

**Bit D14 STAGE2EN1: Enable Stage 2 for LED 1**

0 = Stage 2 is bypassed (default after reset)

1 = Stage 2 is enabled with the gain value specified by the STG2GAIN1[2:0] bits

**Bits D[13:11] Must be '0'**

**Bits D[10:8] STG2GAIN1[2:0]: Program Stage 2 gain for LED1**

000 = 0 dB, or linear gain of 1 (default after reset)

001 = 3.5 dB, or linear gain of 1.5

010 = 6 dB, or linear gain of 2

011 = 9.5 dB, or linear gain of 3

100 = 12 dB, or linear gain of 4

101 = Do not use

110 = Do not use

111 = Do not use

**Bits D[7:3] CF\_LED1[4:0]: Program  $C_F$  for LED1**

00000 = 5 pF (default after reset)

00001 = 5 pF + 5 pF

00010 = 15 pF + 5 pF

00100 = 25 pF + 5 pF

01000 = 50 pF + 5 pF

10000 = 150 pF + 5 pF

Note that any combination of these  $C_F$  settings is also supported by setting multiple bits to '1'. For example, to obtain  $C_F = 100$  pF, set D[7:3] = 01111.

**Bits D[2:0] RF\_LED1[2:0]: Program  $R_F$  for LED1**

000 = 500 k $\Omega$  (default after reset)

001 = 250 k $\Omega$

010 = 100 k $\Omega$

011 = 50 k $\Omega$

100 = 25 k $\Omega$

101 = 10 k $\Omega$

110 = 1 M $\Omega$

111 = None

**Figure 115. TIA\_AMB\_GAIN: Transimpedance Amplifier and Ambient Cancellation Stage Gain Register  
(Address = 21h, Reset Value = 0000h)**

| D23    | D22            | D21    | D20    | D19          | D18 | D17 | D16 | D15            | D14           | D13    | D12    |
|--------|----------------|--------|--------|--------------|-----|-----|-----|----------------|---------------|--------|--------|
| 0      | 0              | 0      | 0      | AMBDAC[3:0]  |     |     |     | FLTR<br>CNRSEL | STAGE2<br>EN2 | 0      | 0      |
| R/W-0h | R/W-0h         | R/W-0h | R/W-0h | R/W-0h       |     |     |     | R/W-0h         | R/W-0h        | R/W-0h | R/W-0h |
| D11    | D10            | D9     | D8     | D7           | D6  | D5  | D4  | D3             | D2            | D1     | D0     |
| 0      | STG2GAIN2[2:0] |        |        | CF_LED2[4:0] |     |     |     | RF_LED2[2:0]   |               |        |        |
| R/W-0h | R/W-0h         |        |        | R/W-0h       |     |     |     | R/W-0h         |               |        |        |

LEGEND: R/W = Read/Write; -n = value after reset

This register configures the ambient light cancellation amplifier gain, cancellation current, and filter corner frequency.

**Bits D[23:20] Must be '0'**

**Bits D[19:16] AMBDAC[3:0]: Ambient DAC value**

These bits set the value of the cancellation current.

|  |                   |
|--|-------------------|
| 0000 = 0 $\mu$ A (default after reset) | 1000 = 8 $\mu$ A  |
| 0001 = 1 $\mu$ A                       | 1001 = 9 $\mu$ A  |
| 0010 = 2 $\mu$ A                       | 1010 = 10 $\mu$ A |
| 0011 = 3 $\mu$ A                       | 1011 = Do not use |
| 0100 = 4 $\mu$ A                       | 1100 = Do not use |
| 0101 = 5 $\mu$ A                       | 1101 = Do not use |
| 0110 = 6 $\mu$ A                       | 1110 = Do not use |
| 0111 = 7 $\mu$ A                       | 1111 = Do not use |

**Bit D15 FLTRCNRSEL: Filter corner selection**

0 = 500-Hz filter corner (default after reset)  
1 = 1000-Hz filter corner

**Bit D14 STAGE2EN2: Stage 2 enable for LED 2**

0 = Stage 2 is bypassed (default after reset)  
1 = Stage 2 is enabled with the gain value specified by the STG2GAIN2[2:0] bits

**Bits D[13:11] Must be '0'**

**Bits D[10:8] STG2GAIN2[2:0]: Stage 2 gain setting for LED 2**

|   |                                  |
|---|----------------------------------|
| 000 = 0 dB, or linear gain of 1 (default after reset) | 100 = 12 dB, or linear gain of 4 |
| 001 = 3.5 dB, or linear gain of 1.5                   | 101 = Do not use                 |
| 010 = 6 dB, or linear gain of 2                       | 110 = Do not use                 |
| 011 = 9.5 dB, or linear gain of 3                     | 111 = Do not use                 |

**Bits D[7:3] CF\_LED2[4:0]: Program  $C_F$  for LED2**

|                                    |                       |
|------------------------------------|-----------------------|
| 00000 = 5 pF (default after reset) | 00100 = 25 pF + 5 pF  |
| 00001 = 5 pF + 5 pF                | 01000 = 50 pF + 5 pF  |
| 00010 = 15 pF + 5 pF               | 10000 = 150 pF + 5 pF |

Note that any combination of these  $C_F$  settings is also supported by setting multiple bits to '1'. For example, to obtain  $C_F$  = 100 pF, set D[7:3] = 01111.

**Bits D[2:0] RF\_LED2[2:0]: Program  $R_F$  for LED2**

|                      |                     |
|----------------------|---------------------|
| 000 = 500 k $\Omega$ | 100 = 25 k $\Omega$ |
| 001 = 250 k $\Omega$ | 101 = 10 k $\Omega$ |
| 010 = 100 k $\Omega$ | 110 = 1 M $\Omega$  |
| 011 = 50 k $\Omega$  | 111 = None          |

**Figure 116. LEDCNTRL: LED Control Register (Address = 22h, Reset Value = 0000h)**

| D23       | D22    | D21    | D20    | D19       | D18    | D17            | D16 | D15       | D14 | D13 | D12 |
|-----------|--------|--------|--------|-----------|--------|----------------|-----|-----------|-----|-----|-----|
| 0         | 0      | 0      | 0      | 0         | 0      | LED_RANGE[1:0] |     | LED1[7:0] |     |     |     |
| R/W-0h    | R/W-0h | R/W-0h | R/W-0h | R/W-0h    | R/W-0h | R/W-0h         |     | R/W-0h    |     |     |     |
| D11       | D10    | D9     | D8     | D7        | D6     | D5             | D4  | D3        | D2  | D1  | D0  |
| LED1[7:0] |        |        |        | LED2[7:0] |        |                |     |           |     |     |     |
| R/W-0h    |        |        |        | R/W-0h    |        |                |     |           |     |     |     |

LEGEND: R/W = Read/Write; -n = value after reset

This register sets the LED current range and the LED1 and LED2 drive current.

**Bits D[23:18]      Must be '0'**

**Bits D[17:16]      LED\_RANGE[1:0]: LED range**

These bits program the full-scale LED current range for Tx. [Table 6](#) details the settings.

**Bits D[15:8]      LED1[7:0]: Program LED current for LED1 signal**

Use these register bits to specify the LED current setting for LED1 (default after reset is 00h).

The nominal value of the LED current is given by [Equation 6](#), where the full-scale LED current is either 0 mA, 50 mA, 75 mA, 100 mA, 150 mA, or 200 mA (as specified by the LED\_RANGE[1:0] register bits).

**Bits D[7:0]      LED2[7:0]: Program LED current for LED2 signal**

Use these register bits to specify the LED current setting for LED2 (default after reset is 00h).

The nominal value of LED current is given by [Equation 7](#), where the full-scale LED current is either 0 mA, 50 mA, 75 mA, 100 mA, 150 mA, or 200 mA (as specified by the LED\_RANGE[1:0] register bits).

**Table 6. Full-Scale LED Current across Tx Reference Voltage Settings<sup>(1)</sup>**

| LED_RANGE[1:0]           | 0.75 V (TX_REF[1:0] = 00) |                 | 0.5 V (TX_REF[1:0] = 01) |                 | 1.0 V (TX_REF[1:0] = 10) |                 |
|--------------------------|---------------------------|-----------------|--------------------------|-----------------|--------------------------|-----------------|
|                          | I <sub>MAX</sub>          | V <sub>HR</sub> | I <sub>MAX</sub>         | V <sub>HR</sub> | I <sub>MAX</sub>         | V <sub>HR</sub> |
| 00 (default after reset) | 150 mA                    | 1.4 V           | 100 mA                   | 1.1 V           | 200 mA                   | 1.7 V           |
| 01                       | 75 mA                     | 1.3 V           | 50 mA                    | 1.0 V           | 100 mA                   | 1.6 V           |
| 10                       | 150 mA                    | 1.4 V           | 100 mA                   | 1.1 V           | 200 mA                   | 1.7 V           |
| 11                       | Tx is off                 | —               | Tx is off                | —               | Tx is off                | —               |

(1) For a 3-V to 3.6-V supply, use TX\_REF = 0.5 V. For a 4.75-V to 5.25-V supply, use TX\_REF = 0.75 V or 1.0 V.

$$\frac{\text{LED1[7:0]}}{256} \times \text{Full-Scale Current} \quad (6)$$

$$\frac{\text{LED2[7:0]}}{256} \times \text{Full-Scale Current} \quad (7)$$



**Figure 117. CONTROL2: Control Register 2 (Address = 23h, Reset Value = 0000h)**

| D23       | D22             | D21      | D20          | D19    | D18     | D17     | D16               | D15        | D14    | D13    | D12    |
|-----------|-----------------|----------|--------------|--------|---------|---------|-------------------|------------|--------|--------|--------|
| 0         | 0               | 0        | 0            | 0      | TX_REF1 | TX_REF0 | RST_CLK_ON_PD_ALM | EN_ADC_BYP | 0      | 0      | 0      |
| R/W-0h    | R/W-0h          | R/W-0h   | R/W-0h       | R/W-0h | R/W-0h  | R/W-0h  | R/W-0h            | R/W-0h     | R/W-0h | R/W-0h | R/W-0h |
| D11       | D10             | D9       | D8           | D7     | D6      | D5      | D4                | D3         | D2     | D1     | D0     |
| TXBRG_MOD | DIGOUT_TRISTATE | XTAL_DIS | EN_SLOW_DIAG | 0      | 0       | 0       | 0                 | 0          | PDNTX  | PDNRX  | PDNAFE |
| R/W-0h    | R/W-0h          | R/W-0h   | R/W-0h       | R/W-0h | R/W-0h  | R/W-0h  | R/W-0h            | R/W-0h     | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; -n = value after reset

This register controls the LED transmitter, crystal, and the AFE, transmitter, and receiver power modes.

**Bits D[23:19] Must be '0'**

**Bits D[18:17] TX\_REF[1:0]: Tx reference voltage**

These bits set the transmitter reference voltage. This Tx reference voltage is available on the device TX\_REF pin.

00 = 0.75-V Tx reference voltage (default value after reset)

01 = 0.5-V Tx reference voltage

10 = 1.0-V Tx reference voltage

11 = 0.75-V Tx reference voltage

NOTE: For best results, use TX\_REF = 0.5 V for 3-V operation. Use TX\_REF = 0.75V and TX\_REF = 1.0 V for 5-V operation.

**Bit D16 RST\_CLK\_ON\_PD\_ALM: Reset clock onto PD\_ALM pin**

0 = Normal mode; no reset clock signal is connected to the PD\_ALM pin

1 = Reset clock signal is connected to the PD\_ALM pin

**Bit D15 EN\_ADC\_BYP: ADC bypass mode enable**

0 = Normal mode, the internal ADC is active (default after reset)

1 = ADC bypass mode, the analog signal is output to the ADC\_BYPP and ADC\_BYPN pins

**Bits D[14:12] Must be '0'**

**Bit D11 TXBRG\_MOD: Tx bridge mode**

0 = LED driver is configured as an H-bridge (default after reset)

1 = LED driver is configured as a push-pull

**Bit D10 DIGOUT\_TRISTATE: Digital output 3-state mode**

This bit determines the state of the device digital output pins, including the clock output pin and SPI output pins. In order to avoid loading the SPI bus when multiple devices are connected, this bit must be set to '1' (3-state mode) whenever the device SPI is inactive.

0 = Normal operation (default)

1 = 3-state mode

**Bit D9 XTALDIS: Crystal disable mode**

0 = The crystal module is enabled; the 8-MHz crystal must be connected to the XIN and XOUT pins

1 = The crystal module is disabled; an external 8-MHz clock must be applied to the XIN pin

**Bit D8 EN\_SLOW\_DIAG: Fast diagnostics mode enable**

0 = Fast diagnostics mode, 8 ms (default value after reset)

1 = Slow diagnostics mode, 16 ms

**Bits D[7:3]      Must be '0'**

**Bit D2            PDN\_TX: Tx power-down**

0 = The Tx is powered up (default after reset)

1 = Only the Tx module is powered down

**Bit D1            PDN\_RX: Rx power-down**

0 = The Rx is powered up (default after reset)

1 = Only the Rx module is powered down

**Bit D0            PDN\_AFE: AFE power-down**

0 = The AFE is powered up (default after reset)

1 = The entire AFE is powered down (including the Tx, Rx, and diagnostics blocks)

**Figure 118. SPARE2: SPARE2 Register For Future Use (Address = 24h, Reset Value = 0000h)**

| D23    | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15    | D14    | D13    | D12    |
|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |
| D11    | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3     | D2     | D1     | D0     |
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; -n = value after reset

This register is a spare register and is reserved for future use.

**Bits D[23:0]      Must be '0'**

**Figure 119. SPARE3: SPARE3 Register For Future Use (Address = 25h, Reset Value = 0000h)**

| D23    | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15    | D14    | D13    | D12    |
|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |
| D11    | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3     | D2     | D1     | D0     |
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; -n = value after reset

This register is a spare register and is reserved for future use.

**Bits D[23:0]      Must be '0'**

**Figure 120. SPARE4: SPARE4 Register For Future Use (Address = 26h, Reset Value = 0000h)**

| D23    | D22    | D21    | D20    | D19    | D18    | D17    | D16    | D15    | D14    | D13    | D12    |
|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|--------|
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |
| D11    | D10    | D9     | D8     | D7     | D6     | D5     | D4     | D3     | D2     | D1     | D0     |
| 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      | 0      |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; -n = value after reset

This register is a spare register and is reserved for future use.

**Bits D[23:0]      Must be '0'**

**Figure 121. RESERVED1: RESERVED1 Register For Factory Use Only**  
(Address = 27h, Reset Value = XXXXh)

| D23              | D22  | D21  | D20  | D19  | D18  | D17  | D16  | D15  | D14  | D13  | D12  |
|------------------|------|------|------|------|------|------|------|------|------|------|------|
| X <sup>(1)</sup> | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    |
| R-0h             | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |
| D11              | D10  | D9   | D8   | D7   | D6   | D5   | D4   | D3   | D2   | D1   | D0   |
| X                | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    |
| R-0h             | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |

LEGEND: R = Read only; -n = value after reset

(1) X = don't care.

This register is reserved for factory use. Readback values vary between devices.

**Bits D[23:0] Must be '0'**

**Figure 122. RESERVED2: RESERVED2 Register For Factory Use Only**  
(Address = 28h, Reset Value = XXXXh)

| D23              | D22  | D21  | D20  | D19  | D18  | D17  | D16  | D15  | D14  | D13  | D12  |
|------------------|------|------|------|------|------|------|------|------|------|------|------|
| X <sup>(1)</sup> | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    |
| R-0h             | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |
| D11              | D10  | D9   | D8   | D7   | D6   | D5   | D4   | D3   | D2   | D1   | D0   |
| X                | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    | X    |
| R-0h             | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |

LEGEND: R = Read only; -n = value after reset

(1) X = don't care.

This register is reserved for factory use. Readback values vary between devices.

**Bits D[23:0] Must be '0'**

**Figure 123. ALARM: Alarm Register (Address = 29h, Reset Value = 0000h)**

| D23  | D22  | D21  | D20  | D19             | D18  | D17  | D16  | D15  | D14  | D13  | D12  |
|------|------|------|------|-----------------|------|------|------|------|------|------|------|
| 0    | 0    | 0    | 0    | 0               | 0    | 0    | 0    | 0    | 0    | 0    | 0    |
| R-0h | R-0h | R-0h | R-0h | R-0h            | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |
| D11  | D10  | D9   | D8   | D7              | D6   | D5   | D4   | D3   | D2   | D1   | D0   |
| 0    | 0    | 0    | 0    | ALMPIN<br>CLKEN | 0    | 0    | 0    | 0    | 0    | 0    | 0    |
| R-0h | R-0h | R-0h | R-0h | R-0h            | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h | R-0h |

LEGEND: R = Read only; -n = value after reset

This register controls the Alarm pin functionality.

**Bits D[23:8] Must be '0'**

**Bit D7 ALMPINCLKEN: Alarm pin clock enable**

0 = Disables the monitoring of internal clocks; the PD\_ALM and LED\_ALM pins function as diagnostic fault alarm output pins (default after reset)

1 = Enables the monitoring of internal clocks; these clocks can be brought out on PD\_ALM and LED\_ALM selectively (depending on the value of the CLKALMPIN[2:0] register bits).

**Bits D[6:0] Must be '0'**

**Figure 124. LED2VAL: LED2 Digital Sample Value Register (Address = 2Ah, Reset Value = 0000h)**

| D23           | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| LED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h          |     |     |     |     |     |     |     |     |     |     |     |
| D11           | D10 | D9  | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| LED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h          |     |     |     |     |     |     |     |     |     |     |     |

LEGEND: R = Read only; -n = value after reset

This register contains the digital value of the latest LED2 sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Bits D[23:0] LED2VAL[23:0]: LED2 digital value**

This register contains the digital value of the latest LED2 sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Figure 125. ALED2VAL: Ambient LED2 Digital Sample Value Register (Address = 2Bh, Reset Value = 0000h)**

| D23            | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|----------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| ALED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h           |     |     |     |     |     |     |     |     |     |     |     |
| D11            | D10 | D9  | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| ALED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h           |     |     |     |     |     |     |     |     |     |     |     |

LEGEND: R = Read only; -n = value after reset

This register contains the digital value of the latest LED2 ambient sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Bits D[23:0] ALED2VAL[23:0]: LED2 ambient digital value**

This register contains the digital value of the latest LED2 ambient sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Figure 126. LED1VAL: LED1 Digital Sample Value Register (Address = 2Ch, Reset Value = 0000h)**

| D23           | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|---------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| LED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h          |     |     |     |     |     |     |     |     |     |     |     |
| D11           | D10 | D9  | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| LED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h          |     |     |     |     |     |     |     |     |     |     |     |

LEGEND: R = Read only; -n = value after reset

This register contains the digital value of the latest LED1 sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Bits D[23:0] LED1VAL[23:0]: LED1 digital value**

This register contains the digital value of the latest LED1 sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Figure 127. ALED1VAL: Ambient LED1 Digital Sample Value Register (Address = 2Dh, Reset Value = 0000h)**

| D23            | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|----------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| ALED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h           |     |     |     |     |     |     |     |     |     |     |     |
| D11            | D10 | D9  | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| ALED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h           |     |     |     |     |     |     |     |     |     |     |     |

LEGEND: R = Read only; -n = value after reset

This register contains the digital value of the latest LED1 ambient sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Bits D[23:0] ALED1VAL[23:0]: LED1 ambient digital value**

This register contains the digital value of the latest LED1 ambient sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

**Figure 128. LED2-ALED2VAL: LED2-Ambient LED2 Digital Sample Value Register**  
(Address = 2Eh, Reset Value = 0000h)

| D23                 | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| LED2-ALED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h                |     |     |     |     |     |     |     |     |     |     |     |
| D11                 | D10 | D9  | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| LED2-ALED2VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h                |     |     |     |     |     |     |     |     |     |     |     |

LEGEND: R = Read only; -n = value after reset

This register contains the digital value of the LED2 sample after the LED2 ambient is subtracted. The host processor must readout this register before the next sample is converted by the AFE.

**Bits D[23:0] LED2-ALED2VAL[23:0]: (LED2 – LED2 ambient) digital value**

This register contains the digital value of the LED2 sample after the LED2 ambient is subtracted. The host processor must readout this register before the next sample is converted by the AFE.

Note that this value is inverted when compared to waveforms shown in many publications.

**Figure 129. LED1-ALED1VAL: LED1-Ambient LED1 Digital Sample Value Register**  
(Address = 2Fh, Reset Value = 0000h)

| D23                 | D22 | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| LED1-ALED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h                |     |     |     |     |     |     |     |     |     |     |     |
| D11                 | D10 | D9  | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| LED1-ALED1VAL[23:0] |     |     |     |     |     |     |     |     |     |     |     |
| R-0h                |     |     |     |     |     |     |     |     |     |     |     |

LEGEND: R = Read only; -n = value after reset

This register contains the digital value of the LED1 sample after the LED1 ambient is subtracted. The host processor must readout this register before the next sample is converted by the AFE.

**Bits D[23:0] LED1-ALED1VAL[23:0]: (LED1 – LED1 ambient) digital value**

This register contains the digital value of the LED1 sample after the LED1 ambient is subtracted from it. The host processor must readout this register before the next sample is converted by the AFE.

Note that this value is inverted when compared to waveforms shown in many publications.

**Figure 130. DIAG: Diagnostics Flag Register (Address = 30h, Reset Value = 0000h)**

| D23     | D22       | D21       | D20   | D19        | D18        | D17  | D16  | D15       | D14       | D13       | D12       |
|---------|-----------|-----------|-------|------------|------------|------|------|-----------|-----------|-----------|-----------|
| 0       | 0         | 0         | 0     | 0          | 0          | 0    | 0    | 0         | 0         | 0         | PD_ALM    |
| R-0h    | R-0h      | R-0h      | R-0h  | R-0h       | R-0h       | R-0h | R-0h | R-0h      | R-0h      | R-0h      | R-0h      |
| D11     | D10       | D9        | D8    | D7         | D6         | D5   | D4   | D3        | D2        | D1        | D0        |
| LED_ALM | LED1_OPEN | LED2_OPEN | LEDSC | OUTPSH_GND | OUTNSH_GND | PDOC | PDSC | INNSC_GND | INPSC_GND | INNSC_LED | INPSC_LED |
| R-0h    | R-0h      | R-0h      | R-0h  | R-0h       | R-0h       | R-0h | R-0h | R-0h      | R-0h      | R-0h      | R-0h      |

LEGEND: R = Read only; -n = value after reset

This register is read only. This register contains the status of all diagnostic flags at the end of the diagnostics sequence. The end of the diagnostics sequence is indicated by the signal going high on DIAG\_END pin.

**Bits D[23:13]      Read only**
**Bit D12            PD\_ALM: Power-down alarm status diagnostic flag**

This bit indicates the status of PD\_ALM (and the PD\_ALM pin).  
0 = No fault (default after reset)  
1 = Fault present

**Bit D11            LED\_ALM: LED alarm status diagnostic flag**

This bit indicates the status of LED\_ALM (and the LED\_ALM pin).  
0 = No fault (default after reset)  
1 = Fault present

**Bit D10            LED1OPEN: LED1 open diagnostic flag**

This bit indicates that LED1 is open.  
0 = No fault (default after reset)  
1 = Fault present

**Bit D9             LED2OPEN: LED2 open diagnostic flag**

This bit indicates that LED2 is open.  
0 = No fault (default after reset)  
1 = Fault present

**Bit D8             LEDSC: LED short diagnostic flag**

This bit indicates an LED short.  
0 = No fault (default after reset)  
1 = Fault present

**Bit D7             OUTPSHGND: OUTP to GND diagnostic flag**

This bit indicates that OUTP is shorted to the GND cable.  
0 = No fault (default after reset)  
1 = Fault present

**Bit D6             OUTNSHGND: OUTN to GND diagnostic flag**

This bit indicates that OUTN is shorted to the GND cable.  
0 = No fault (default after reset)  
1 = Fault present

**Bit D5             PDOC: PD open diagnostic flag**

This bit indicates that PD is open.  
0 = No fault (default after reset)  
1 = Fault present

|               |   |
|---------------|---|
| <b>Bit D4</b> | <b>PDSC: PD short diagnostic flag</b><br>This bit indicates a PD short.<br>0 = No fault (default after reset)<br>1 = Fault present                                      |
| <b>Bit D3</b> | <b>INNSCGND: INN to GND diagnostic flag</b><br>This bit indicates a short from the INN pin to the GND cable.<br>0 = No fault (default after reset)<br>1 = Fault present |
| <b>Bit D2</b> | <b>INPSCGND: INP to GND diagnostic flag</b><br>This bit indicates a short from the INP pin to the GND cable.<br>0 = No fault (default after reset)<br>1 = Fault present |
| <b>Bit D1</b> | <b>INNSCLED: INN to LED diagnostic flag</b><br>This bit indicates a short from the INN pin to the LED cable.<br>0 = No fault (default after reset)<br>1 = Fault present |
| <b>Bit D0</b> | <b>INPSCLED: INP to LED diagnostic flag</b><br>This bit indicates a short from the INP pin to the LED cable.<br>0 = No fault (default after reset)<br>1 = Fault present |



## 9 Applications and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

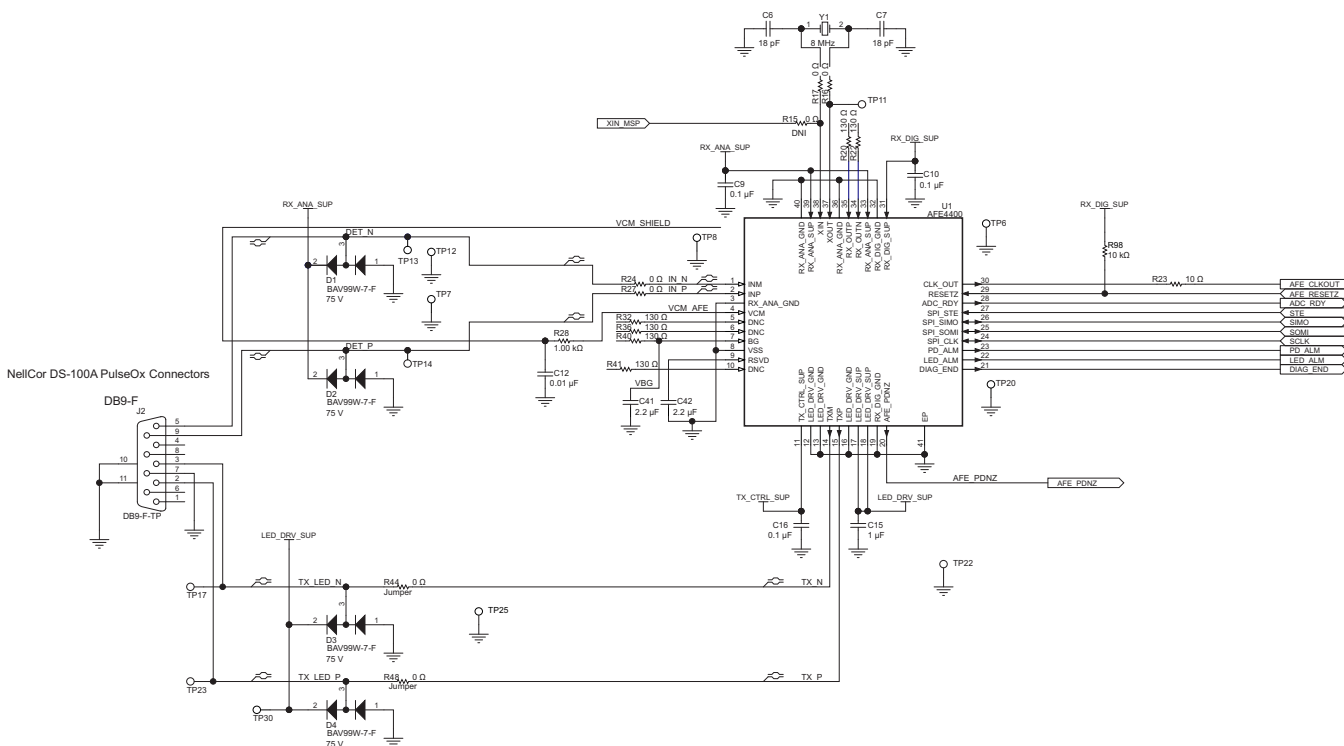
### 9.1 Application Information

The AFE4490 can be used for measuring SPO2 and for monitoring heart rate. The high dynamic range of the device enables measuring SPO2 with a high degree of accuracy even under low-perfusion (ac-to-dc ratio) conditions. An SPO2 measurement system involves two different wavelength LEDs—usually Red and IR. By computing the ratio of the ac to dc at the two different wavelengths, the SPO2 can be calculated. Heart rate monitoring systems can also benefit from the high dynamic range of the device, which enables capturing a high-fidelity pulsating signal even in cases where the signal strength is low.

For more information on application guidelines, refer to the [AFE44x0SPO2EVM User's Guide \(SLAU480\)](#).

### 9.2 Typical Application

Device connections in a typical application are shown in [Figure 131](#). Refer to the [AFE44x0SPO2EVM User's Guide \(SLAU480\)](#) for more details. The schematic in [Figure 131](#) is a part of the AFE44x0SPO2EVM and shows a cabled application in which the LEDs and photodiode are connected to the AFE4490 through a cable. However, in an application without cables, the LEDs and photodiode can be directly connected to the TXP, TXN and INP, INN pins directly, as shown in the [Design Requirements](#) section.



NOTE: The following signals must be considered as two sets of differential pairs and routed as adjacent signals within each pair: TXM, TXP and INM, INP.

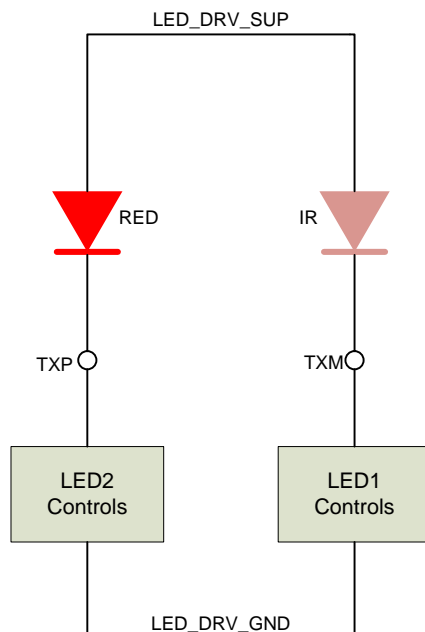
INM and INP must be guarded with VCM\_SHIELD the signal. Run the VCM\_SHIELD signal to the DB9 connector and back to the device.

**Figure 131. AFE44x0SPO2EVM: Connections to the AFE4490**

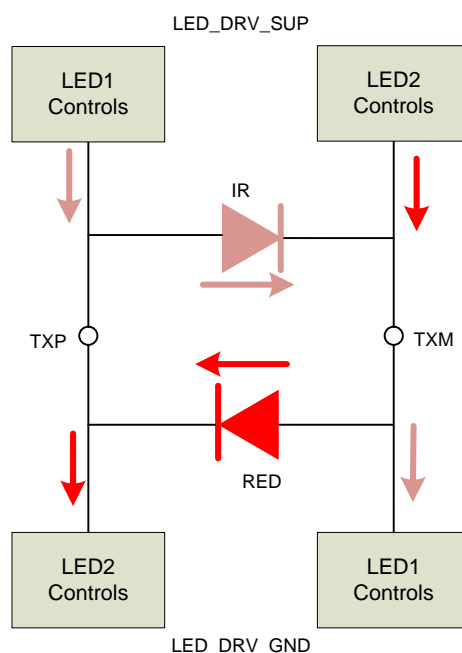
## Typical Application (continued)

### 9.2.1 Design Requirements

An SPO2 application usually involves a Red LED and an IR LED. These LEDs can be connected either in the common anode configuration or H-bridge configuration to the TXP, TXN pins. [Figure 132](#) shows common anode configuration and [Figure 133](#) shows H-bridge configuration.



**Figure 132. LEDs in Common Anode Configuration**



**Figure 133. LEDs in H-Bridge Configuration**

## Typical Application (continued)

### 9.2.2 Detailed Design Procedure

The photodiode receives the light from both the Red and IR phases and usually has good sensitivities at both these wavelengths.

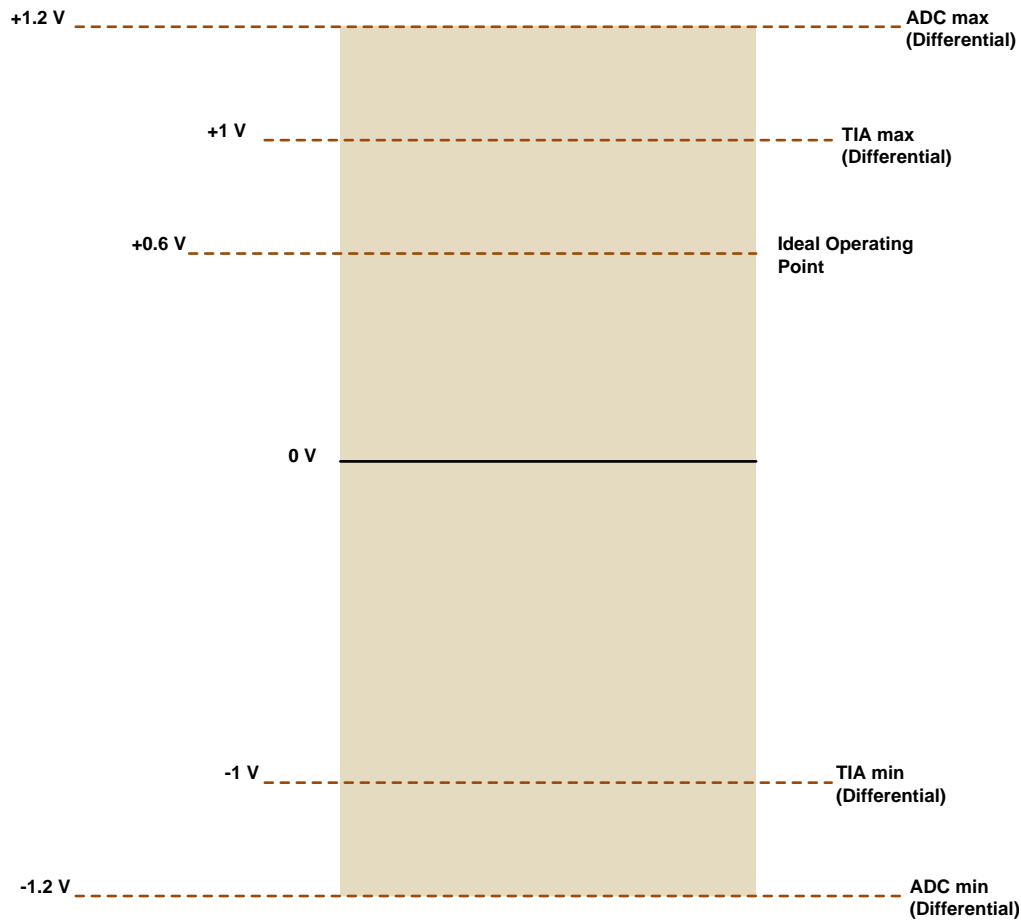
The photodiode connected in this manner operates in zero bias because of the negative feedback from the transimpedance amplifier. The connections of the photodiode to the AFE inputs are shown in [Figure 134](#).



**Figure 134. Photodiode Connection**

The signal current generated by the photodiode is converted into a voltage by the transimpedance amplifier, which has a programmable transimpedance gain. The rest of the signal chain then presents a voltage to the ADC. The full-scale output of the transimpedance amplifier is  $\pm 1$  V and the full-scale input to the ADC is  $\pm 1.2$  V. An automatic gain control loop can be used to set the target dc voltage at the ADC input to approximately 50% of full scale. This type of AGC loop can control a combination of LED current and TIA gain to achieve this target value; see [Figure 135](#).

## Typical Application (continued)



**Figure 135. AGC Loop**

The ADC output is a 22-bit code that is obtained by discarding the two MSBs of the 24-bit registers (for example the register with address 2Ah).

| D23                            | D22 | D21                         | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |
|--------------------------------|-----|-----------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Ignore                         |     | 22-Bit ADC Code, MSB to LSB |     |     |     |     |     |     |     |     |     |
| R/W-0h                         |     | R/W-0h                      |     |     |     |     |     |     |     |     |     |
| D11                            | D10 | D9                          | D8  | D7  | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| 22-Bit ADC Code, MSB to LSB    |     |                             |     |     |     |     |     |     |     |     |     |
| R/W-0h (TBD register correct?) |     |                             |     |     |     |     |     |     |     |     |     |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

Table 7 shows the mapping of the input voltage to the ADC output code.

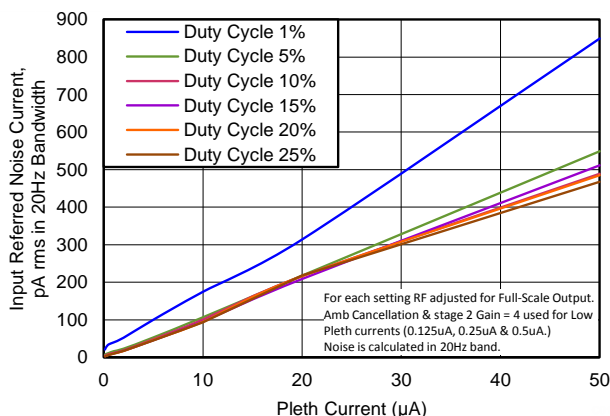
**Table 7. Input Voltage Mapping**

| DIFFERENTIAL INPUT VOLTAGE AT ADC INPUT | 22-BIT ADC OUTPUT CODE |
|---|------------------------|
| -1.2 V                                  | 1000000000000000000000 |
| $(-1.2 / 2^{21})$ V                     | 1111111111111111111111 |
| 0                                       | 0000000000000000000000 |
| $(1.2 / 2^{21})$ V                      | 0000000000000000000001 |
| 1.2 V                                   | 0111111111111111111111 |

The data format is binary two's complement format, MSB first. TI recommends that the input to the ADC does not exceed  $\pm 1$  V (which is approximately 80% full-scale) because the TIA has a full-scale range of  $\pm 1$  V.

### 9.2.3 Application Curve

The dc component of the current from the PPG signal is referred to as *Pleth* (short for photoplethysmography) current. The input-referred noise current (referred differentially to the INP, INN inputs) as a function of the Pleth current is shown in Figure 136 at a PRF of 600 Hz and for various duty cycles of LED pulsing. For example, a duty cycle of 25% refers to a case where the LED is pulsed for 25% of the pulse repetition period and the receiver samples the photodiode current for the same period of time. The noise shown in Figure 136 is the integrated noise over a 20-Hz bandwidth from dc.



**Figure 136. Input-Referred Noise Current vs Pleth Current (BW = 20Hz, PRF = 600 Hz)**

## 10 Power-Supply Recommendations

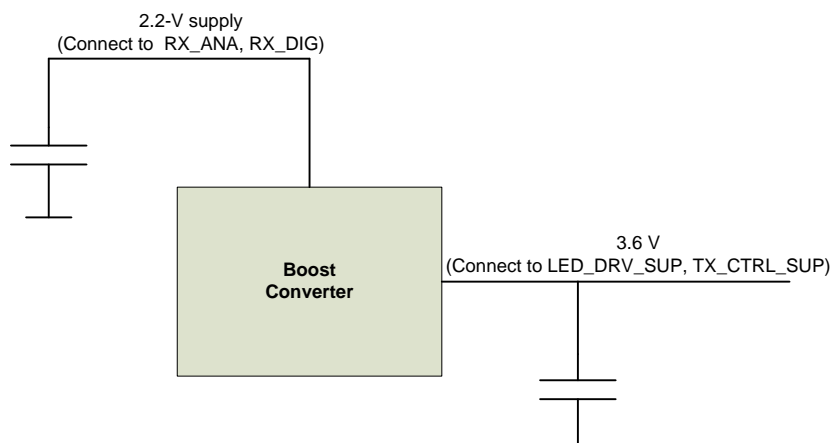
The AFE4490 has two sets of supplies: the receiver supplies (RX\_ANA\_SUP, RX\_DIG\_SUP) and the transmitter supplies (TX\_CTRL\_SUP, LED\_DRV\_SUP). The receiver supplies can be between 2.0 V to 3.6 V whereas the transmitter supplies can be between 3.0 V to 5.25 V. Another consideration that determines the minimum allowed value of the transmitter supplies is the forward voltage of the LEDs being driven. The current source and switches inside the AFE require voltage headroom that mandates the transmitter supply to be a few hundred millivolts higher than the LED forward voltage. TX\_REF is the voltage that governs the generation of the LED current from the internal reference voltage. Choosing the lowest allowed TX\_REF setting reduces the additional headroom required but results in higher transmitter noise. Other than for the highest end clinical SPO2 applications, this extra noise resulting from a lower TX\_REF setting might be acceptable.

The LED\_DRV\_SUP and TX\_CTRL\_SUP are recommended to be tied together to the same supply (between 3.0 V and 5.25 V). The external supply (connected to the common anode of the two LEDs) must be high enough to account for the forward drop of the LEDs as well as the voltage headroom required by the current source and switches inside the AFE. In most cases, this voltage is expected to fall below 5.25 V; thus the external supply can be the same as the LED\_DRV\_SUP. However, there might be cases (for instance when two LEDs are connected in series) where the voltage required on the external supply is higher than 5.25 V. Such a case must be handled with care to ensure that the voltage on the TXP and TXN pins stays less than 5.25 V and also never exceeds the supply voltage of LED\_DRV\_SUP, TX\_CTRL\_SUP by more than 0.3 V.

Many scenarios of power management are possible.

**Case 1:** LED forward voltage is such that a voltage of 3.3 V (for example) is acceptable on LED\_DRV\_SUP. In that case, a single 3.3-V supply can be used to drive all four pins (RX\_ANA\_SUP, RX\_DIG\_SUP, TX\_CTRL\_SUP, LED\_DRV\_SUP). Care must be taken to provide some isolation between the transmit and receive supplies because the LED\_DRV\_SUP carries the high switching current from the LEDs.

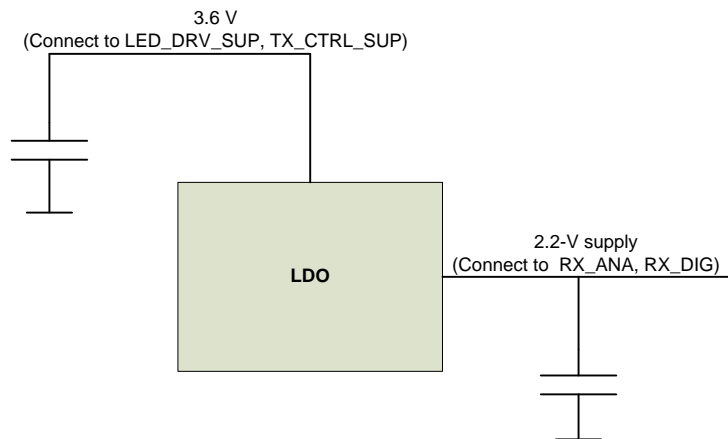
**Case 2:** A low-voltage supply (2.2 V for instance) is available in the system. In this case, a boost converter can be used to derive the voltage for the LED\_DRV\_SUP, as shown in [Figure 137](#).



**Figure 137. Boost Converter**

The boost converter requires a clock (usually in the megahertz range) and there is usually a ripple at the boost converter output at this switching frequency. While this frequency is much higher than the signal frequency of interest (which is at maximum a few 10s of hertz around dc), a small fraction of this switching noise might possibly alias to the low-frequency band. Therefore, TI strongly recommends that the switching frequency of the boost converter be offset from every multiple of the PRF by at least 20 Hz, which can be ensured by choosing the appropriate PRF.

**Case 3:** In cases where a high voltage supply is available in the system, a buck converter or an LDO can be used to derive the voltage levels required to drive RX\_ANA and RX\_DIG. Such a scenario is shown in [Figure 138](#).



**Figure 138. Buck Converter or an LDO**

For more information on power-supply recommendations, see the [AFE44x0SPO2EVM User's Guide \(SLAU480\)](#).

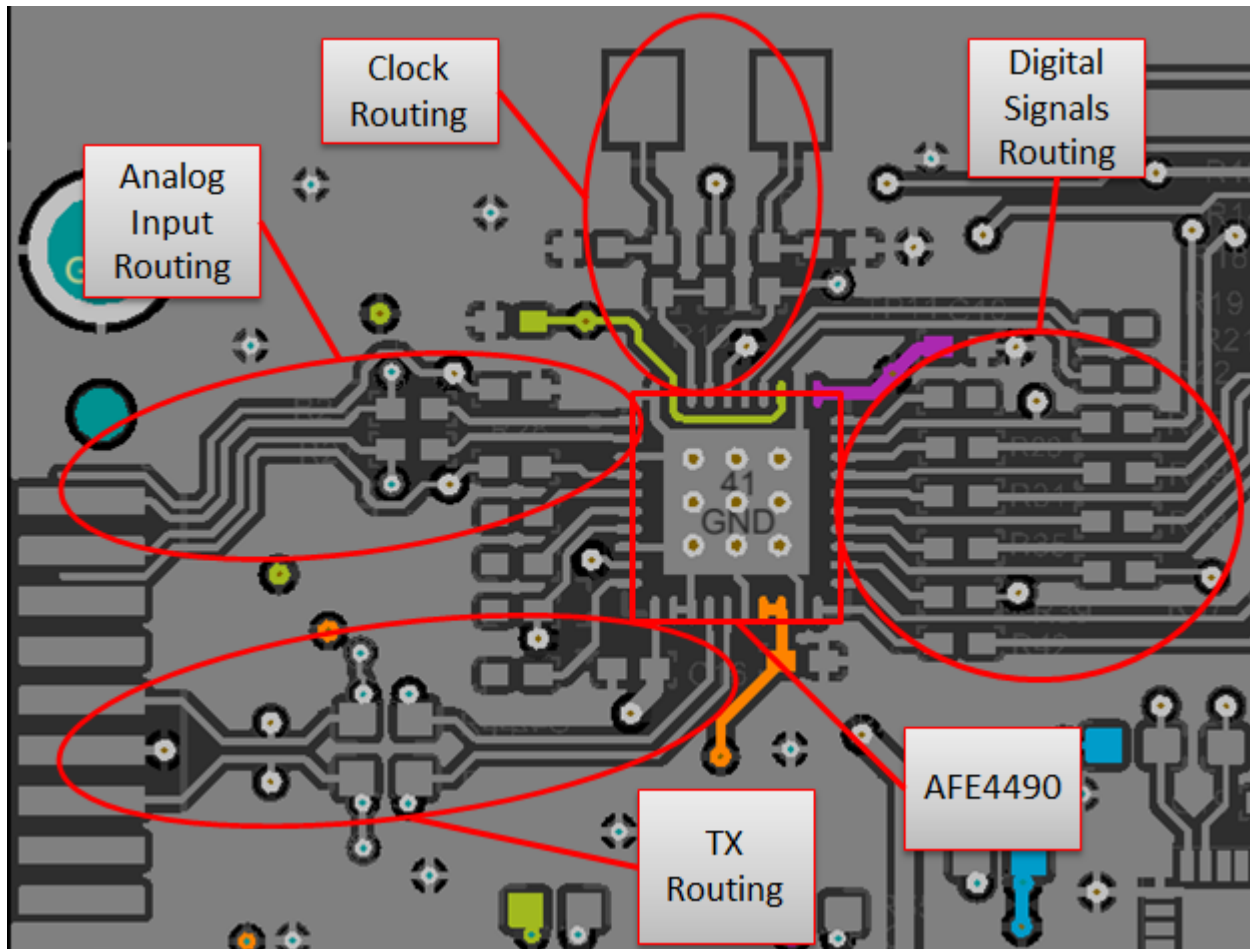
## 11 Layout

### 11.1 Layout Guidelines

Some key layout guidelines are:

1. TXP, TXN are fast switching lines and must be routed away from sensitive reference lines as well as from the INP, INN inputs.
2. If required to route long, TI recommends that the VCM be used as a shield for the INP, INN lines.
3. The device can draw high switching currents from the LED\_DRV\_SUP pin. Therefore, having a decoupling capacitor electrically close to the pin is recommended.

### 11.2 Layout Example



**Figure 139. Typical Layout of the AFE4490 Board**



## 12 Device and Documentation Support

### 12.1 Documentation Support

#### 12.1.1 Related Documentation

AFE44x0SPO2EVM User's Guide, [SLAU480](#)

*SpO Pulse Ox Wrist Oximeter Reference Design*, [TIDU124](#)

### 12.2 Trademarks

SPI is a trademark of Motorola.

All other trademarks are the property of their respective owners.

### 12.3 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| AFE4490RHAR      | ACTIVE        | VQFN         | RHA                | 40   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | AFE4490                 | <a href="#">Samples</a> |
| AFE4490RHAT      | ACTIVE        | VQFN         | RHA                | 40   | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-3-260C-168 HR  | -40 to 85    | AFE4490                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| AFE4490RHAR | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.5     | 12.0    | 16.0   | Q2            |
| AFE4490RHAT | VQFN         | RHA             | 40   | 250  | 180.0              | 16.4               | 6.3     | 6.3     | 1.5     | 12.0    | 16.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

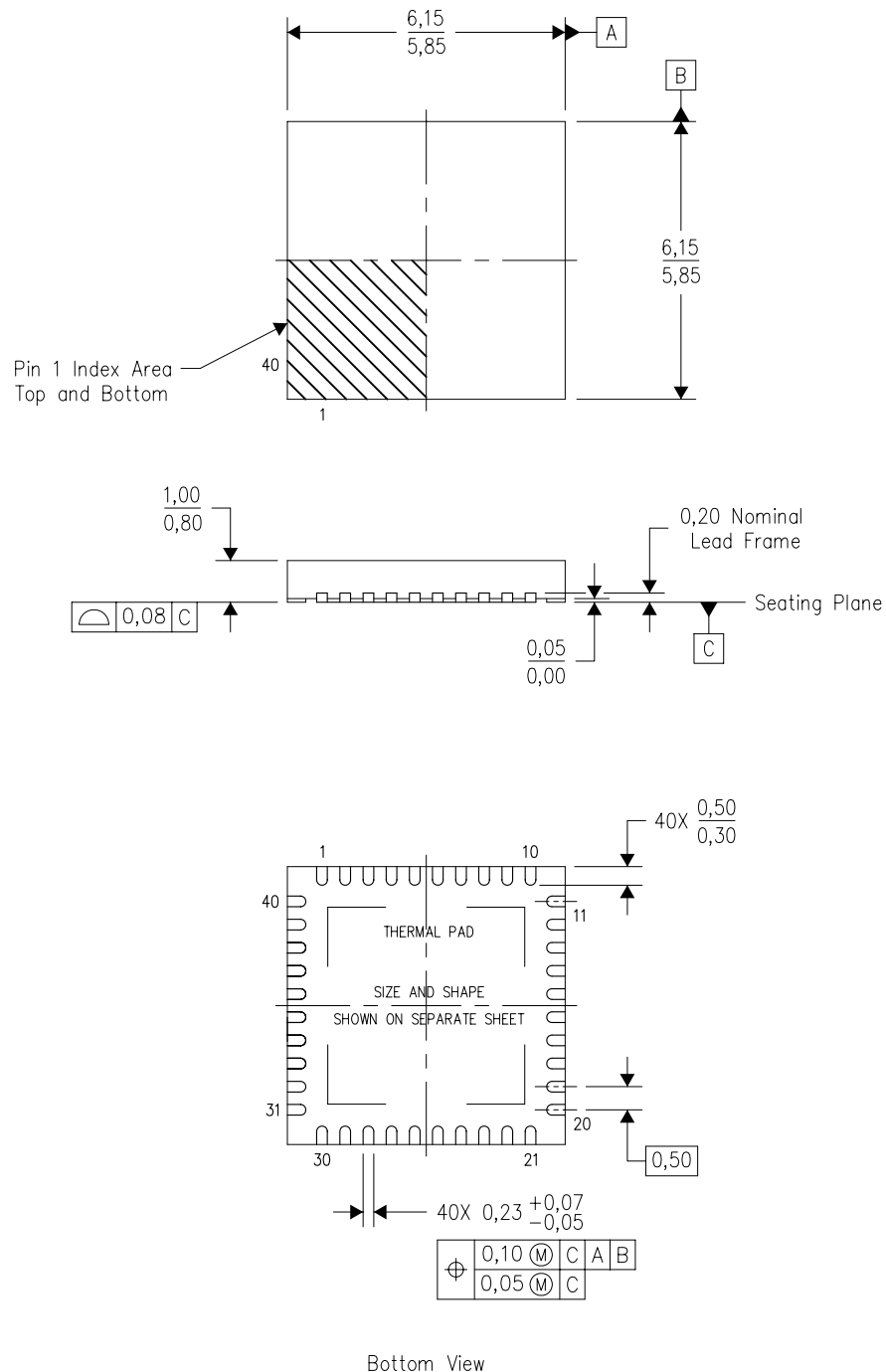


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| AFE4490RHAR | VQFN         | RHA             | 40   | 2500 | 367.0       | 367.0      | 38.0        |
| AFE4490RHAT | VQFN         | RHA             | 40   | 250  | 210.0       | 185.0      | 35.0        |

RHA (S-PVQFN-N40)

PLASTIC QUAD FLATPACK NO-LEAD



4204276/E 06/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) Package configuration.
  - D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
  - F. Package complies to JEDEC MO-220 variation VJJD-2.

RHA (S-PVQFN-N40)

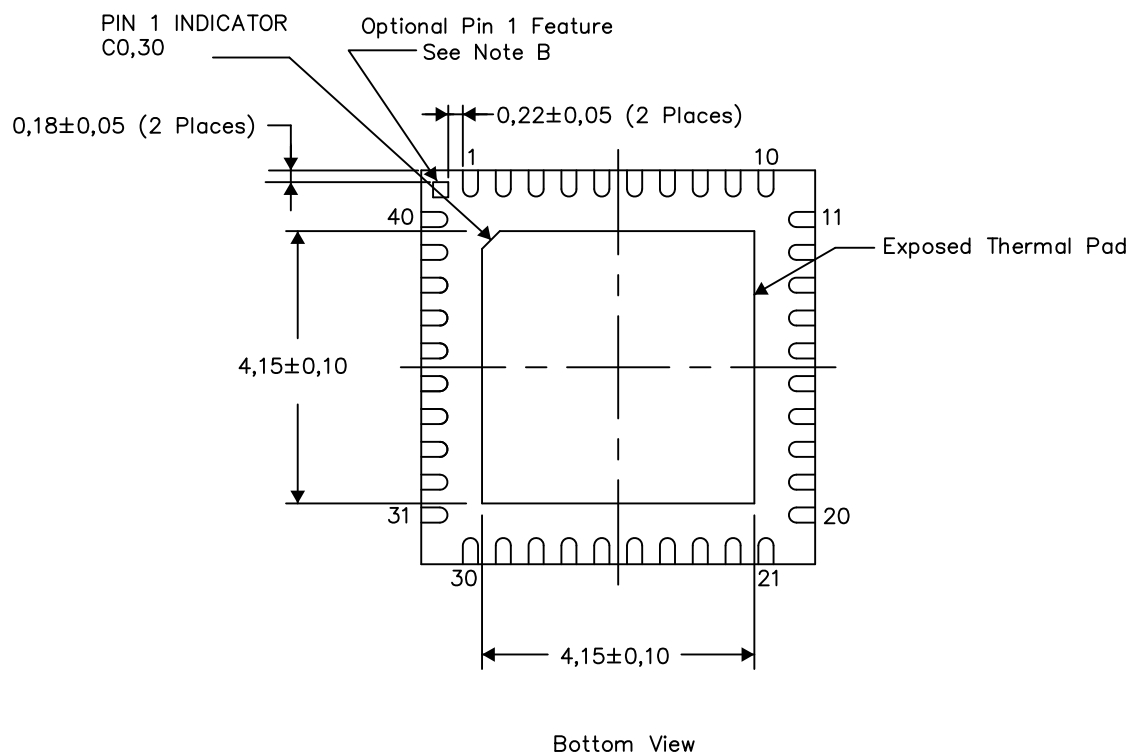
PLASTIC QUAD FLATPACK NO-LEAD

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Exposed Thermal Pad Dimensions

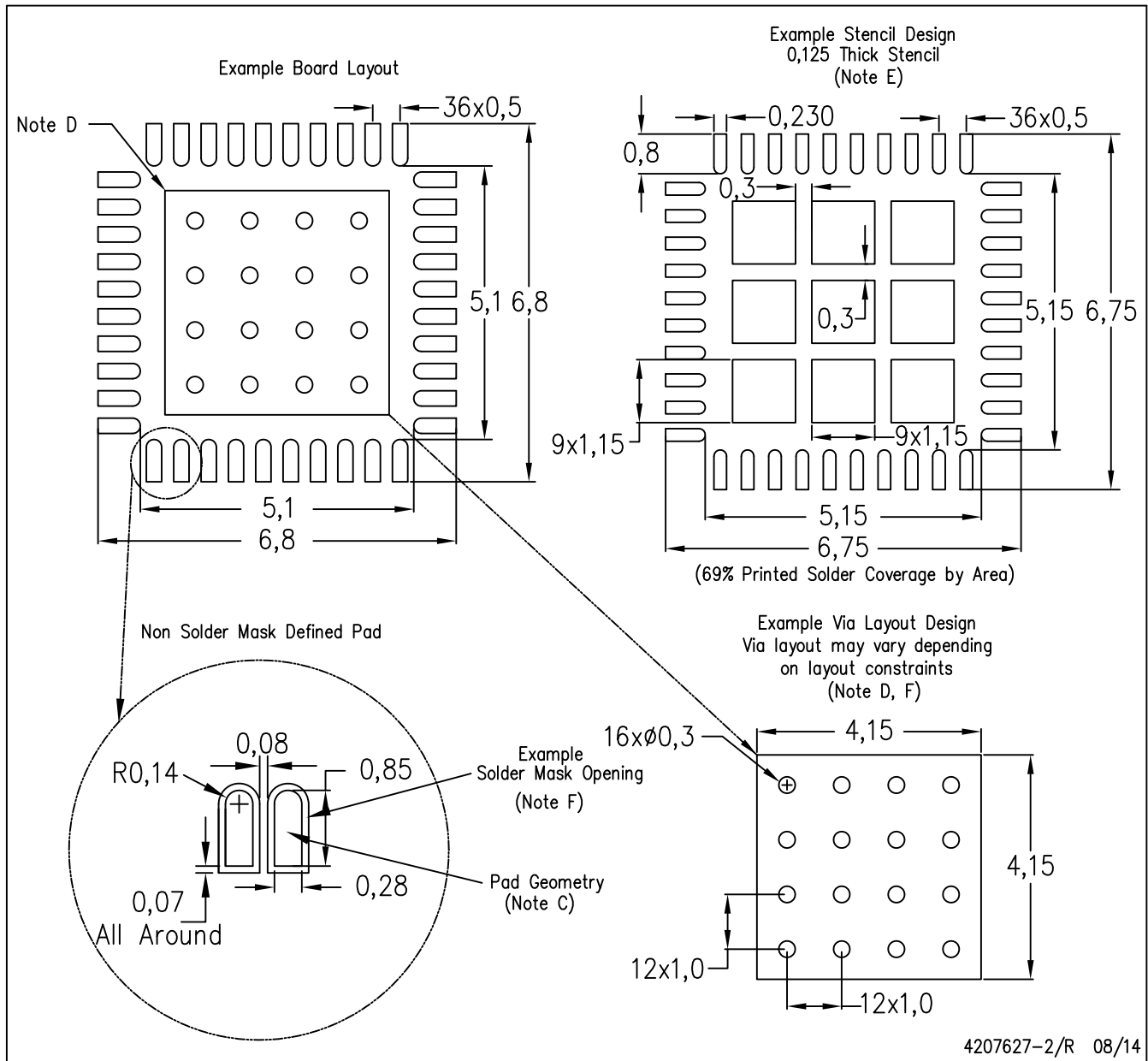
4206355-2/X 08/14

NOTES: A. All linear dimensions are in millimeters

B. The Pin 1 Identification mark is an optional feature that may be present on some devices  
In addition, this Pin 1 feature if present is electrically connected to the center thermal pad  
and therefore should be considered when routing the board layout.

RHA (S-PVQFN-N40)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for vias placed in the thermal pad.



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